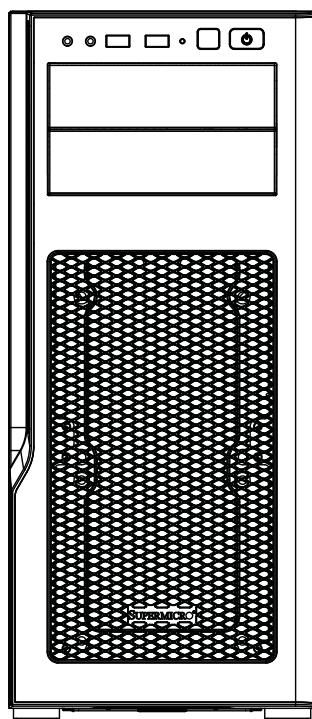




5039AD-T



User's Manual

Revision 1.0

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Manual Revision 1.0
Release Date: November 03, 2015

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Preface

About This Manual

This manual is written for professional system integrators and PC technicians. It provides information for the installation and use of the 5039AD-T. Installation and maintenance should be performed by experienced technicians only.

The 5039AD-T is a high-end system based on the GS5A-753R mid-tower chassis and the C7Z170-SQ motherboard.

Manual Organization

Chapter 1: Introduction

The first chapter provides a checklist of the main components included with the system and describes the main features of the C7Z170-SQ motherboard and the GS5A-753R chassis.

Chapter 2: System Installation

This chapter describes the steps necessary to setup the 5039AD-T and check out the system configuration prior to powering up the system. If your system was ordered without processor and memory components, this chapter will refer you to the appropriate sections of the manual for their installation.

Chapter 3: System Interface

Refer here for details on the system interface, which includes the functions and information provided by the control panel on the chassis as well as other LEDs located throughout the system.

Chapter 4: System Safety

You should thoroughly familiarize yourself with this chapter for a general overview of safety precautions that should be followed when installing and servicing the 5039AD-T.

Chapter 5: Advanced Motherboard Setup

Chapter 5 provides detailed information on the C7Z170-SQ motherboard, including the locations and functions of connections, headers and jumpers. Refer to this chapter when adding or removing processors or main memory and when reconfiguring the motherboard.

Chapter 6: Advanced Chassis Setup

Refer to Chapter 6 for detailed information on the GS5A-753R chassis. You should follow the procedures given in this chapter when installing, removing or reconfiguring SATA or peripheral drives and when replacing system power supply units and cooling fans.

Chapter 7: BIOS

The BIOS chapter includes an introduction to BIOS and provides detailed information on running the CMOS Setup Utility.

Appendix A: BIOS Error Beep Codes

Appendix B: System Specifications

Notes

Table of Contents

Chapter 1 Introduction

1-1	Overview	1-1
1-2	Motherboard Features.....	1-2
	Processors	1-2
	Memory	1-2
	SATA	1-2
	PCI Expansion Slots	1-3
	Onboard Controllers/Ports	1-3
	Other Features	1-4
	Recovery from AC Power Loss.....	1-4
	PC Health Monitoring.....	1-5
	Fan Status Monitor with Firmware Control	1-5
	Environmental Temperature Control.....	1-5
	System Resource Alert.....	1-5
	ACPI Features.....	1-5
	Slow Blinking LED for Suspend-State Indicator	1-6
	Power Supply	1-6
	Super I/O	1-6
1-3	Chassis Features	1-7
	Key Features	1-7
	System Power	1-7
	Hard Drives	1-7
	Front Control Panel.....	1-7
	Fans and Cooling.....	1-8
1-4	Contacting Supermicro.....	1-10

Chapter 2 Installation

2-1	Overview	2-1
2-2	Unpacking the System	2-1
2-3	Warnings and Precautions!	2-1
2-3	Accessing the Inside of the System.....	2-2
	Left Side and Right Side Covers	2-2
	Front Bezel.....	2-3

Chapter 3 System Interface

3-1	Overview	3-1
3-2	Control Panel Button.....	3-1
	Power	3-1
	Reset.....	3-1
3-3	Front Panel Components	3-2

Chapter 4 Standardized Warning Statements for AC Systems

4-1	About Standardized Warning Statements.....	4-1
	Warning Definition	4-1
	Installation Instructions.....	4-4
	Circuit Breaker	4-5
	Power Disconnection Warning	4-6
	Equipment Installation.....	4-8
	Restricted Area.....	4-9
	Battery Handling.....	4-10
	Redundant Power Supplies	4-12
	Backplane Voltage	4-13
	Comply with Local and National Electrical Codes	4-14
	Product Disposal	4-15
	Hot Swap Fan Warning.....	4-16
	Power Cable and AC Adapter	4-18

Chapter 5 Advanced Motherboard Setup

5-1	Handling the Motherboard	5-1
	Precautions	5-1
5-2	Connecting Cables.....	5-2
	Connecting Data Cables	5-2
	Connecting Power Cables	5-2
	Connecting the Control Panel.....	5-2
5-3	I/O Ports.....	5-3
5-4	Processor and Heatsink Installation.....	5-4
	Installing the LGA1155 Processor	5-4
	Installing an Active Fan CPU Heatsink.....	5-6
	Removing the Heatsink.....	5-8
5-5	Installing Memory Modules	5-9
	DIMM Installation	5-9
	Removing Memory Modules	5-10
	Memory Support.....	5-10
	Memory Population Guidelines	5-11

5-6	Adding PCI Add-On Cards.....	5-12
5-7	Motherboard Details.....	5-13
	Important Notes to the User.....	5-14
5-8	Connector Definitions.....	5-15
5-9	Jumper Settings.....	5-22
5-10	Onboard Indicators.....	5-25
5-11	SATA Connections.....	5-26
5-12	The OC Front Control Panel (Optional).....	5-27
	Installing the OC Front Control Panel.....	5-28
5-13	Installing Drivers.....	5-29
	SuperDoctor 5.....	5-30
5-14	Motherboard Battery.....	5-31

Chapter 6 Advanced Chassis Setup

6-1	Static-Sensitive Devices.....	6-1
	Precautions.....	6-1
6-2	Removing Power from the System.....	6-2
6-3	Accessing the Inside of the System.....	6-2
	Left Side and Right Side Covers.....	6-3
	Front Bezel.....	6-3
6-4	Installing Drives.....	6-4
6-5	Installing the Motherboard.....	6-8
	Installing the I/O Shield.....	6-8
	Motherboard Standoffs.....	6-8
	Motherboard Installation.....	6-9
6-6	Fans and Cooling.....	6-10
	Water Cooled Heat Sink.....	6-11
	Air Flow.....	6-12
	Dust Filters.....	6-12
6-7	Installing Expansion Cards.....	6-13
6-8	Power Supply.....	6-13

Chapter 7 BIOS

7-1	Introduction.....	7-1
	Starting BIOS GUI Setup Utility.....	7-1
	How To Change the Configuration Data.....	7-2
	How to Start the Setup Utility.....	7-2
7-2	Saving and Loading.....	7-3
	Save and Load.....	7-3
	Profiles.....	7-4

7-3	System Information	7-6
7-4	Processor (CPU)	7-9
7-5	Overclocking	7-14
7-6	Memory	7-30
7-7	Booting	7-33
7-8	Input/Output	7-36
7-9	Hardware Monitor	7-42
7-10	Management	7-45
7-11	Chipset	7-49
7-12	Security	7-52
7-13	Recovery	7-58
	BIOS Boot Block	7-58
	BIOS Boot Block Corruption Occurrence	7-58
	Steps to Reboot the System by Switch JBR1	7-58
7-14	UEFI BIOS Recovery Instructions	7-59
	An Overview to the UEFI BIOS	7-59
	How to Recover the UEFI BIOS Image (-the Main BIOS Block)	7-59
	To Recover the Main BIOS Block Using a USB-Attached Device	7-59

Appendix A BIOS Error Beep Codes

Appendix B System Specifications

Notes

Chapter 1

Introduction

1-1 Overview

The 5039AD-T is a high-end workstation comprised of two main subsystems: the GS5A-753R mid-tower chassis and the C7Z170-SQ single Intel® processor motherboard. Please refer to our web site for information on operating systems that have been certified for use with the 5039AD-T (www.supermicro.com).

In addition to the motherboard and chassis, various hardware components have been included with the 5039AD-T, as listed below:

- One (1) rear exhaust fan, two (2) front cooling fans
- Two (2) chassis 3.5" HDD cages (MCP-220-GS504-0N)
- One (1) chassis 2.5" HDD cage (MCP-220-GS505-0N)
- Optional:
 - One (1) active CPU heatsink (SNK-P0051AP4)
 - 12-cm PWM fans (FAN-0124L4)

Note: For your system to work properly, please follow the links below to download all necessary drivers/utilities and the user's manual for your system.

- Supermicro product manuals: <http://www.supermicro.com/support/manuals/>
- Product drivers and utilities: <ftp://ftp.supermicro.com>
- Product safety information:
http://www.supermicro.com/about/policies/safety_information.cfm
- If you have any questions, please contact our support team at:
support@supermicro.com

1-2 Motherboard Features

At the heart of the 5039AD-T lies the C7Z170-SQ, a single processor motherboard based on the Intel Z170 Express chipset. Below are the main features of the C7Z170-SQ. (See Figure 1-1 for a block diagram of the chipset).

Processors

The C7Z170-SQ supports a single Intel Core i3/i5/i7 6th generation processors in an Intel LGA1151 (H4) socket. With the Intel Z170 Express chipset built in, the C7Z170-SQ motherboard offers substantial system performance and storage capability for overclocking platforms in a sleek package. Please refer to our website (<http://www.supermicro.com/products/>) for processor and memory support updates.

Other chipset features include:

- Direct Media Interface (up to 10 Gb/s transfer, Full Duplex)
- Intel® Matrix Storage Technology and Intel Rapid Storage Technology
- Dual NAND Interface
- Intel I/O Virtualization (VT-d) Support
- Intel Trusted Execution Technology Support
- PCI Express 3.0 Interface (up to 8 GT/s)
- SATA Controller (up to 6Gb/sec)
- Advanced Host Controller Interface (AHCI)

Memory

The C7Z170-SQ has four (4) DIMM slots that can support 64GB of unbuffered, non-ECC UDIMM up to 4 GB, 8 GB or 16 GB size and DDR4 3000+MHz(OC) MHz speed SDRAM. See Chapter 5 for details.

SATA

A SATA controller is integrated into the chipset to provide a SATA3 subsystem that supports RAID 0, 1, 5, and 10 (RAID 5 is not supported with Linux OS), and supports six (6) (I-SATA 0-5) SATA 3.0 (6Gb/s) ports.

PCI Expansion Slots

The C7Z170-SQ has the following available expansion ports on the motherboard:

- Two (2) PCH PCI-E 3.0 X1 (in X4) slots
- One (1) CPU PCI-E 3.0 X4 (in X16) slot
- One (1) PCH PCI-E 3.0 X4 slot
- One (1) CPU PCI-E 3.0 X16 slot
- One (1) CPU PCI-E 3.0 X8 (in X16) slot
- One (1) M.2 slot

Onboard Controllers/Ports

Both the motherboard and chassis include the following I/O ports:

- Six (6) USB 2.0 ports (two (2) rear I/O panel and four (4) headers)
- Six (6) USB 3.0 ports (four (4) rear I/O panel and two (2) front panel)
- One (1) USB 3.1 'type C' port on the motherboard
- One (1) PS/2 Keyboard/Mouse rear I/O panel shared port
- One (1) RJ-45 rear I/O panel connector
- One (1) Serial port header (COM1) on the motherboard
- One (1) Display rear I/O panel port
- One (1) DVI-D rear I/O panel port
- One (1) HDMI rear I/O panel port
- One (1) rear I/O panel High Definition Audio 7.1 channel connector (supported by Realtek ALC1150)
- One (1) front panel Audio Header
- One (1) S/PDIF out on the rear side of the chassis

Other Features

Other onboard features of the motherboard include:

- Plug and Play (PnP0, DMI 2.8, PCI 2.3, ACPI 1.0/2.0/3.0, and USB Keyboard)
- ACPI/ASPM Power Management
- Main Switch Override Mechanism
- Internal/External Modem Ring-On
- Power-on mode for AC power recovery
- Onboard monitors: CPU core, +3.3V, +5V, +/- 12V, +3.3V Stby, +5V Stby, VBAT, HT, Memory PCH Temperature, System Temperature, and CPU Temperature
- CPU 6+1 phase switching voltage regulator
- CPU/System overheat LED and control
- CPU Thermal Trip and Monitor support
- Fan status monitoring with firmware 4-pin fan low-noise speed control
- PECI (Platform Environment Configuration Interface) 2.0 support
- System resource alert via SuperDoctor® III, NMI
- Chassis Intrusion header and detection
- BIOS flash upgrade utility
- Drivers and software for Intel® Z170 Express chipset utilities
- ROHS 6/6 (Full Compliance, Lead Free)

Recovery from AC Power Loss

Basic I/O System (BIOS) provides a setting for you to determine how the system will respond when AC power is lost and then restored to the system. You can choose for the system to remain powered off, (in which case you must press the power switch to turn it back on), or for it to automatically return to a power-on state. See the Advanced BIOS Setup section to change this setting. The default setting is **Last State**.

PC Health Monitoring

This section describes the PC health monitoring features of the board. All have an onboard System Hardware Monitoring chip that supports PC health monitoring. An onboard voltage monitor will scan these onboard voltages continuously: CPU core, +3.3V, +5V, +/- 12V, +3.3V Stby, +5V Stby, VBAT, HT, Memory PCH Temperature, System Temperature, and CPU Temperature. Once a voltage becomes unstable, a warning is given, or an error message is sent to the screen. The user can adjust the voltage thresholds to define the sensitivity of the voltage monitor.

Fan Status Monitor with Firmware Control

PC health monitoring in the BIOS can check the RPM status of the cooling fans. The onboard CPU and chassis fans are controlled by Thermal Management via SIO.

Environmental Temperature Control

The thermal control sensor monitors the CPU temperature in real time and will turn on the thermal control fan whenever the CPU temperature exceeds a user-defined threshold. The overheat circuitry runs independently from the CPU. Once the thermal sensor detects that the CPU temperature is too high, it will automatically turn on the thermal fans to prevent the CPU from overheating. The onboard chassis thermal circuitry can monitor the overall system temperature and alert the user when the chassis temperature is too high.

Note: To avoid possible system overheating, please be sure to provide adequate airflow to your system.

System Resource Alert

This feature is available when the system is used with SuperDoctor III in the Windows OS environment or used with SuperDoctor II in Linux. SuperDoctor is used to notify the user of certain system events. For example, you can also configure SuperDoctor to provide you with warnings when the system temperature, CPU temperatures, voltages and fan speeds go beyond predefined thresholds.

ACPI Features

ACPI stands for Advanced Configuration and Power Interface. The ACPI specification defines a flexible and abstract hardware interface that provides a standard way to integrate power management features throughout a PC system, including its hardware, operating system and application software. This enables the system to automatically turn on and off peripherals such as CD-ROMs, network cards, hard disk drives and printers.

In addition to enabling operating system-directed power management, ACPI also provides a generic system event mechanism for Plug and Play, and an operating system-independent interface for configuration control. ACPI leverages the Plug and Play BIOS data structures, while providing a processor architecture-independent implementation.

Slow Blinking LED for Suspend-State Indicator

When the CPU goes into a suspend state, the chassis power LED will start to blink to indicate that the CPU is in suspend mode. When the user presses any key, the CPU will "wake up", and the LED will automatically stop blinking and remain on.

Power Supply

As with all computer products, a stable power source is necessary for proper and reliable operation. It is even more important for processors that have high CPU clock rates.

This motherboard accommodates 24-pin ATX power supplies. Although most power supplies generally meet the specifications required by the CPU, some are inadequate. In addition, the 12V 8-pin power connector located at JPW2 is also required to ensure adequate power supply to the system. Also your power supply must supply 1.5A for the Ethernet ports.

Super I/O

The Nuvoton NCT6792D-B Super I/O supports two high-speed, 16550 compatible serial communication ports (UARTs). Each UART includes a 16-byte send/receive FIFO, a programmable baud rate generator, complete modem control capability and a processor interrupt system. Both UARTs provide legacy speed with baud rate of up to 115.2 Kbps as well as an advanced speed with baud rates of 250 K, 500 K, or 1 Mb/s, which support higher speed modems.

The Nuvoton NCT6792D-B Super I/O provides functions that comply with ACPI (Advanced Configuration and Power Interface), which includes support of legacy and ACPI power management through an SMI or SCI function pin. It also features auto power management to reduce power consumption.

1-3 Chassis Features

Supermicro's GS5A gaming chassis (GS5A-753R) offers extreme storage and cooling opportunities in a sleek, attractive form. It can house a powerful ATX form factor motherboard supporting outstanding gaming-level high performance.

Key Features

- Black anodized brushed aluminum fascia front panel with two front USB 3.0 ports and audio ports
- Removable 3.5" and 2.5" HDD/SSD cages with tool-less trays for up to 10 drives
- Tool-less 5.25" device installation with trays to support 3.5" and 2.5" drives additionally
- Cable management holes with rubber grommets for clean builds
- Removable magnetic dust filters
- One click front grille access
- Large motherboard tray cut-out for CPU cooler back-plates

System Power

The 5039AD-T features a single 750 Watt power supply. This power supply unit has been designed to operate at a low noise level to make it ideal for use in a noise sensitive environment.

Hard Drives

The 5039AD-T standard configuration includes two 5.25" drive bays, four 2.5" drive bays, and six combination bays that can house either 3.5" or 2.5" drives.

- Each 5.25" bay can be configured to accept a 3.5" drive, or one or two 2.5" drives (with optional bracket (MCP-220-00044-ON)).
- The four 2.5" bays are housed in a removable cage.
- Two additional removable cages can each accommodate three 2.5" or 3.5" drives.

Front Control Panel

The front control panel on the 5039AD-T includes system monitoring LEDs, the main power button, and a reset button, two USB 3.0 ports, a headphone port and a microphone port.

Fans and Cooling

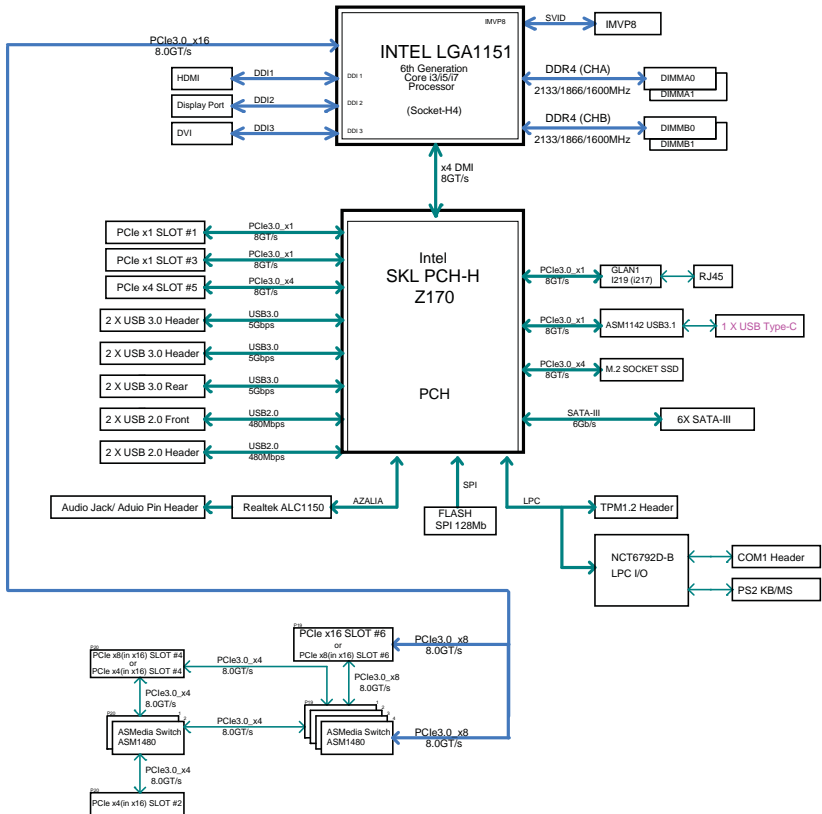
The system includes two 120mm PWM fans in the front and one 120mm PWM fan in the rear. Other fan mounts and configurations are possible.

- Two front fans can be upgraded to 140mm.
- Three fans can be mounted on the chassis top, 120mm or 140mm.
- One fans can be mounted on the chassis bottom, 120mm.
- Fans can be mounted on the chassis side panel, two 120mm or one 140mm.

In addition, the chassis supports a conventional water cooled CPU heat sink.

**Figure 1-1. Intel Z170 Express Chipset:
System Block Diagram**

Note: This is a general block diagram. Please see Chapter 5 for details.



1-4 Contacting Supermicro

Headquarters

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San Jose, CA 95131 U.S.A.

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Fax: +1 (408) 503-8008

Email: marketing@supermicro.com (General Information)
support@supermicro.com (Technical Support)

Website: www.supermicro.com

Europe

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Het Sterrenbeeld 28, 5215 ML
's-Hertogenbosch, The Netherlands

Tel: +31 (0) 73-6400390

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Website: www.supermicro.nl

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Zhonghe Dist., New Taipei City 235
Taiwan (R.O.C)

Tel: +886-(2) 8226-3990

Fax: +886-(2) 8226-3992

Email: support@supermicro.com.tw

Website: www.supermicro.com.tw

Chapter 2

Installation

2-1 Overview

This chapter provides a quick setup checklist to get your 5039AD-T up and running. Following these steps in the order given should enable you to have the system operational within a minimum amount of time. This quick setup assumes that your system has come to you with the motherboard preinstalled.

2-2 Unpacking the System

You should inspect the box the system was shipped in and note if it was damaged in any way. If the system itself shows damage you should file a damage claim with the carrier who delivered it.

Decide on a suitable location for the system. It should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated. You will also need it plugged into a grounded power outlet. Be sure to read the Warnings and Precautions in the next section.

2-3 Warnings and Precautions!

- Review the electrical and general safety precautions in Chapter 4.
- Use a regulating uninterruptible power supply (UPS) to protect the system from power surges, voltage spikes and to keep your system operating in case of a power failure.
- Allow the power supply units to cool before touching them.

2-3 Accessing the Inside of the System

You may need to access the system periodically to perform maintenance or install components such as hard drives. The system features two removable side covers, allowing easy access to the system interior.

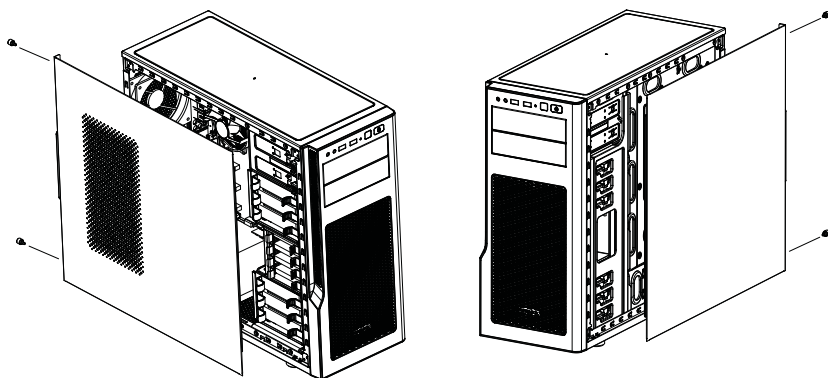
Caution: Except for short periods of time, do not operate the system without the cover in place. The chassis cover must be in place to allow proper airflow.

Left Side and Right Side Covers

Removing a Side Chassis Cover

1. Power down the system.
2. Remove the two thumb screws on the rear of the chassis.
3. Slide the cover back toward the rear of the chassis.

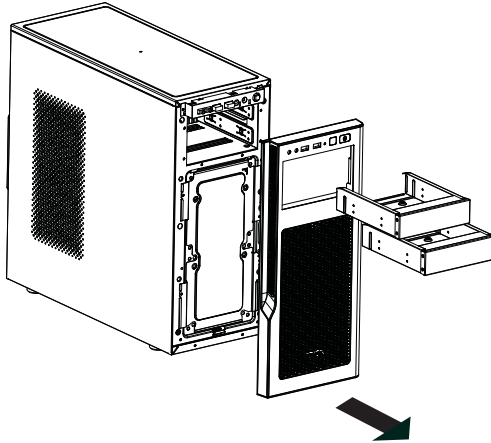
Figure 2-1. Removing the Chassis Side Covers



Front Bezel

Remove the front bezel by pulling it off from the bottom of the bezel. This should only be necessary when replacing the front fans.

Figure 3-3. Removing the Front Bezel



Notes

Chapter 3

System Interface

3-1 Overview

The control panel on the 5039AD-T has one LED, a power button and a reset button. This LED keeps you constantly informed of hard drive status and activity.

3-2 Control Panel Button

A single push-button is located on the front of the chassis.

Power

This is the main power button, which is used to apply or turn off the main system power. Turning off system power with this button removes the main power but keeps standby power supplied to the system.

Reset

Use the reset button to reboot the system.

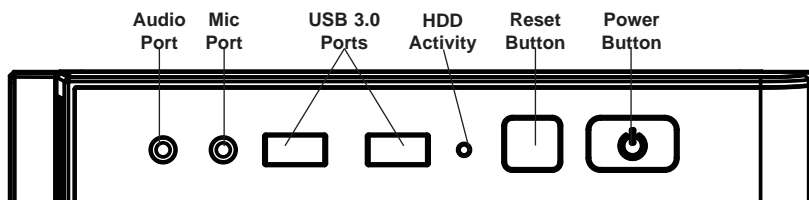
3-3 Front Panel Components

The 5039AD-T features a front panel allowing easy access to the chassis power and communication ports. The in addition to the Power and Reset buttons the following ports are available on the front panel:

- Two USB 3.0 ports
- Audio port
- Mic port

See diagram on the following page.

Figure 3-1. Front Panel Components



Chapter 4

Standardized Warning Statements for AC Systems

4-1 About Standardized Warning Statements

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this appendix in its entirety before installing or configuring components in the Supermicro chassis.

These warnings may also be found on our web site at http://www.supermicro.com/about/policies/safety_information.cfm.

Warning Definition



Warning!

This warning symbol means danger. You are in a situation that could cause bodily injury. Before you work on any equipment, be aware of the hazards involved with electrical circuitry and be familiar with standard practices for preventing accidents.

警告の定義

この警告サインは危険を意味します。

人身事故につながる可能性がありますので、いずれの機器でも動作させる前に、電気回路に含まれる危険性に注意して、標準的な事故防止策に精通して下さい。

此警告符号代表危險。

您正處於可能受到嚴重傷害的工作環境中。在您使用設備開始工作之前，必須充分意識到觸電的危險，並熟練掌握防止事故發生的標準工作程序。請根據每項警告結尾的聲明號碼找到此設備的安全性警告說明的翻譯文本。

此警告符號代表危險。

您正處於可能身體可能會受損傷的工作環境中。在您使用任何設備之前，請注意觸電的危險，並且要熟悉預防事故發生的標準工作程序。請依照每一注意事項後的號碼找到相關的翻譯說明內容。

Warnung

WICHTIGE SICHERHEITSHINWEISE

Dieses Warnsymbol bedeutet Gefahr. Sie befinden sich in einer Situation, die zu Verletzungen führen kann. Machen Sie sich vor der Arbeit mit Geräten mit den Gefahren elektrischer Schaltungen und den üblichen Verfahren zur Vorbeugung vor Unfällen vertraut. Suchen Sie mit der am Ende jeder Warnung angegebenen Anweisungsnummer nach der jeweiligen Übersetzung in den übersetzten Sicherheitshinweisen, die zusammen mit diesem Gerät ausgeliefert wurden.

BEWAHREN SIE DIESE HINWEISE GUT AUF.

INSTRUCCIONES IMPORTANTES DE SEGURIDAD

Este símbolo de aviso indica peligro. Existe riesgo para su integridad física. Antes de manipular cualquier equipo, considere los riesgos de la corriente eléctrica y familiarícese con los procedimientos estándar de prevención de accidentes. Al final de cada advertencia encontrará el número que le ayudará a encontrar el texto traducido en el apartado de traducciones que acompaña a este dispositivo.

GUARDE ESTAS INSTRUCCIONES.

IMPORTANTES INFORMATIONS DE SÉCURITÉ

Ce symbole d'avertissement indique un danger. Vous vous trouvez dans une situation pouvant entraîner des blessures ou des dommages corporels. Avant de travailler sur un équipement, soyez conscient des dangers liés aux circuits électriques et familiarisez-vous avec les procédures couramment utilisées pour éviter les accidents. Pour prendre connaissance des traductions des avertissements figurant dans les consignes de sécurité traduites qui accompagnent cet appareil, référez-vous au numéro de l'instruction situé à la fin de chaque avertissement.

CONSERVEZ CES INFORMATIONS.

תקנון הזהרות אזהרה

הזהרות הבאות הן אזהרות על פי תקני התעשייה, על מנת להזהיר את המשתמש מפני חבלה פיזית אפשרית. במידה ויש שאלות או היתקלות בבעיה כלשהי, יש ליצור קשר עם מחלקת תמיכה טכנית של סופרמיקרו. טכנאים מוסמכים בלבד רשאים להתקין או להגדיר את הרכיבים.

יש לקרוא את הנספח במלואו לפני התקנת או הגדרת הרכיבים במארזי סופרמיקרו.

تحذير! هذا الرمز يعني خطر انك في حالة يمكن أن تتسبب في اصابة جسدية .
 قبل أن تعمل على أي معدات، كن على علم بالمخاطر الناجمة عن الدوائر
 الكهربائية
 وكن على دراية بالممارسات الوقائية لمنع وقوع أي حوادث
 استخدم رقم البيان المنصوص في نهاية كل تحذير للعثور ترجمتها

안전을 위한 주의사항

경고!

이 경고 기호는 위험이 있음을 알려 줍니다. 작업자의 신체에 부상을 야기 할 수 있는 상태에 있게 됩니다. 모든 장비에 대한 작업을 수행하기 전에 전기회로와 관련된 위험요소들을 확인하시고 사전에 사고를 방지할 수 있도록 표준 작업절차를 준수해 주시기 바랍니다.

해당 번역문을 찾기 위해 각 경고의 마지막 부분에 제공된 경고문 번호를 참조하십시오

BELANGRIJKE VEILIGHEIDSINSTRUCTIES

Dit waarschuwings symbool betekent gevaar. U verkeert in een situatie die lichamelijk letsel kan veroorzaken. Voordat u aan enige apparatuur gaat werken, dient u zich bewust te zijn van de bij een elektrische installatie betrokken risico's en dient u op de hoogte te zijn van de standaard procedures om ongelukken te voorkomen. Gebruik de nummers aan het eind van elke waarschuwing om deze te herleiden naar de desbetreffende locatie.

BEWAAR DEZE INSTRUCTIES

Installation Instructions



Warning!

Read the installation instructions before connecting the system to the power source.

設置手順書

システムを電源に接続する前に、設置手順書をお読み下さい。

警告

将此系统连接电源前，请先阅读安装说明。

警告

將系統與電源連接前，請先閱讀安裝說明。

Warnung

Vor dem Anschließen des Systems an die Stromquelle die Installationsanweisungen lesen.

¡Advertencia!

Lea las instrucciones de instalación antes de conectar el sistema a la red de alimentación.

Attention

Avant de brancher le système sur la source d'alimentation, consulter les directives d'installation.

יש לקרוא את הוראות התקנה לפני חיבור המערכת למקור מתח.

اقر إرشادات التركيب قبل توصيل النظام إلى مصدر للطاقة

시스템을 전원에 연결하기 전에 설치 안내를 읽어주십시오.

Waarschuwing

Raadpleeg de installatie-instructies voordat u het systeem op de voedingsbron aansluit.

Circuit Breaker



Warning!

This product relies on the building's installation for short-circuit (overcurrent) protection. Ensure that the protective device is rated not greater than: 250 V, 20 A.

サーキット・ブレーカー

この製品は、短絡(過電流)保護装置がある建物での設置を前提としています。
保護装置の定格が250 V、20 Aを超えないことを確認下さい。

警告

此产品的短路(过载电流)保护由建筑物的供电系统提供,确保短路保护设备的额定电流不大于250V,20A。

警告

此產品的短路(過載電流)保護由建築物的供電系統提供,確保短路保護設備的額定電流不大於250V,20A。

Warnung

Dieses Produkt ist darauf angewiesen, dass im Gebäude ein Kurzschluss- bzw. Überstromschutz installiert ist. Stellen Sie sicher, dass der Nennwert der Schutzvorrichtung nicht mehr als: 250 V, 20 A beträgt.

¡Advertencia!

Este equipo utiliza el sistema de protección contra cortocircuitos (o sobrecorrientes) del edificio. Asegúrese de que el dispositivo de protección no sea superior a: 250 V, 20 A.

Attention

Pour ce qui est de la protection contre les courts-circuits (surtension), ce produit dépend de l'installation électrique du local. Vérifiez que le courant nominal du dispositif de protection n'est pas supérieur à :250 V, 20 A.

מוצר זה מסתמך על הגנה המותקנת במבנים למניעת קצר חשמלי. יש לוודא כי
המכשיר המגן מפני הקצר החשמלי הוא לא יותר מ-250 V, 20 A

هذا المنتج يعتمد على معدات الحماية من الدوائر القصيرة التي تم تثبيتها في
المبنى

تأكد من أن تقييم الجهاز الوقائي ليس أكثر من: 20A, 250V

경고!

이 제품은 전원의 단락(과전류)방지에 대해서 전적으로 건물의 관련 설비에 의존합니다. 보호장치의 정격이 반드시 250V(볼트), 20A(암페어)를 초과하지 않도록 해야 합니다.

Waarschuwing

Dit product is afhankelijk van de kortsluitbeveiliging (overspanning) van uw elektrische installatie. Controleer of het beveiligde apparaat niet groter gedimensioneerd is dan 220V, 20A.

Power Disconnection Warning



Warning!

The system must be disconnected from all sources of power and the power cord removed from the power supply module(s) before accessing the chassis interior to install or remove system components.

電源切斷の警告

システムコンポーネントの取り付けまたは取り外しのために、シャーシ内部にアクセスするには、

システムの電源はすべてのソースから切断され、電源コードは電源モジュールから取り外す必要があります。

警告

在你打开机箱并安装或移除内部器件前,必须将系统完全断电,并移除电源线。

警告

在您打開機殼安裝或移除內部元件前,必須將系統完全斷電,並移除電源線。

Warnung

Das System muss von allen Quellen der Energie und vom Netzanschlusskabel getrennt sein, das von den Spg.Versorgungsteilmodulen entfernt wird, bevor es auf den Chassisinnenraum zurückgreift, um Systemsbestandteile anzubringen oder zu entfernen.

¡Advertencia!

El sistema debe ser disconnected de todas las fuentes de energía y del cable eléctrico quitado de los módulos de fuente de alimentación antes de tener acceso el interior del chasis para instalar o para quitar componentes de sistema.

Attention

Le système doit être débranché de toutes les sources de puissance ainsi que de son cordon d'alimentation secteur avant d'accéder à l'intérieur du chasis pour installer ou enlever des composants de système.

אזהרה מפני ניתוק חשמלי**אזהרה !**

יש לנתק את המערכת מכל מקורות החשמל ויש להסיר את כבל החשמלי מהספק לפני גישה לחלק הפנימי של המארו לצורך התקנת או הסרת רכיבים.

يجب فصل النظام من جميع مصادر الطاقة وإزالة سلك الكهرباء من وحدة امداد الطاقة قبل الوصول إلى المناطق الداخلية للهيكल لتثبيت أو إزالة مكونات الجهاز

경고!

시스템에 부품들을 장착하거나 제거하기 위해서는 새시 내부에 접근하기 전에 반드시 전원 공급장치로부터 연결되어있는 모든 전원과 전기코드를 분리해주어야 합니다.

Waarschuwing

Voordat u toegang neemt tot het binnenwerk van de behuizing voor het installeren of verwijderen van systeem onderdelen, dient u alle spanningsbronnen en alle stroomkabels aangesloten op de voeding(en) van de behuizing te verwijderen

Equipment Installation



Warning!

Only trained and qualified personnel should be allowed to install, replace, or service this equipment.

機器の設置

トレーニングを受け認定された人だけがこの装置の設置、交換、またはサービスを許可されています。

警告

只有经过培训且具有资格的人员才能进行此设备的安装、更换和维修。

警告

只有經過受訓且具資格人員才可安裝、更換與維修此設備。

Warnung

Das Installieren, Ersetzen oder Bedienen dieser Ausrüstung sollte nur geschultem, qualifiziertem Personal gestattet werden.

¡Advertencia!

Solamente el personal calificado debe instalar, reemplazar o utilizar este equipo.

Attention

Il est vivement recommandé de confier l'installation, le remplacement et la maintenance de ces équipements à des personnels qualifiés et expérimentés.

אזהרה!

צוות מוסמך בלבד רשאי להתקין, להחליף את הציוד או לתת שירות עבור הציוד.

يجب أن يسمح فقط للموظفين المؤهلين والمدربين لتثبيت واستبدال أو خدمة هذا الجهاز

경고!

훈련을 받고 공인된 기술자만이 이 장비의 설치, 교체 또는 서비스를 수행할 수 있습니다.

Waarschuwing

Deze apparatuur mag alleen worden geïnstalleerd, vervangen of hersteld door geschoold en gekwalificeerd personeel.

Restricted Area



Warning!

This unit is intended for installation in restricted access areas. A restricted access area can be accessed only through the use of a special tool, lock and key, or other means of security. (This warning does not apply to workstations).

アクセス制限区域

このユニットは、アクセス制限区域に設置されることを想定しています。

アクセス制限区域は、特別なツール、鍵と錠前、その他のセキュリティの手段を用いてのみ出入りが可能です。

警告

此部件应安装在限制进出的场所，限制进出的场所指只能通过使用特殊工具、锁和钥匙或其它安全手段进出的场所。

警告

此裝置僅限安裝於進出管制區域，進出管制區域係指僅能以特殊工具、鎖頭及鑰匙或其他安全方式才能進入的區域。

Warnung

Diese Einheit ist zur Installation in Bereichen mit beschränktem Zutritt vorgesehen. Der Zutritt zu derartigen Bereichen ist nur mit einem Spezialwerkzeug, Schloss und Schlüssel oder einer sonstigen Sicherheitsvorkehrung möglich.

¡Advertencia!

Esta unidad ha sido diseñada para instalación en áreas de acceso restringido. Sólo puede obtenerse acceso a una de estas áreas mediante la utilización de una herramienta especial, cerradura con llave u otro medio de seguridad.

Attention

Cet appareil doit être installée dans des zones d'accès réservés. L'accès à une zone d'accès réservé n'est possible qu'en utilisant un outil spécial, un mécanisme de verrouillage et une clé, ou tout autre moyen de sécurité.

אזור עם גישה מוגבלת

אזהרה!

יש להתקין את היחידה באזורים שיש בהם הגבלת גישה. הגישה ניתנת בעזרת כלי אבטחה בלבד (מפתח, מנעול וכד').

تم تخصيص هذه الوحدة لتثبيتها في مناطق محظورة .
يمكن الوصول إلى منطقة محظورة فقط من خلال استخدام أداة خاصة،
قفل ومفتاح أو أي وسيلة أخرى للأمان

경고!

이 장치는 접근이 제한된 구역에 설치하도록 되어있습니다. 특수도구, 잠금 장치 및 키, 또는 기타 보안 수단을 통해서만 접근 제한 구역에 들어갈 수 있습니다.

Waarschuwing

Dit apparaat is bedoeld voor installatie in gebieden met een beperkte toegang. Toegang tot dergelijke gebieden kunnen alleen verkregen worden door gebruik te maken van speciaal gereedschap, slot en sleutel of andere veiligheidsmaatregelen.

Battery Handling



Warning!

There is the danger of explosion if the battery is replaced incorrectly. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions

電池の取り扱い

電池交換が正しく行われなかった場合、破裂の危険性があります。交換する電池はメーカーが推奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さい。

警告

电池更换不当会有爆炸危险。请只使用同类电池或制造商推荐的功能相当的电池更换原有电池。请按制造商的说明处理废旧电池。

警告

電池更換不當會有爆炸危險。請使用製造商建議之相同或功能相當的電池更換原有電池。請按照製造商的說明指示處理廢棄舊電池。

Warnung

Bei Einsetzen einer falschen Batterie besteht Explosionsgefahr. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

Attention

Danger d'explosion si la pile n'est pas remplacée correctement. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

¡Advertencia!

Existe peligro de explosión si la batería se reemplaza de manera incorrecta. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

אזהרה!

קיימת סכנת פיצוץ של הסוללה במידה והוחלפה בדרך לא תקינה. יש להחליף את הסוללה בסוג התואם מחברת יצרן מומלצת.

סילוק הסוללות המושמשות יש לבצע לפי הוראות היצרן.

هناك خطر من انفجار في حالة استبدال البطارية بطريقة غير صحيحة فعليك استبدال البطارية فقط بنفس النوع أو ما يعادلها كما أوصت به الشركة المصنعة تخلص من البطاريات المستعملة وفقا لتعليمات الشركة الصانعة

경고!

배터리가 올바르게 교체되지 않으면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

Waarschuwing

Er is ontplofingsgevaar indien de batterij verkeerd vervangen wordt. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Redundant Power Supplies



Warning!

This unit might have more than one power supply connection. All connections must be removed to de-energize the unit.

冗長電源装置

このユニットは複数の電源装置が接続されている場合があります。
ユニットの電源を切るためには、すべての接続を取り外さなければなりません。

警告

此部件连接的电源可能不止一个，必须将所有电源断开才能停止给该部件供电。

警告

此裝置連接的電源可能不只一個，必須切斷所有電源才能停止對該裝置的供電。

Warnung

Dieses Gerät kann mehr als eine Stromzufuhr haben. Um sicherzustellen, dass der Einheit kein Strom zugeführt wird, müssen alle Verbindungen entfernt werden.

¡Advertencia!

Puede que esta unidad tenga más de una conexión para fuentes de alimentación. Para cortar por completo el suministro de energía, deben desconectarse todas las conexiones.

Attention

Cette unité peut avoir plus d'une connexion d'alimentation. Pour supprimer toute tension et tout courant électrique de l'unité, toutes les connexions d'alimentation doivent être débranchées.

אם קיים יותר מספק אחד

אזהרה!

ליחידה יש יותר מחיבור אחד של ספק. יש להסיר את כל החיבורים על מנת לרוקן את היחידה.

قد يكون لهذا الجهاز عدة اتصالات بوحدات امداد الطاقة.
يجب إزالة كافة الاتصالات لعزل الوحدة عن الكهرباء

경고!

이 장치에는 한 개 이상의 전원 공급 단자가 연결되어 있을 수 있습니다. 이 장치에 전원을 차단하기 위해서는 모든 연결 단자를 제거해야만 합니다.

Waarschuwing

Deze eenheid kan meer dan één stroomtoevoeraansluiting bevatten. Alle aansluitingen dienen verwijderd te worden om het apparaat stroomloos te maken.

Backplane Voltage



Warning!

Hazardous voltage or energy is present on the backplane when the system is operating. Use caution when servicing.

バックプレーンの電圧

システムの稼働中は危険な電圧または電力が、バックプレーン上にかかっています。
修理する際には注意ください。

警告

当系统正在进行时，背板上有很危险的电压或能量，进行维修时务必小心。

警告

當系統正在進行時，背板上有危險的電壓或能量，進行維修時務必小心。

Warnung

Wenn das System in Betrieb ist, treten auf der Rückwandplatine gefährliche Spannungen oder Energien auf. Vorsicht bei der Wartung.

¡Advertencia!

Cuando el sistema está en funcionamiento, el voltaje del plano trasero es peligroso. Tenga cuidado cuando lo revise.

Attention

Lorsque le système est en fonctionnement, des tensions électriques circulent sur le fond de panier. Prendre des précautions lors de la maintenance.

מתח בפנל האחורי

אזהרה !

קיימת סכנת מתח בפנל האחורי בזמן תפעול המערכת. יש להיזהר במהלך העבודה.

هناك خطر من التيار الكهربائي أو الطاقة الموجودة على اللوحة عندما يكون النظام يعمل كن حذرا عند خدمة هذا الجهاز

경고!

시스템이 동작 중일 때 후면판 (Backplane)에는 위험한 전압이나 에너지가 발생합니다. 서비스 작업 시 주의하십시오.

Waarschuwing

Een gevaarlijke spanning of energie is aanwezig op de backplane wanneer het systeem in gebruik is. Voorzichtigheid is geboden tijdens het onderhoud.

Comply with Local and National Electrical Codes**Warning!**

Installation of the equipment must comply with local and national electrical codes.

地方および国の電気規格に準拠

機器の取り付けはその地方および国の電気規格に準拠する必要があります。

警告

设备安装必须符合本地与本国电气法规。

警告

設備安裝必須符合本地與本國電氣法規。

Warnung

Die Installation der Geräte muss den Sicherheitsstandards entsprechen.

¡Advertencia!

La instalacion del equipo debe cumplir con las normas de electricidad locales y nacionales. Attention

L'équipement doit être installé conformément aux normes électriques nationales et locales.

תאום חוקי החשמל הארצי

אזהרה !

התקנת הציוד חייבת להיות תואמת לחוקי החשמל המקומיים והארציים.

تركيب المعدات الكهربائية يجب أن يمتثل للقوانين المحلية والوطنية المتعلقة بالكهرباء

경고!

현 지역 및 국가의 전기 규정에 따라 장비를 설치해야 합니다.

Waarschuwing

Bij installatie van de apparatuur moet worden voldaan aan de lokale en nationale elektriciteitsvoorschriften.

Product Disposal



Warning!

Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄

この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告

本产品的废弃处理应根据所有国家的法律和规章进行。

警告

本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung

Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!

Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

אזהרה !

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

عند التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقاً لجميع القوانين واللوائح الوطنية

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Hot Swap Fan Warning



Warning!

The fans might still be turning when you remove the fan assembly from the chassis. Keep fingers, screwdrivers, and other objects away from the openings in the fan assembly's housing.

ファン・ホットスワップの警告

シャーシから冷却ファン装置を取り外した際、ファンがまだ回転している可能性があります。ファンの開口部に、指、ドライバー、およびその他のものを近づけないで下さい。

警告

当您从机架移除风扇装置，风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇

警告

當您從機架移除風扇裝置，風扇可能仍在轉動。小心不要將手指、螺絲起子和其他物品太靠近風扇。

Warnung

Die Lüfter drehen sich u. U. noch, wenn die Lüfterbaugruppe aus dem Chassis genommen wird. Halten Sie Finger, Schraubendreher und andere Gegenstände von den Öffnungen des Lüftergehäuses entfernt.

¡Advertencia!

Los ventiladores podran dar vuelta cuando usted quite el montaje del ventilador del chasis. Mantenga los dedos, los destornilladores y todos los objetos lejos de las aberturas del ventilador

Attention

Il est possible que les ventilateurs soient toujours en rotation lorsque vous retirerez le bloc ventilateur du châssis. Prenez garde à ce que doigts, tournevis et autres objets soient éloignés du logement du bloc ventilateur.

אזהרה!

כאשר מסירים את חלקי המאוורר מהמארז, יתכן והמאווררים עדיין עובדים. יש להרחיק למרחק בטוח את האצבעות וכלי עבודה שונים מהפתחים בתוך המאוורר

من الممكن أن المراوح لا تزال تدور عند إزالة كتلة المروحة من الهيكل يجب إبقاء الأصابع ومفكات البراغي وغيرها من الأشياء بعيدا عن الفتحات في كتلة المروحة.

경고!

새시로부터 팬 조립품을 제거할 때 팬은 여전히 회전하고 있을 수 있습니다. 팬 조립품 외관의 열려있는 부분들로부터 손가락 및 스크류드라이버, 다른 물체들이 가까이 하지 않도록 배치해 주십시오.

Waarschuwing

Het is mogelijk dat de ventilator nog draait tijdens het verwijderen van het ventilatorsamenstel uit het chassis. Houd uw vingers, schroevendraaiers en eventuele andere voorwerpen uit de buurt van de openingen in de ventilatorbehuizing.

Power Cable and AC Adapter



Warning!

When installing the product, use the provided or designated connection cables, power cables and AC adaptors. Using any other cables and adaptors could cause a malfunction or a fire. Electrical Appliance and Material Safety Law prohibits the use of UL or CSA -certified cables (that have UL/CSA shown on the code) for any other electrical devices than products designated by Supermicro only.

電源コードとACアダプター

製品を設置する場合、提供または指定された接続ケーブル、電源コードとACアダプターを使用下さい。他のケーブルやアダプタを使用すると故障や火災の原因になることがあります。電気用品安全法は、ULまたはCSA認定のケーブル(UL/CSEマークがコードに表記)をSupermicroが指定する製品以外に使用することを禁止しています。

警告

安裝此產品時，請使用本身提供的或指定的連接線，電源線和電源適配器。使用其它線材或適配器可能會引起故障或火災。除了Supermicro所指定的產品，電氣用品和材料安全法律規定禁止使用未經UL或CSA認證的線材。(線材上會顯示UL/CSA符號)。

警告

安裝此產品時，請使用本身提供的或指定的連接線，電源線和電源適配器。使用其它線材或適配器可能會引起故障或火災。除了Supermicro所指定的產品，電氣用品和材料安全法律規定禁止使用未經UL或CSA認證的線材。(線材上會顯示UL/CSA符號)。

Warnung

Bei der Installation des Produkts, die zur Verfügung gestellten oder benannt Anschlusskabel, Stromkabel und Netzteile. Verwendung anderer Kabel und Adapter kann zu einer Fehlfunktion oder ein Brand entstehen. Elektrische Geräte und Material Safety Law verbietet die Verwendung von UL-oder CSA-zertifizierte Kabel, UL oder CSA auf der Code für alle anderen elektrischen Geräte als Produkte von Supermicro nur bezeichnet gezeigt haben.

¡Advertencia!

Al instalar el producto, utilice los cables de conexión previstos o designados, los cables y adaptadores de CA. La utilización de otros cables y adaptadores podría ocasionar un mal funcionamiento o un incendio. Aparatos Eléctricos y la Ley de Seguridad del Material prohíbe el uso de UL o CSA cables certificados que tienen UL o CSA se muestra en el código de otros dispositivos eléctricos que los productos designados por Supermicro solamente.

Attention

Lors de l'installation du produit, utilisez les bables de connection fournis ou désigné. L'utilisation d'autres cables et adaptateurs peut provoquer un dysfonctionnement ou un incendie. Appareils électroménagers et de loi sur la sécurité Matériel interdit l'utilisation de UL ou CSA câbles certifiés qui ont UL ou CSA indiqué sur le code pour tous les autres appareils électriques que les produits désignés par Supermicro seulement.

חשמליים ומתאמי AC**אזהרה !**

כאשר מתקינים את המוצר, יש להשתמש בכבלים, ספקים ומתאמים AC אשר נועדו וסופקו לשם כך. שימוש בכל כבל או מתאם אחר יכול לגרום לתקלה או קצר חשמלי. על פי חוקי שימוש במכשירי חשמל וחוקי בטיחות, קיים איסור להשתמש בכבלים המוסמכים ב- UL או ב- CSA (כשאר מופיע עליהם קוד של UL/CSA) עבור כל מוצר חשמלי אחר שלא צוין על ידי סופרמיקרו בלבד.

عند تركيب الجهاز يجب استخدام كابلات التوصيل، والكابلات الكهربائية
ومحولات التيار المتردد

التي . أن استخدام أي كابلات ومحولات أخرى يتسبب في حدوث عطل أو حريق.
تم توفيرها لك مع المنتج

الأجهزة الكهربائية ومواد قانون السلامة يحظر استخدام الكابلات CSA أو UL
معتمدة من قبل

لأي أجهزة كهربائية أخرى غير المنتجات المعينة من قبل Supermicro
(التي تحمل علامة UL/CSA)

경고!

제품을 설치할 때에는 제공되거나 지정된 연결케이블과 전원케이블, AC어댑터를 사용해야 합니다. 그 밖의 다른 케이블들이나 어댑터들은 고장 또는 화재의 원인이 될 수 있습니다. 전기용품안전법 (Electrical Appliance and Material Safety Law)은 슈퍼마이크로에서 지정한 제품들 외에는 그 밖의 다른 전기 장치들을 위한 UL또는 CSA에서 인증한 케이블(전선 위에 UL/CSA가 표시)들의 사용을 금지합니다.

Waarschuwing

Bij het installeren van het product, gebruik de meegeleverde of aangewezen kabels, stroomkabels en adapters. Het gebruik van andere kabels en adapters kan leiden tot een storing of een brand. Elektrisch apparaat en veiligheidsinformatiebladen wet verbiedt het gebruik van UL of CSA gecertificeerde kabels die UL of CSA die op de code voor andere elektrische apparaten dan de producten die door Supermicro alleen.

Chapter 5

Advanced Motherboard Setup

This chapter covers the steps required to connect the C7Z170-SQ data and power cables and install add-on cards. All motherboard jumpers and connections are also described. A layout and quick reference chart are included in this chapter for your reference. Remember to completely close the chassis when you have finished working with the motherboard to better cool and protect the system.

5-1 Handling the Motherboard

Electrostatic discharge (ESD) can damage electronic components. To prevent damage to any printed circuit boards (PCBs), it is important to handle them very carefully. To prevent the motherboard from bending, keep one hand under the center of the board to support it when handling. The following measures are generally sufficient to protect your equipment from electrostatic discharge.

Precautions

- Use a grounded wrist strap designed to prevent Electrostatic Discharge.
- Touch a grounded metal object before removing boards from their antistatic bag.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the motherboard, add-on cards and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the motherboard.

5-2 Connecting Cables

Now that the motherboard is installed, the next step is to connect the cables to the board. These include the data (ribbon) cables for the peripherals and control panel and the power cables.

Connecting Data Cables

The cables used to transfer data from the peripheral devices have been carefully routed to prevent them from blocking the flow of cooling air that moves through the system from front to back. If you need to disconnect any of these cables, you should take care to keep them routed as they were originally after reconnecting them. The following data cables (with their locations noted) should be connected. (See the layout in Section 5-7 for connector locations.)

Important! Make sure the the cables do not come into contact with the fans.

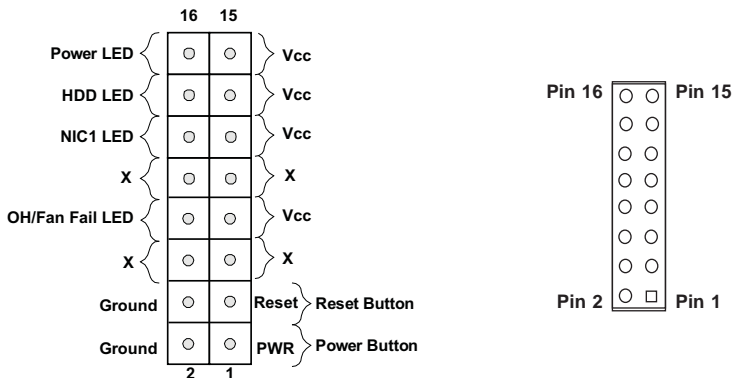
Connecting Power Cables

The C7Z170-SQ has a 24-pin primary power supply connector (JPW1) for connection to the ATX power supply. In addition, an 8-pin processor power connector (JPW2) must also be connected to your power supply. See Section 5-8 for power connector pin definitions.

Connecting the Control Panel

JF1 contains header pins for various front control panel connectors. See Figure 5-1 for the pin definition. All JF1 wires have been bundled into a single ribbon cable to simplify this connection. Make sure the red wire plugs into pin 1 as marked on the board.

Figure 5-1. Control Panel Header Pins

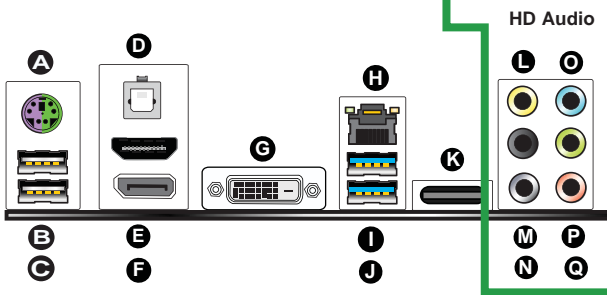


5-3 I/O Ports

The I/O ports are in conformance with the PC 99 specification. See Figure 5-2 below for the colors and locations of the various I/O ports.

Figure 5-2. I/O Ports

A. PS/2 Keyboard/Mouse Port	G. DVI-D Port	L. Center/LFE Out
B. USB 2.0 Port 0	H. Gb LAN Port	M. Surround Out
C. USB 2.0 Port 1	I. USB 3.0 Port 6	N. S-Surround Out
D. S/PDIF Out	J. USB 3.0 Port 7	O. Line In
E. HDMI Port	K. USB 3.1 Port 8, Type C	P. Line Out
F. VESA Display Port		Q. Mic In



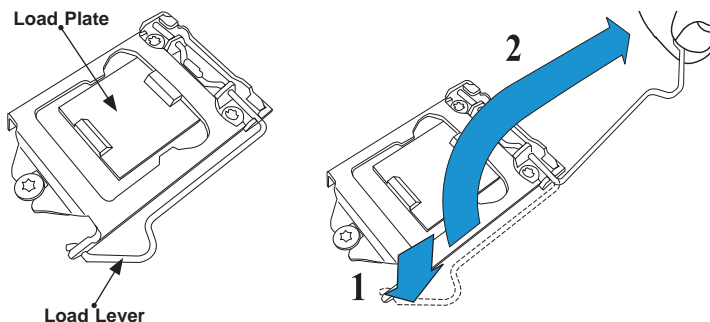
5-4 Processor and Heatsink Installation

Notes:

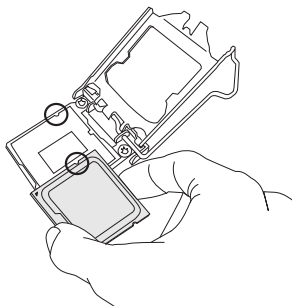
- Always connect the power cord last and always remove it before adding, removing or changing any hardware components. Make sure that you install the processor into the CPU socket before you install the CPU heatsink.
- If you buy a CPU separately, make sure that you use an Intel-certified multi-directional heatsink only.
- Make sure to install the motherboard into the chassis before you install the CPU heatsinks.
- When receiving a motherboard without a processor pre-installed, make sure that the plastic CPU socket cap is in place and none of the socket pins are bent; otherwise, contact your retailer immediately.
- Refer to the Supermicro web site for updates on CPU support.

Installing the LGA1155 Processor

1. Press the load lever to release the load plate, which covers the CPU socket, from its locked position.
2. Gently lift the load lever to open the load plate. Remove the plate cap.
3. Use your thumb and your index finger to hold the CPU at the top center edge and the bottom center edge of the CPU.



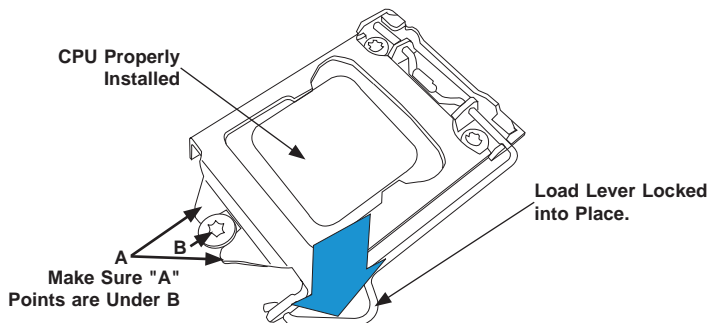
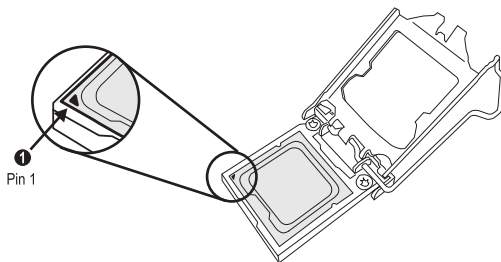
4. Align the CPU key (the semi-circle cutouts) against the socket keys. Once aligned, carefully lower the CPU straight down to the socket. (Do not drop the CPU on the socket. Do not move the CPU horizontally or vertically.



Do not rub the CPU against the surface or against any pins of the socket to avoid damage to the CPU or the socket.)

With the CPU inside the socket, inspect the four corners of the CPU to make sure that the CPU is properly installed.

5. Use your thumb to gently push the load lever down to the lever lock. Save the plastic PnP cap. The motherboard must be shipped with the PnP cap properly installed to protect the CPU socket pins. Shipment without the PnP cap properly installed will cause damage to the socket pins.



Warning: The CPU will only seat inside the socket in one direction. Make sure it is properly inserted before closing the load plate. If it doesn't close properly, do not force it as it may damage your CPU. Instead, open the load plate again and double-check that the CPU is aligned properly.

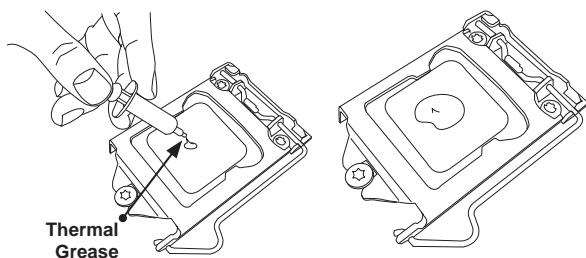
Installing an Active Fan CPU Heatsink

1. Locate the CPU Fan power connector on the motherboard. (Refer to the layout on the right for the CPU Fan location.)
2. Position the heatsink so that the heatsink fan wires are closest to the CPU fan power connector and are not interfered with other components.
3. Inspect the CPU Fan wires to make sure that the wires are routed through the bottom of the heatsink.
4. Remove the thin layer of the protective film from the copper core of the heatsink.

Warning: CPU may overheat if the protective film is not removed from the heatsink.

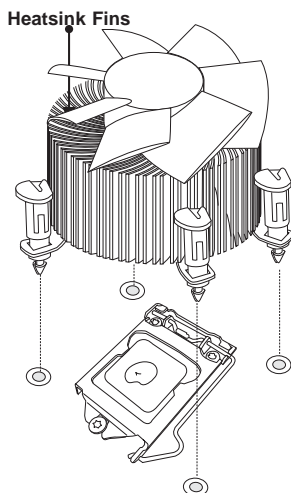
5. Apply the proper amount of thermal grease on the CPU.

Note: If your heatsink came with a thermal pad, please ignore this step.

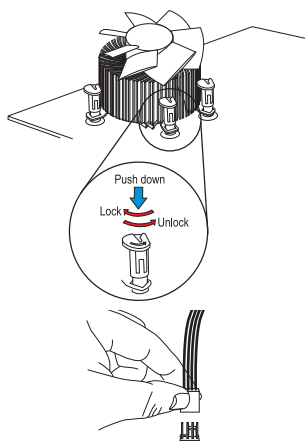


6. If necessary, rearrange the wires to make sure that the wires are not pinched between the heatsink and the CPU. Also make sure to keep clearance between the fan wires and the fins of the heatsink.

- Align the four heatsink fasteners with the mounting holes on the motherboard. Gently push the pairs of diagonal fasteners (#1 & #2, and #3 & #4) into the mounting holes until you hear a click. Also, make sure to orient each fastener so that the narrow end of the groove is pointing outward.



- Repeat Step 7 to insert all four heatsink fasteners into the mounting holes.
- Once all four fasteners are securely inserted into the mounting holes, and the heatsink is properly installed on the motherboard, connect the heatsink fan wires to the CPU Fan connector.



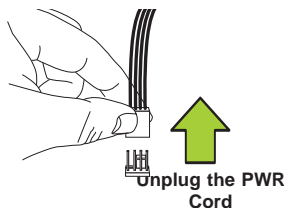
Warning: We do not recommend removing the CPU or the heatsink. However, if you do need to uninstall the heatsink, please follow these instructions to avoid damaging the CPU or the CPU socket.

Removing the Heatsink

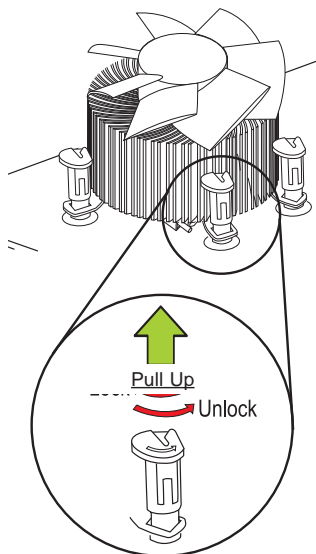
Warning: We do not recommend that the CPU or the heatsink be removed. However, if you do need to remove the heatsink, please follow the instructions below to remove the heatsink and to prevent damage done to the CPU or other components.

Active Heatsink Removal

1. Unplug the power cord from the power supply.



2. Disconnect the heatsink fan wires from the CPU fan header.
3. Use your finger tips to gently press on the fastener cap and turn it counterclockwise to make a 1/4 (90°) turn, and pull the fastener upward to loosen it.



4. Repeat Step 3 to loosen all fasteners from the mounting holes.
5. With all fasteners loosened, remove the heatsink from the CPU.

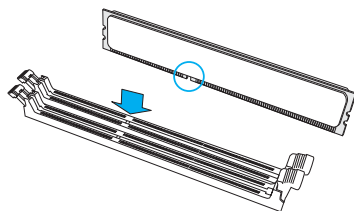
5-5 Installing Memory Modules

Note: Check the Supermicro web site for recommended memory modules.

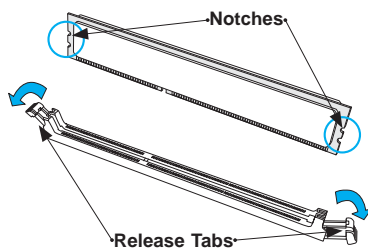
CAUTION! Exercise extreme care when installing or removing DIMM modules to prevent any possible damage.

DIMM Installation

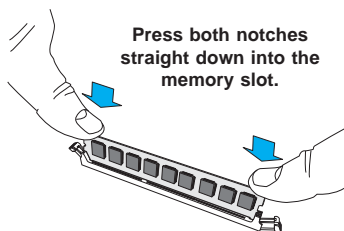
1. Insert the desired number of DIMMs into the memory slots, starting with DIMMA1 (see the next page for the location). For the system to work properly, please use the memory modules of the same type and speed in the same motherboard.
2. Push the release tabs outwards on both ends of the DIMM slot to unlock it.



3. Align the key of the DIMM module with the receptive point on the memory slot.
4. Align the notches on both ends of the module against the receptive points on the ends of the slot.



5. Use two thumbs together to press the notches on both ends of the module straight down into the slot until the module snaps into place.



6. Press the release tabs to the lock positions to secure the DIMM module into the slot.

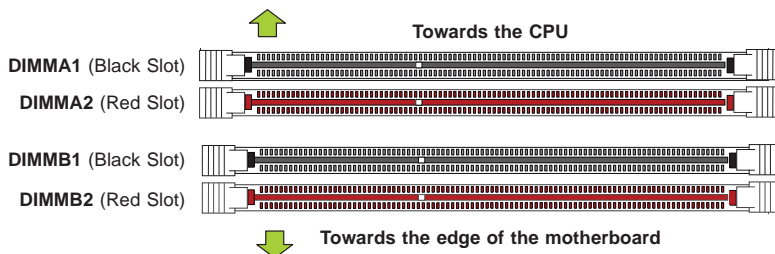
Removing Memory Modules

Reverse the steps above to remove the DIMM modules from the motherboard.

Memory Support

The C7Z170-SQ supports up to 64GB of Unbuffered (UDIMM) non-ECC DDR4 memory, up to 3000+MHz (OC) in four 288-pin memory slots. Populating these DIMM modules with a pair of memory modules of the same type and same size will result in interleaved memory, which will improve memory performance.

Notes:



- Be sure to use memory modules of the same type, same speed, same frequency on the same motherboard. Mixing of memory modules of different types and speeds is not allowed.
- Due to memory allocation to system devices, the amount of memory that remains available for operational use will be reduced when 4 GB of RAM is used. The reduction in memory availability is disproportional.
- For Microsoft Windows users: Microsoft implemented a design change in the Windows XP with Service Pack 2 (SP2) and Windows Vista. This change is specific to the behavior of Physical Address Extension (PAE) mode which improves driver compatibility. For more information, please read the following article at: Microsoft's Knowledge Base website at: <http://support.microsoft.com/kb/888137>.

Memory Population Guidelines

When installing memory modules, the DIMM slots should be populated in the following order: DIMMA2, DIMMB2, then DIMMA1, DIMMB1.

Notes:

- Always use DDR4 DIMM modules of the same size, type and speed.
- Mixed DIMM speeds can be installed. However, all DIMMs will run at the speed of the slowest DIMM.

Recommended Population (Balanced)				
DIMMA2	DIMMB2	DIMMA1	DIMMB1	Total System Memory
4GB	4GB			8GB
4GB	4GB	4GB	4GB	16GB
8GB	8GB			16GB
8GB	8GB	8GB	8GB	32GB
16GB	16GB			32GB
16GB	16GB	16GB	16GB	64GB

5-6 Adding PCI Add-On Cards

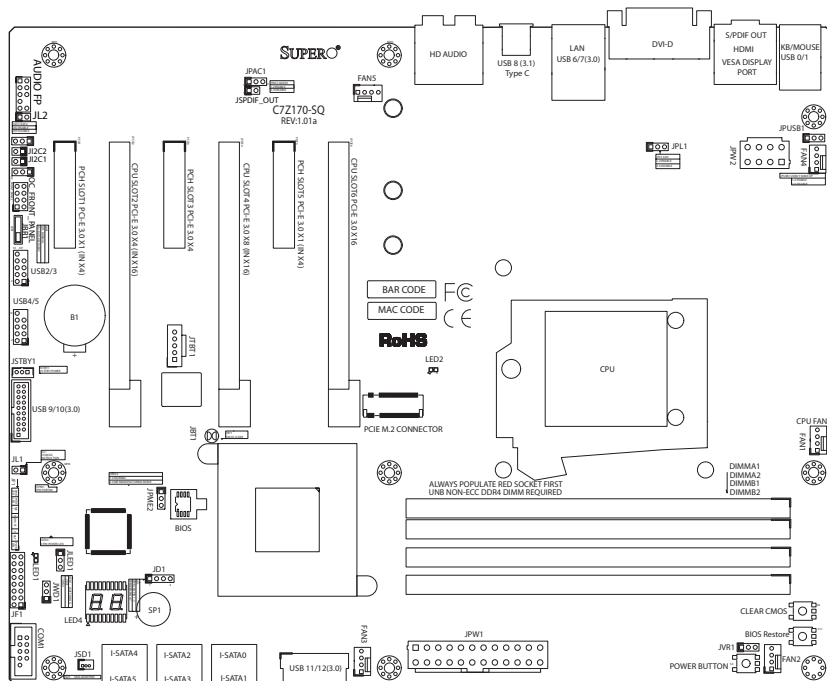
The 5039AD-T can accommodate standard size add-on cards populated in all slots on the C7Z170-SQ motherboard.

Installing an Add-on Card

1. Begin by removing the PCI slot shield for the slot you wish to populate.
2. Fully seat the card into the slot, pushing down with your thumbs evenly on both sides of the card.
3. Finish by using a screw to secure the top of the card bracket to the chassis. The PCI slot brackets protect the motherboard and its components from EMI and aid in proper ventilation, so make sure there is always a bracket covering each unused slot.

5-7 Motherboard Details

Figure 5-3. C7Z170-SQ Layout



C7Z170-SQ Quick Reference

Jumper	Description	Default
JBT1	Clear CMOS (on board)	(See Chpt. 2)
J ² C1/J1 ² C2	SMB to PCI-E Slots	On (Enabled)
JPAC1	Audio Enable	Pins 1-2 (Enabled)
JPL1	LAN Enable	Pins 1-2 (Enabled)
JPME2	Intel Recovery Mode	Pins 1-2 (Normal)
JWD1	Watch Dog Enable	Pins 1-2 (RST)
JBR1	BIOS Recovery Switch	Toggle Switch, Off (Disabled)
JPUSB1	USB Wake Up Enable (Back Panel USB 0/1)	Pins 1-2 (Enabled)
POWER BUTTON	Internal Power Button	Push Button Switch
BIOS Restore	Restores the BIOS from Firmware ('SUPER.ROM') on a USB memory device	Push Button Switch
Clear CMOS	Clear CMOS Switch	Push Button Switch

Connector	Description
I/O Back Panel	See Back Panel I/O Connectors, below right
Audio FP	Front Panel Audio Header
Battery	Onboard Battery
COM1	COM1 Port Header
Fan 1,2,3,4,5	System/CPU Fan Headers (Fan1: CPU Fan)
JD1	Speaker/buzzer (Pins 1~4: External Speaker, Pins 3~4: Buzzer)
JF1	Front Panel Control Header
JL1	Chassis Intrusion Header
JLED1	Power LED Indicator Header
JPW1	24-pin ATX Main Power Connector (Required)
JPW2	+12V 8-pin CPU power Connector (Required)
JSD1	SATA DOM (Disk On Module) Power Connector
JSPDIF_OUT	Sony/Philips Digital Interface (S/PDIF) Out Header
JSTBY1	5V Standby Power Header
SP1	Internal Speaker/Buzzer
I-SATA0~5	(Intel Z170) Serial ATA (SATA 3.0) Ports 0~5 (6Gb/sec)
USB 2/3, 4/5	Front Panel Accessible USB 2.0 Headers 2/3, 4/5
USB 9/10 (3.0)	Front Panel Accessible USB 3.0 Header 9/10
USB 11/12 (3.0)	Front Panel Accessible USB 3.0 Header 11/12
OC FRONT PANEL	Header for the Over-Clocking Control Panel
PCI-E M.2 CONNECTOR	PCI-E M.2 Connector for memory cards, wireless adapters, etc.

LED	Description	Color/State	Status
LED1	Onboard Standby PWR LED	Green: Solid on	Power On
LED2	M.2 LED	Green: M.2 on board	M.2 on board
LED4	Status Display	Digital Readout	Download the status codes below*

Important Notes to the User

- " " indicates the location of "Pin 1".
- Jumpers not indicated are for testing only.
- When LED1 (Onboard Power LED Indicator) is on, system power is on. Unplug the power cable before installing or removing any components.

5-8 Connector Definitions

ATX Main PWR & CPU PWR Connectors (JPW1 & JPW2)

The 24-pin main power connector (JPW1) is used to provide power to the motherboard. The 8-pin CPU PWR connector (JPW2) is also required for the processor. These power connectors meet the SSI EPS 12V specification. See the table on the right for pin definitions.

ATX Power 24-pin Connector Pin Definitions (JPW1)			
Pin#	Definition	Pin #	Definition
13	+3.3V	1	+3.3V
14	-12V	2	+3.3V
15	COM	3	COM
16	PS_ON	4	+5V
17	COM	5	COM
18	COM	6	+5V
19	COM	7	COM
20	Res (NC)	8	PWR_OK
21	+5V	9	5VSB
22	+5V	10	+12V
23	+5V	11	+12V
24	COM	12	+3.3V

12V 8-pin Processor Power Pin Definitions (JPW2)	
Pins	Definition
1 through 4	Ground
5 through 8	+12V

Required Connection

Power LED

The Power LED connection is located on pins 15 and 16 of JF1. Refer to the table on the right for pin definitions.

Power LED Pin Definitions (JF1)	
Pin#	Definition
15	+5V
16	Ground

HDD LED

The HDD LED connection is located on pins 13 and 14 of JF1. Attach a cable here to indicate the status of HDD-related activities, including IDE, SATA activities. See the table on the right for pin definitions.

HDD LED Pin Definitions (JF1)	
Pin#	Definition
13	+5V
14	HD Active

NIC1 (LAN)

The NIC (Network Interface Controller) LED connection for LAN port 1 is located on pins 11 and 12 of JF1. Attach an LED indicator to this header to display network activity. Refer to the table on the right for pin definitions.

LAN1/LAN2 LED Pin Definitions (JF1)	
Pin#	Definition
9/11	Vcc
10/12	Ground

Overheat (OH)/Fan Fail

Connect an LED cable to OH/Fan Fail connections on pins 7 and 8 of JF1 to provide warnings for chassis overheat/fan failure. Refer to the table on the right for pin definitions.

OH/Fan Fail LED Pin Definitions (JF1)	
Pin#	Definition
7	Vcc/Blue UID LED
8	OH/Fan Fail LED

OH/Fan Fail Indicator Status

State	Definition
Off	Normal
On	Overheat
Flashing	Fan Fail

Reset Button

The Reset Button connection is located on pins 3 and 4 of JF1. Attach it to a hardware reset switch on the computer case to reset the system. Refer to the table on the right for pin definitions.

Reset Button Pin Definitions (JF1)	
Pin#	Definition
3	Reset
4	Ground

Power Button

The Power Button connection is located on pins 1 and 2 of JF1. Momentarily contacting both pins will power on/off the system. This button can also be configured to function as a suspend button (with a setting in the BIOS - see Chapter 4). To turn off the power in the suspend mode, press the button for at least 4 seconds. Refer to the table on the right for pin definitions.

Power Button Pin Definitions (JF1)	
Pin#	Definition
1	Signal
2	Ground

Fan Headers (Fan 1 ~ Fan 5)

The C7Z170-SQ has five fan headers (Fan 1~Fan 5). These fans are 4-pin fan headers. Although pins 1-3 of the fan headers are backward compatible with the traditional 3-pin fans, we recommend the use 4-pin fans to take advantage of the fan speed control. This allows the fan speeds to be automatically adjusted based on the motherboard temperature. Refer to the table on the right for pin definitions.

Fan Header Pin Definitions	
Pin#	Definition
1	Ground (Black)
2	2.5A/+12V (Red)
3	Tachometer
4	PWM_Control

Chassis Intrusion

A Chassis Intrusion header is located at JL1 on the motherboard. Attach the appropriate cable from the chassis to inform you of a chassis intrusion when the chassis is opened.

Chassis Intrusion Pin Definitions (JL1)	
Pin#	Definition
1	Intrusion Input
2	Ground

Internal Buzzer

The Internal Buzzer (SP1) can be used to provide audible indications for various beep codes. See the table on the right for pin definitions.

Internal Buzzer Pin Definition		
Pin#	Definitions	
1	Pos. (+)	Beep In
2	Neg. (-)	Alarm Speaker

Speaker

On the JD1 header, pins 3~4 are used for internal speaker. Close pins 3~4 with a cap to use the onboard speaker. If you wish to use an external speaker, close Pins 1~4 with a cable. See the table on the right for pin definitions.

Speaker Connector Pin Definitions	
Pin Setting	Definition
Pins 3~4	Internal Speaker
Pins1~4	External Speaker

Onboard Power LED (JLED1)

An onboard Power LED header is located at JLED1. This Power LED header is connected to Front Control Panel located at JF1 to indicate the status of system power. See the table on the right for pin definitions.

Onboard PWR LED Pin Definitions	
Pin#	Definition
1	VCC
2	No Connection
3	Connection to PWR LED in JF1

Serial Port (COM1)

There is one serial (COM) port header on the motherboard. COM1 is located close to the SATA connectors. See the table on the right for pin definitions.

Serial/COM Ports Pin Definitions			
Pin#	Definition	Pin#	Definition
1	DCD	6	DSR
2	RXD	7	RTS
3	TXD	8	CTS
4	DTR	9	RI
5	Ground	10	N/A

DOM PWR Connector (JSD1)

The Disk-On-Module (DOM) power connector, located at JSD1, provides 5V (Gen1/Gen) power to a solid state DOM storage device connected to one of the SATA ports. See the table on the right for pin definitions.

DOM PWR Pin Definitions	
Pin#	Definition
1	5V
2	Ground
3	Ground

SPDIF OUT (JSPDIF_OUT)

The SPDIF Out (JSPDIF_OUT) is used for digital audio output. You will also need the appropriate cable to use this feature.

SPDIF_OUT Pin Definitions	
Pin#	Definition
1	S/SPDIF_Out
2	Ground

Standby Power Header (STBY1)

The Standby Power header is located at JSTBY1 on the motherboard. See the table on the right for pin definitions.

Standby Power Pin Definitions	
Pin#	Definition
1	+5V Standby
2	Ground
3	Wake-up

OC Front Panel (OC FRONT PANEL)

This header is for the optional Over-Clocking (OC) control panel. Attach the control panel's cable to this header. The OC control panel enables over-clocking control and management from the front of the chassis.

Front Panel Audio Header (AUDIO FP)

A 10-pin Audio header is supported on the motherboard. This header allows you to connect the motherboard to a front panel audio control panel, if needed. Connect an audio cable to the audio header to use this feature (not supplied). See the table at right for pin definitions for the header.

10-in Audio Pin Definitions	
Pin#	Signal
1	Microphone_Left
2	Audio_Ground
3	Microphone_Right
4	Audio_Detect
5	Line_2_Right
6	Ground
7	Jack_Detect
8	Key
9	Line_2_Left
10	Ground

Ethernet Port

One Gigabit Ethernet port (LAN) is located next to the DVI-D port on the I/O Backpanel to provide network connections. This port will accept RJ45 type cables.

Note: Please refer to the LED Indicator Section for LAN LED information.

LAN Ports Pin Definition			
Pin#	Definition	Pin#	Definition
1	P2V5SB	10	SGND
2	TD0+	11	Act LED
3	TD0-	12	P3V3SB
4	TD1+	13	Link 100 LED (Green, +3V3SB)
5	TD1-	14	Link 1000 LED (Yellow, +3V3SB)
6	TD2+	15	Ground
7	TD2-	16	Ground
8	TD3+	17	Ground
9	TD3-	18	Ground

(NC: No Connection)

HDMI Port

One HDMI (High-Definition Multimedia Interface) is located on the I/O backpanel. This connector is used to display both high definition video and digital sound through an HDMI capable display, using a single HDMI cable (not included).

Universal Serial Bus (USB)

Two Universal Serial Bus 2.0 ports (#0/1), two USB 3.0 ports (#6/7) and one USB 3.1 'type C' port (#8) are located on the I/O back panel. In addition, two USB 3.0 headers (four ports: #9/10, #11/12), and one USB 2.0 header (two ports: #4/5) are also located on the motherboard to provide front chassis access using USB cables (not included). See the tables below for pin definitions.

**Front Panel USB (2.0) Header #4/5
Pin Definitions**

Pin #	Definition	Pin #	Definition
1	+5V	2	+5V
3	USB_PN2	4	USB_PN3
5	USB_PP2	6	USB_PP3
7	Ground	8	Ground
9	Key	10	Ground

**Back Panel USB (2.0) #0/1, USB
(3.0) #6/7 Pin Definitions**

Pin#	Definition	Pin#	Definition
1	+5V	5	+5V
2	USB_PN1	6	USB_PN0
3	USB_PP1	7	USB_PP0
4	Ground	8	Ground

**Front Panel USB (3.0) Header #9/10,
#11/12
Pin Definitions**

Pin#	Pin#	Signal Name	Description
1	10	VBUS	Power
2	11	D-	USB 2.0 Differential Pair
3	12	D+	
4	13	Ground	Ground of PWR Return
5	14	StdA_SSRX-	SuperSpeed Receiver
6	15	StdA_SSRX+	Differential Pair
7	16	GND_DRAIN	Ground for Signal Return
8	17	StdA_SSTX-	SuperSpeed Transmitter
9	18	StdA_SSTX+	Differential Pair

DVI-D Port

A DVI-D port is located on the I/O backpanel. Use this port to connect to a compatible DVI (Digital Visual Interface) display.

Back Panel High Definition Audio (HD Audio)

This motherboard features a 7.1+2 Channel High Definition Audio (HDA) codec that provides 10 DAC channels. The HD Audio connections simultaneously supports multiple-streaming 7.1 sound playback with 2 channels of independent stereo output through the front panel stereo out for front, rear, center and subwoofer speakers. Use the Advanced software included in the CD-ROM with your motherboard to enable this function.

S/PDIF Port

A S/PDIF port is located next to the USB ports 0/1 on the I/O backpanel. Use this port to connect to a compatible S/PDIF optical audio device.

VESA DisplayPort

DisplayPort™, developed by the VESA® consortium, delivers digital display at a fast refresh rate. It can connect to virtually any display device using a DisplayPort adapter for devices such as VGA, DVI or HDMI.

PCI-E M.2 Connector (PCI-E M.2)

The PCI-E M.2 connector is for devices such as memory cards, wireless adapters, etc. These devices must conform to the PCIe M.2 specifications (formerly known as NGFF).

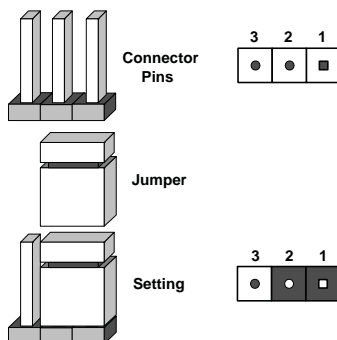
Note: This particular PCIe M.2 supports M-Key (PCIe3.0 x4) storage card only.

5-9 Jumper Settings

Explanation of Jumpers

To modify the operation of the motherboard, jumpers can be used to choose between optional settings. Jumpers create shorts between two pins to change the function of the connector. Pin 1 is identified with a square solder pad on the printed circuit board. See the motherboard layout pages for jumper locations.

Note: On a two-pin jumper, "Closed" means the jumper is on both pins and "Open" means the jumper is either on only one pin or completely removed.



CMOS Clear

JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

1. First power down the system and unplug the power cord(s). It is also recommended that you remove the onboard battery from the motherboard.
2. With the power disconnected, short the CMOS pads with a metal object such as a small screwdriver.
3. Remove the screwdriver (or shorting device).
4. Reconnect the power cord(s) and power on the system.

Note 1. For an ATX power supply, you must completely shut down the system, remove the AC power cord, and then short JBT1 to clear CMOS.

Note 2. Be sure to remove the onboard CMOS Battery before you short JBT1 to clear CMOS.

Note 3. Clearing CMOS will also clear all passwords.

Note 4: Do not use the PW_ON connector to clear CMOS.

LAN Enable/Disable

Jumper JPL1 will enable or disable the LAN port on the motherboard. See the table on the right for jumper settings. The default setting is enabled.

GLAN Enable Jumper Settings	
Pin#	Definition
1-2	Enabled (default)
2-3	Disabled

PCI Slot SMB Enable (I2C1/I2C2)

Use Jumpers I²C1/I²C2 to enable PCI SMB (System Management Bus) support to improve system management for the PCI slots. See the table on the right for jumper settings.

PCI Slot_SMB Enable Jumper Settings	
Jumper Setting	Definition
Short (Default)	Enabled
Open	Disabled

Audio Enable (JPAC1)

JPAC1 allows you to enable or disable the onboard audio support. The default position is on pins 1 and 2 to enable onboard audio connections. See the table on the right for jumper settings.

Audio Enable/Disable Jumper Settings	
Both Jumpers	Definition
Pins 1-2	Enabled
Pins 2-3	Disabled

Watch Dog Enable/Disable

Watch Dog (JWD1) is a system monitor that can reboot the system when a software application hangs. Close Pins 1-2 to reset the system if an application hangs. Close Pins 2-3 to generate a non-maskable interrupt signal for the application that hangs. See the table on the right for jumper settings.

Watch Dog Jumper Settings	
Jumper Setting	Definition
Pins 1-2	Reset (default)
Pins 2-3	NMI
Open	Disabled

USB Wake Up (JPUSB1)

Use jumper JPUSB to activate the "wake-up" function of the USB ports by pressing a key on a USB keyboard or clicking the USB mouse connected. This jumper is used together with a USB Wake-Up feature in the BIOS. Enable this jumper and the USB support in the BIOS to wake up your system via USB devices.

USB Wake-Up Jumper Settings	
Jumper Setting	Definition
Pins 1-2	Enabled (Default)
Pins 2-3	Disabled

Manufacturing Mode (JPME2)

Close Pin 2 and Pin 3 of Jumper JPME2 to bypass SPI flash security and force the system to operate in Manufacturing Mode, allowing the user to flash the system firmware from a host system for system setting modifications. See the table on the right for jumper settings.

Manufacture Mode (JPME2) Jumper Settings	
Pin#	Definition
1-2	Normal (Default)
2-3	Manufacture Mode

BIOS Recovery Switch (JBR1)

The BIOS Recovery Switch (JBR1) is used to enable or disable the BIOS Recovery feature of the motherboard. Slide the switch from the default position to begin the recovery process. See Appendix D for details.

BIOS Recovery (JBR1) Jumper Settings	
State	Definition
Off	Normal (Default)
On	Recover

**Off****On**

Power Button (POWER BUTTON)

In addition to the soft power switch provided in JF1, your motherboard is equipped with a 'soft' power button on the motherboard. This switch works the same way as the soft power switch on JF1.

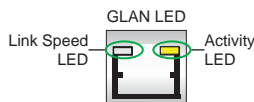
BIOS Restore (BIOS RESTORE)

When pressed, the BIOS Restore Button will look for, and load a file named 'SUPER.ROM' from an installed USB memory device, in any of the USB ports. It will then proceed to update the BIOS. Do NOT turn off the system when BIOS is updating.

5-10 Onboard Indicators

LAN LEDs

One LAN port is located on the I/O backpanel of the motherboard. This Ethernet LAN port has two LEDs (Light Emitting Diode). The yellow LED indicates activity, while the Link LED may be green, amber, or off to indicate the speed of the connections. See the tables at right for more information.



**LAN Port Activity LED (Left)
LED State**

Color	Status	Definition
Orange	Flashing	Active

**1Gbps LAN Link
LED Settings
(For X##xxx-MB)**

Color	Definition
Off	No Connection, 10 Mbps
Green	100 Mbps
Amber	1 Gbps

Onboard Power LED (LED1)

An Onboard Power LED is located at LED1 on the motherboard. When LED1 is on, the AC power cable is connected. Make sure to disconnect the power cable before removing or installing any component. See the layout below for the LED location.

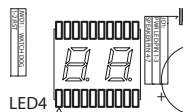
**Onboard PWR LED
Indicator
LED Status**

Status	Definition
Off	System Off
On	System on, or System off and PWR Cable Connected

Status Display (LED4)

LED4 is made up of two alpha-numeric displays that will display a status or POST code, when the motherboard is powered on. Please download the following AMI publication for a complete list of POST codes:

http://www.ami.com/support/doc/ami_apio_4.x_status_codes_pub.pdf



M.2 On Board (LED2)

The M.2 On Board LED is located on LED2. When lit, this indicates that an M.2 device is detected in the M.2 slot of the motherboard, and is working normally.

5-11 SATA Connections

SATA Connections (I-SATA0~I-SATA5)

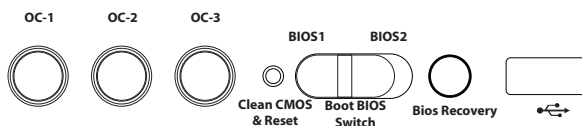
Six Serial ATA (SATA) 3.0 connectors (I-SATA 0~5) are supported on the board. These I-SATA 3.0 ports are supported by the Intel Z170 PCH chip (supports RAID 0,1,5,10). See the table below for pin definitions.

SATA 3.0 Connectors Pin Definitions	
Pin#	Signal
1	Ground
2	SATA_TXP
3	SATA_TXN
4	Ground
5	SATA_RXN
6	SATA_RXP
7	Ground

5-12 The OC Front Control Panel (Optional)

The OC (Over-Clocking) Front Control Panel has Six (6) control buttons, switches and one USB port.

Figure 5-4. OC Front Control Panel Controls



Over-Clocking Buttons (OC1, OC2, OC3)

Press these buttons to activate the over-clocking feature of the motherboard. These buttons will allow the CPU to run above its rated speed. This is an advanced feature and should only be used by experienced users. These work the same way as the OC buttons on the motherboard, see Page 2-32 for details.

Clear CMOS and Reset

Use the push-button hardware switch to clear the CMOS memory back to its default values and reset the system. There is also a similar switch on the motherboard (JBT1), but is made up of two contact pads that need to be shorted with a metallic object (i.e., screwdriver, etc).

Boot BIOS Switch

The Boot BIOS Switch is used to select between two boot BIOS blocks that are installed on the motherboard. See Appendix D for details.

BIOS Recovery

Push the BIOS Recovery button to enable the motherboard to enter the BIOS Recovery process and re-install the BIOS, reverting all settings back to factory default. It looks for a file named "SUPER.ROM" from a memory device attached to any of the USB drives. It functions the same way as the BIOS Restore Button which is installed on the motherboard, see page 2-34.

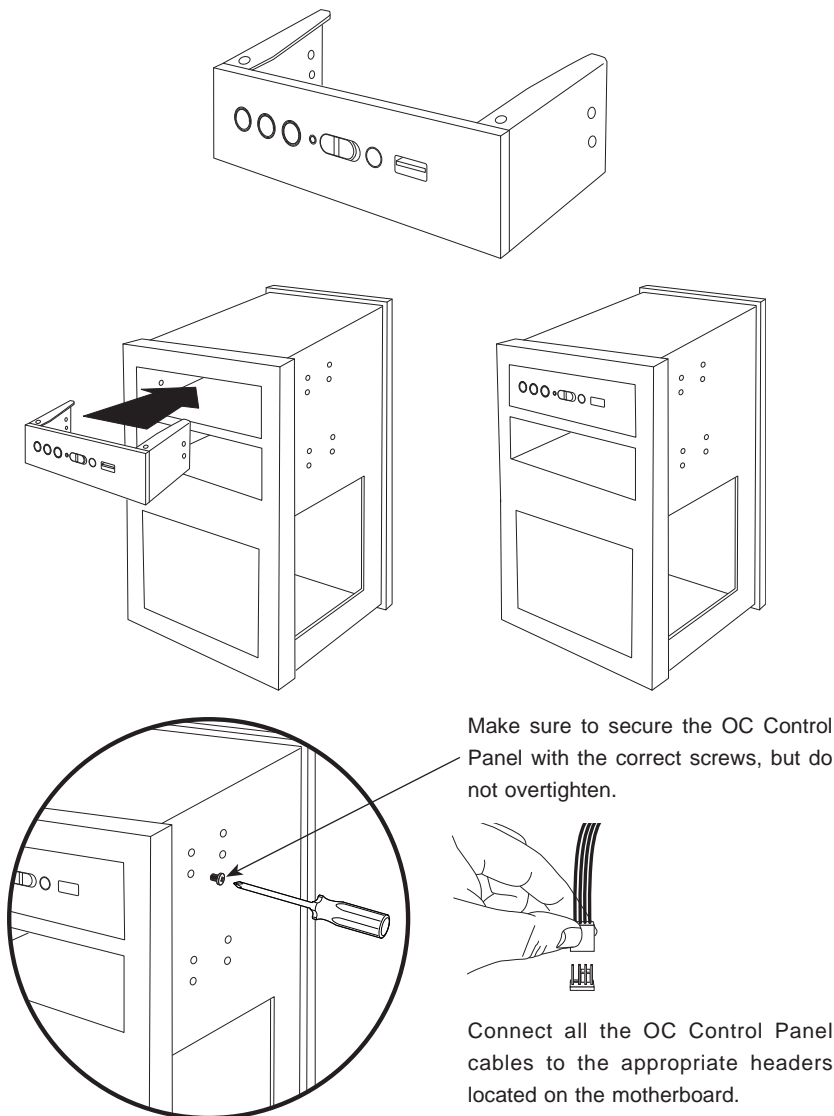
Front USB Port

The Front USB Port is defined as USB 3.0 Port# XX on this motherboard. It is conveniently located on the OC panel for quick access for USB memory sticks and other storage devices.

Installing the OC Front Control Panel

The OC Front Control Panel is designed to fit into an external 5.25-inch external drive bay of a desktop-style or tower-style computer chassis. Make sure that the appropriate type of screws are used. The OC Control panel easily slides into a standard 5.25-inch drive bay on a desktop or tower-style computer chassis.

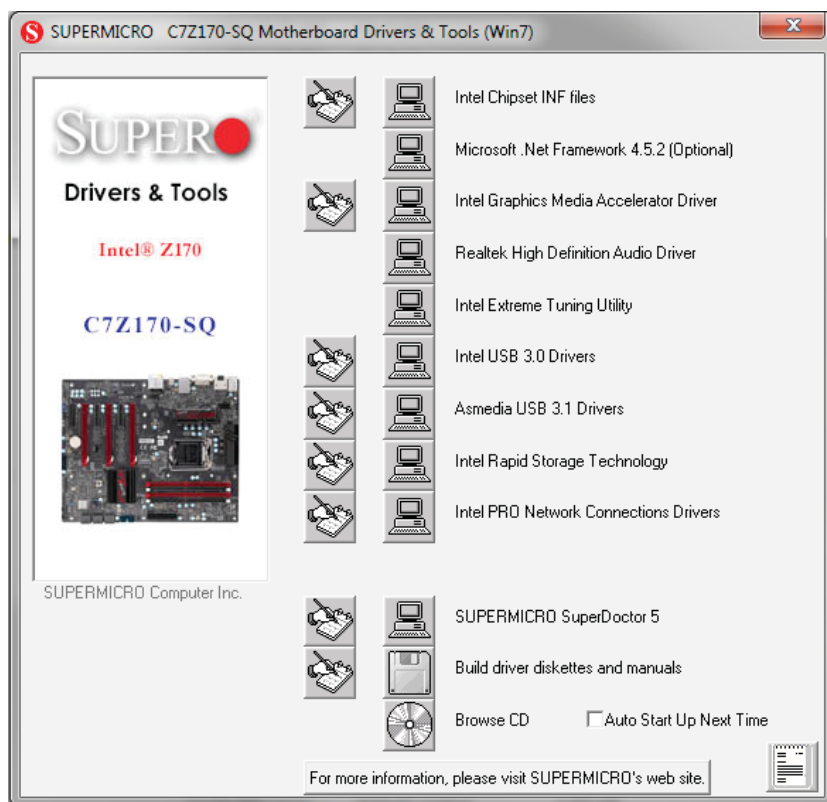
Figure 5-5. The OC Front Control Panel Placement



5-13 Installing Drivers

After all the hardware and operating system have been installed, you need to install certain drivers. The necessary drivers are all included on the Supermicro CD that came packaged with your motherboard. After inserting this CD into your CD-ROM drive, the display shown in Figure 5-6 should appear. (If this display does not appear, click on the My Computer icon and then on the icon representing your CD-ROM drive. Finally, double click on the S "Setup" icon.)

Figure 5-6. Driver Installation Display Screen



Click the icons showing a hand writing on paper to view the readme files for each item. Click the tabs to the right of these *in order from top to bottom* to install each item one at a time. **After installing each item, you must reboot the system before moving on to the next item on the list.** You should install everything here except for the SUPER Doctor utility, which is optional. The bottom icon with a CD on it allows you to view the entire contents of the CD.

SuperDoctor 5

The Supermicro SuperDoctor® 5 is a hardware and operating system services monitoring program that functions in a command-line or web-based interface in Windows and Linux operating systems. The program monitors system health information such as CPU temperature, system voltages, system power consumption, fan speed, and provides alerts via email or Simple Network Management Protocol (SNMP).

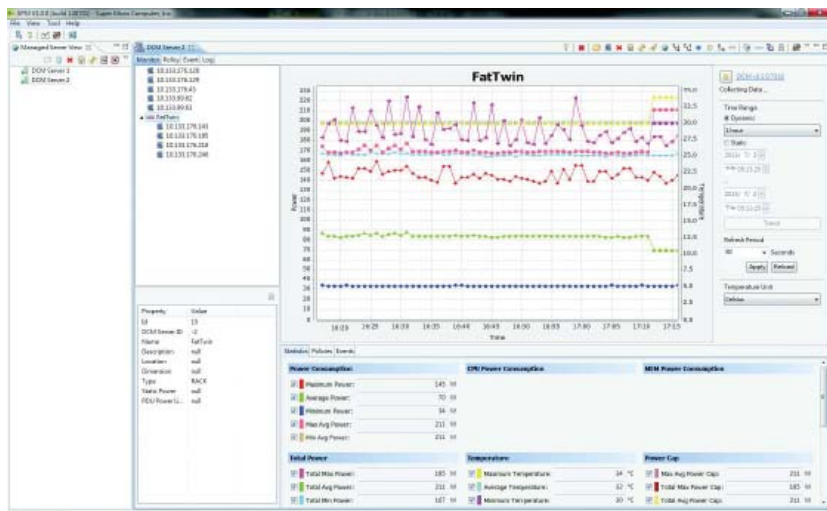
SuperDoctor 5 comes in local and remote management versions and can be used with Nagios to maximize your system monitoring needs. With SuperDoctor 5 Management System (SSM System), you can remotely control power on/off and reset chassis intrusion for multiple systems with SuperDoctor 5 or IPMI. SD5 Management System monitors HTTP, FTP, and SMTP services to optimize the efficiency of your operation.

Note: The default User Name and Password for SuperDoctor 5 is admin / admin.

Figure 5-7. SuperDoctor 5 Interface Display Screen (Health Information)



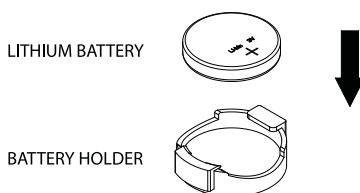
Figure 5-8. SuperDoctor 5 Interface Display Screen (Remote Control)



5-14 Motherboard Battery

Caution: There is a danger of explosion if the onboard battery is installed upside down, which will reverse its polarities (see Figure 5-9). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer (CR2032). Dispose of used batteries according to the manufacturer's instructions.

Figure 5-9. Installing the Onboard Battery



Please handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Please comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

Notes

Chapter 6

Advanced Chassis Setup

This chapter covers the steps required to install components and perform simple maintenance. Following the component installation steps in the order given will eliminate most common problems. If some steps are unnecessary, skip ahead to the step that follows.

Tools Required: The only tool you will need is a Philips screwdriver.

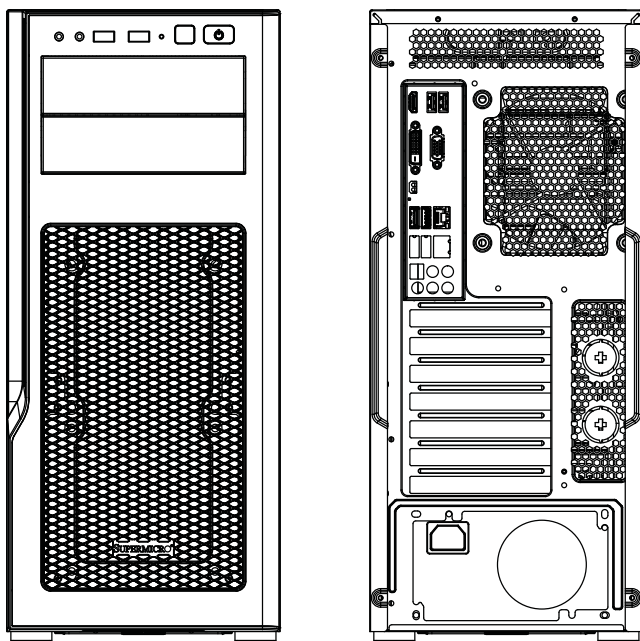
6-1 Static-Sensitive Devices

Static electrical discharge can damage electronic components. To prevent damage to any printed circuit boards (PCBs), it is important to handle them very carefully. The following measures are generally sufficient to protect your equipment from static discharge.

Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Touch a grounded metal object before removing any board from its antistatic bag.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the motherboard, add-on cards and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the motherboard.

Note: The components in the following figures are representative for illustration purposes only.

Figure 6-1. Front and Rear View

6-2 Removing Power from the System

Before performing most setup or maintenance tasks, use the following procedure to ensure that power has been removed from the system.

1. Use the operating system to power down the system, following the on-screen prompts.
2. After the system has completely shut-down, carefully grasp the head of the power cord and gently pull it out of the back of the power supply.
3. Disconnect the cord from the power strip or wall outlet.

6-3 Accessing the Inside of the System

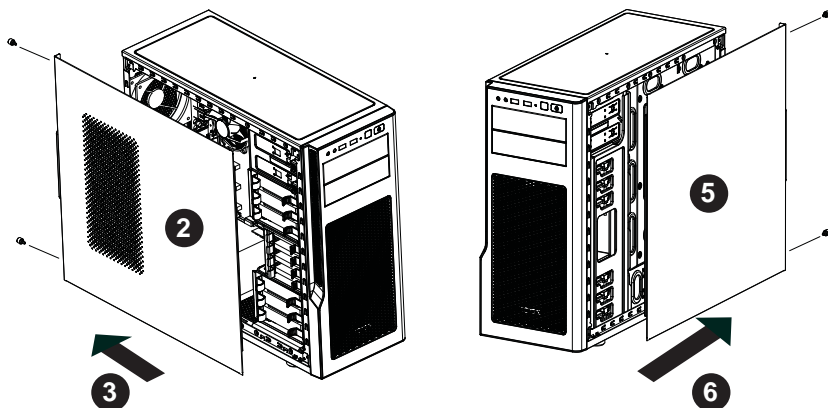
Caution: Except for short periods of time, do not operate the system without the cover in place. The chassis cover must be in place to allow proper airflow and prevent overheating.

Left Side and Right Side Covers

Removing a Side Chassis Cover

1. Power down the system as described in section 6-2.
2. Remove the two thumb screws on the rear of the chassis.
3. Slide the cover back toward the rear of the chassis.

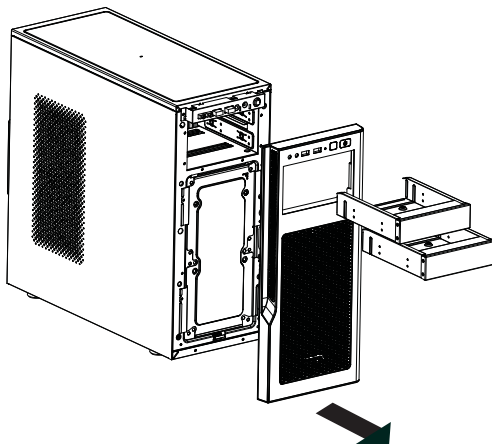
Figure 6-2. Removing the Chassis Side Covers



Front Bezel

Remove the front bezel by pulling it off from the bottom of the bezel. This should only be necessary when replacing the front fans.

Figure 6-3. Removing the Front Bezel



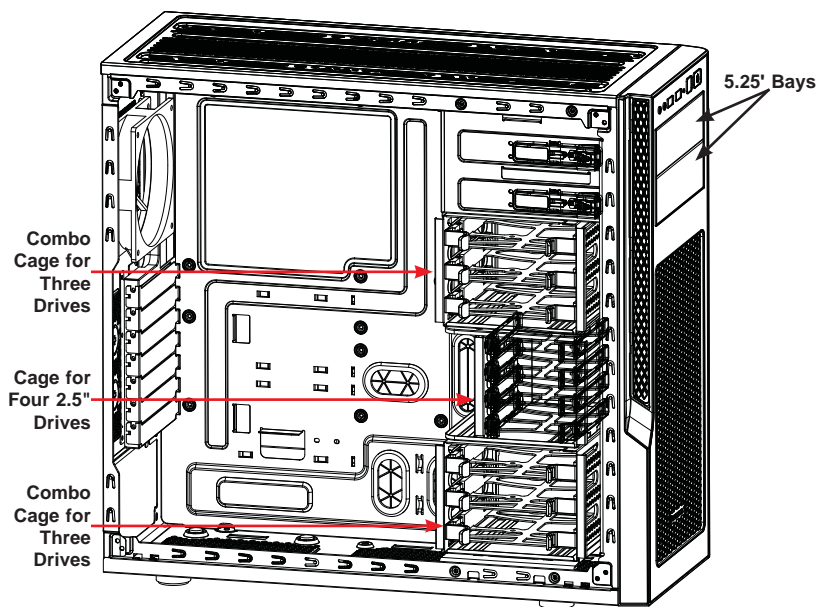
6-4 Installing Drives

Warning: Enterprise level hard disk drives are recommended for use in Supermicro chassis and servers. For information on recommended HDDs, visit the Supermicro Web site at <http://www.supermicro.com/products/nfo/files/storage/SBB-HDDCompList.pdf>

The standard configuration includes two 5.25" drive bays, four 2.5" drive bays, and six combination bays that can house either 3.5" or 2.5" drives.

- Each 5.25" bay can be configured to accept a removable media drive, such as DVD, or a storage device, such as a 3.5" HDD, 2.5" HDD, or solid state drive.
- The four 2.5" bays are housed in a removable cage.
- Two additional removable cages can each accommodate three 2.5" or 3.5" drives.

Figure 6-4. Drive Bays

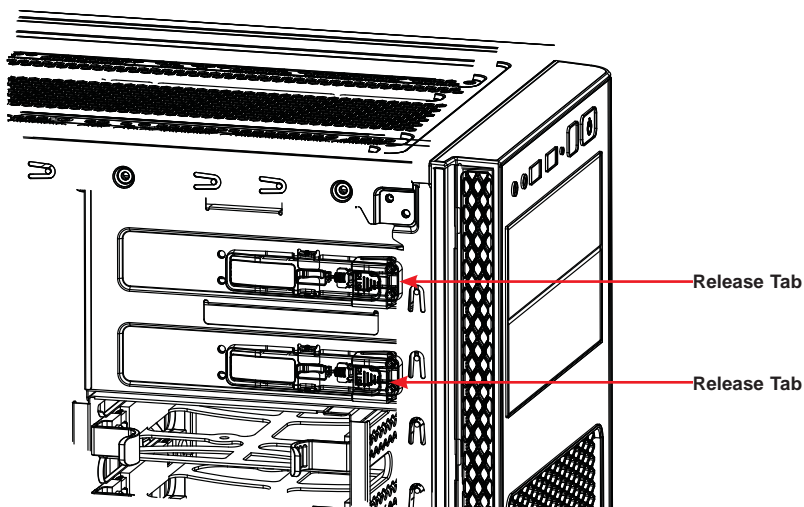


Installing a DVD Drive in the 5.25" Drive Bay

Replace a drive tray with a DVD drive.

1. Open the chassis left side cover.
2. Locate and press the release tab for the drive tray where you want to place the DVD drive.

Figure 6-5. Release Tabs for the Drive Tray



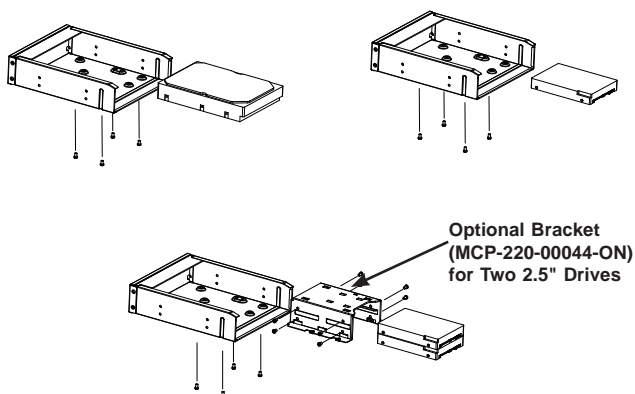
3. Push the drive tray toward the front of the chassis and out.
4. Slide the DVD drive into the chassis until it clicks into place.

Installing a Storage Device in the 5.25" Drive Tray

You can install a 3.5" drive, one or two 2.5" disk drives or solid state drives.

1. Open the chassis left side cover.
2. Locate and press the release tab (Figure 6-5) for the drive tray in which you want to place the drive.

Figure 6-6. Storage Device Configurations for 5.25" Bays



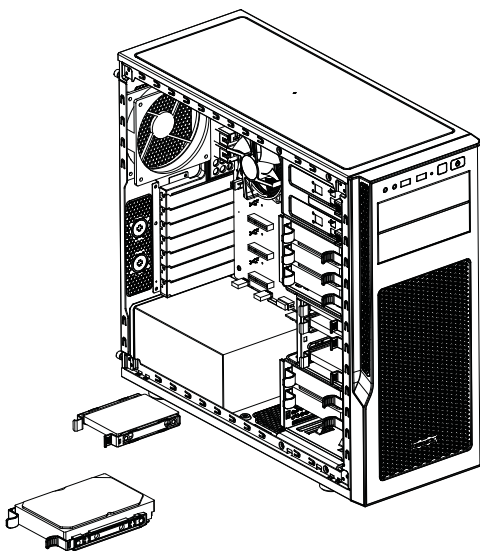
3. Push the drive tray toward the front of the chassis and out.
4. Secure the storage drive to the drive tray with screws through the bottom of the tray. To install two 2.5" drives, use the optional bracket (P/N MCP-220-00044-0N) as shown.
5. Slide the drive tray into the chassis until it clicks into place.

Installing Disk Drives into the Cage

You can install up to four 2.5" drives into the dedicated center cage. You can also install three drives into each of the upper and lower combination cages.

1. Open the chassis left side cover.
2. Remove the drive mounting bracket from the cage. Pinch the tabs and pull out.

Figure 6-7. Installing Drives and Mounting Brackets in to the Cage



3. Secure the drive into the mounting bracket.
 - For 2.5" drives in the dedicated bays (center cage), flex the drive bracket and drop the drive in with the connector side facing into the chassis.
 - For 3.5" drives in the combo bays (top or bottom cages), flex the drive bracket and drop the drive in with the connector side facing into the chassis.
 - For 2.5" drives in the combo bays, use screws through the bottom of the bracket to secure the drive with the connector side facing into the chassis.
 4. Slide the assembly into the cage.
 5. Connect the storage device cables from the motherboard.
-

Figure 6-8. Mounting Tray for 3.5" Drive

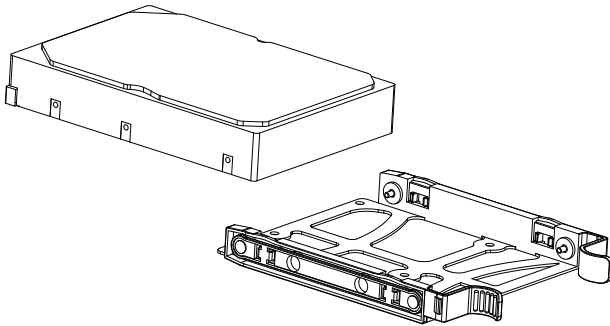
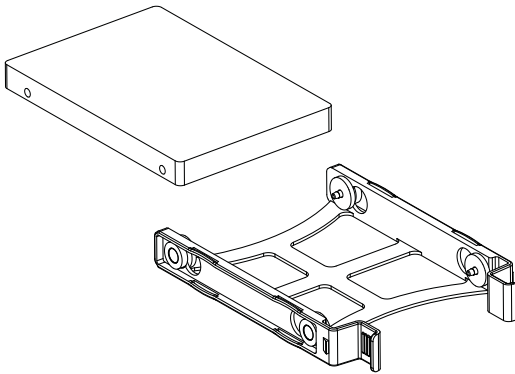


Figure 6-9. Mounting Tray for 2.5" Drive



Note: Refer to the following FTP site for RAID setup guidelines: <ftp://ftp.supermicro.com/driver/SAS/LSI/LSI_SAS_EmbMRAID_SWUG.pdf> and Supermicro's web site for additional information < <http://www.supermicro.com/support/manuals/>>.

6-5 Installing the Motherboard

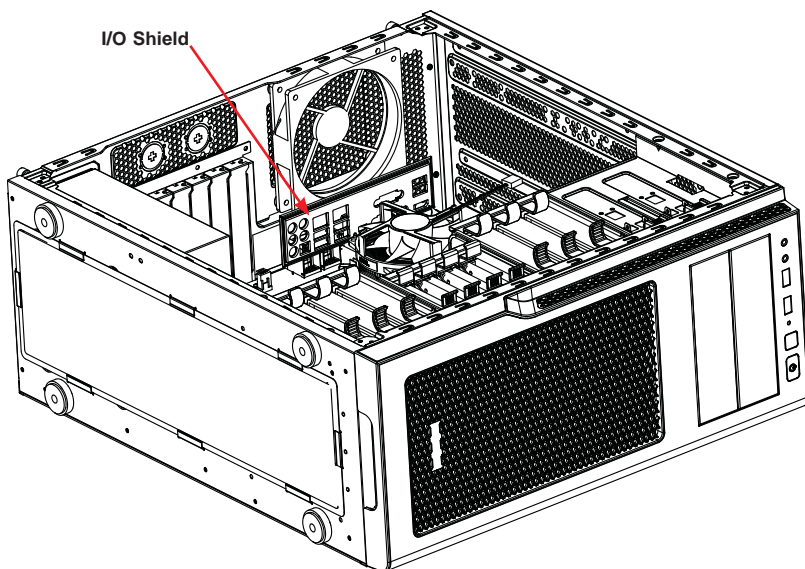
Installing the I/O Shield

The shield encloses the I/O ports at the rear of the chassis. Install it before installing the motherboard. The motherboard package should include a compatible shield.

Installing the I/O Shield

1. Open the chassis left side cover.
2. With the illustrations facing outward, place the shield into the space provided at the rear of the chassis.

Figure 6-10. Installing the I/O Shield



Motherboard Standoffs

Standoffs prevent short circuits by securing space between the motherboard and the chassis surface. Three standoffs are pre-installed. Some motherboards require additional standoffs. The chassis accessory box contains standoffs and rounded Phillips head screws.

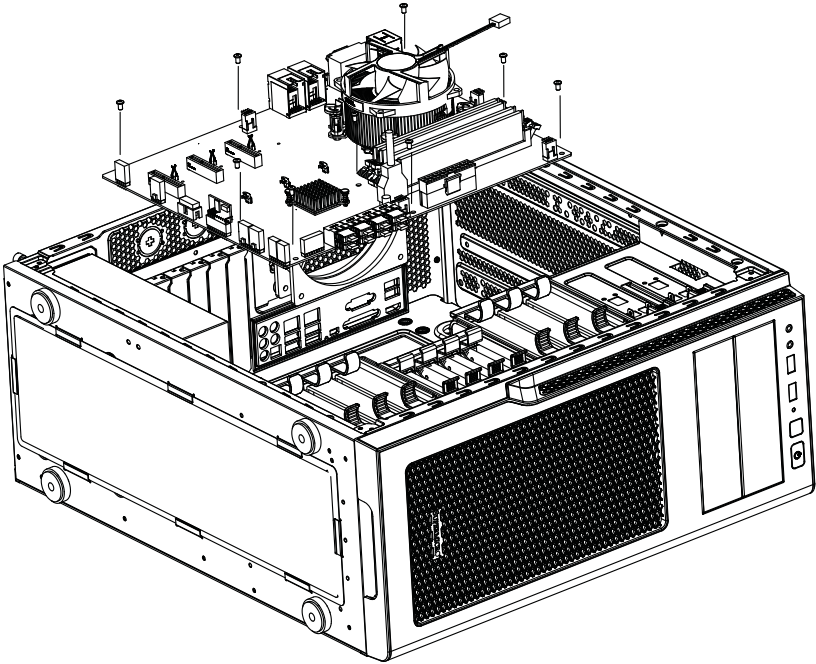
Compare the mounting holes in the motherboard to those in the chassis and add or remove standoffs as needed. Secure the hexagonal standoff, rounded side up, by screwing it into the mounting base of the chassis. Once all standoffs are in place, you are ready to mount the motherboard.

Motherboard Installation

Installing the Motherboard

1. Review the documentation that came with your motherboard. Become familiar with component placement, requirements, precautions, and cable connections.
2. Install standoffs in the locations required by your motherboard.

Figure 6-11. Installing the Motherboard



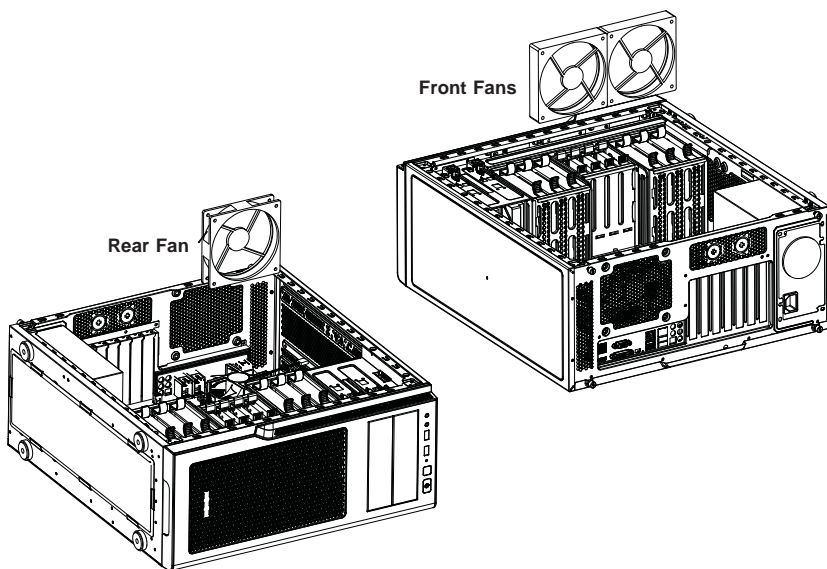
3. Lay the motherboard on the chassis, aligning the standoffs.
4. Secure the motherboard to the standoffs using the rounded, Phillips head screws. Do not exceed eight inch-pounds of torque when tightening the screws.
5. Secure the CPU, heatsinks, and other components to the motherboard as described in the motherboard documentation.
6. Connect the cables between the motherboard and other components such as the chassis, front panel, drives, fans and power supply.
7. Replace the chassis cover, plug the power cord into the rear of the power supply and power up the system.

6-6 Fans and Cooling

The chassis includes two 120mm PWM fans in the front and one 120mm PWM in the rear. Other fan mounts and configurations are possible.

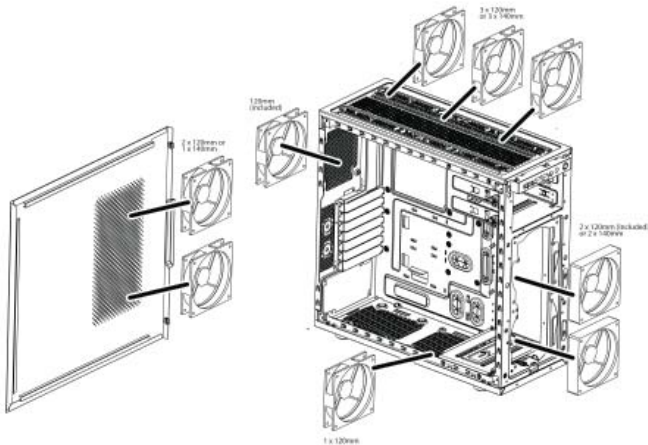
- Two front fans can be upgraded to 140mm.
- Three fans can be mounted on the chassis top, 120mm or 140mm.
- One fan can be mounted on the chassis bottom, 120mm.
- Fans can be mounted on the chassis side: two 120mm or one 140mm.

Figure 6-12. Standard Fan Placement



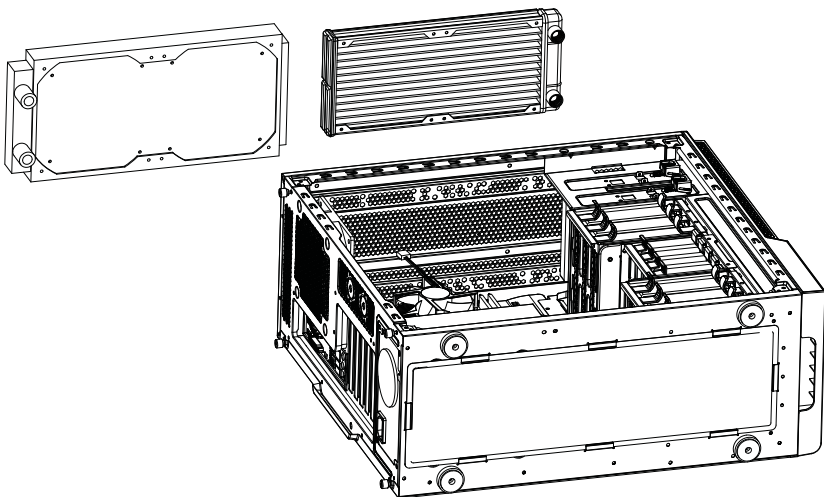
Adding or Changing Fans

- To upgrade the standard front fans, remove the chassis front cover.
- To add a fan to the chassis bottom, the lower 3.5" HDD cage must be removed. See Figure 6-13.

Figure 6-13. All Possible Fan Placements

Water Cooled Heat Sink

The chassis supports a water cooled CPU heat sink. A 120 mm radiator can be placed over the rear fan. A 240 mm radiator can be placed just under the top of the chassis. Consult your water cooling kit instructions for installation.

Figure 6-14. Example 240 mm Radiator

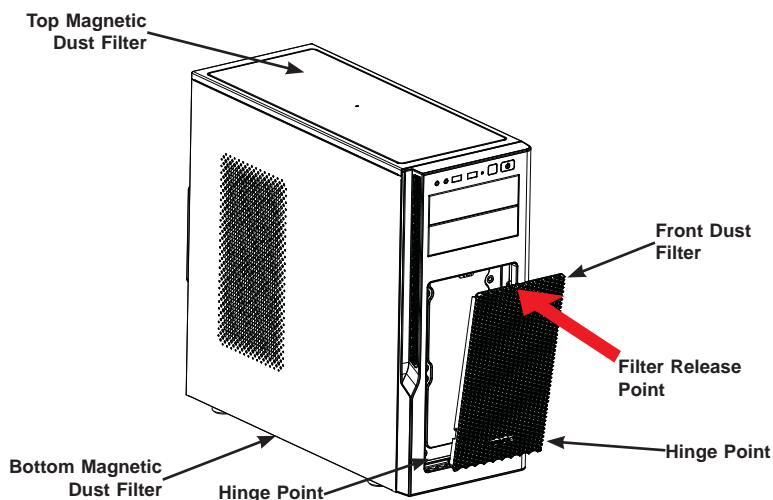
Air Flow

Make sure cables do not obstruct the cooling airflow.

Dust Filters

The chassis features a dust filter in front of the front fans, and two magnetic dust filters, one on top of the chassis and one on the bottom. They can be lifted off and cleaned to improve system air flow circulation.

Figure 6-15. Dust Filters



Cleaning the Front Dust Filter

1. Disengage the filter by pushing on the top edge center. The top pops loose.
2. Rotate the filter top downward to release it from the hinge points on the bottom.
3. Clean the filter.
4. Replace the filter by aligning it in the bottom hinge points, then pushing the top edge back into place. Push the top center until it clicks in.

The top and bottom magnetic filters can be simply lifted off for cleaning.

6-7 Installing Expansion Cards

Installing an Expansion Card

1. Power down the system as described in section 6-2 and open the left side chassis cover.
2. Remove the blank PCI shield from the rear of the chassis by removing the thumb screw.
3. Insert the expansion card into the motherboard expansion slot while aligning the expansion card bracket with the opening in the rear of the chassis.
4. Secure the expansion card bracket to the rear of the chassis with the thumb screw.
5. Replace the chassis side cover and power up the system.

6-8 Power Supply

The 5039AD-T system comes with a 750 Watt power supply. Mount it on the rear floor of the chassis. The power supply fan may be on top (recommended) or under the power supply.

Notes

Chapter 7

BIOS

7-1 Introduction

This chapter describes the AMI BIOS Setup Utility for the C7Z170-SQ. The ROM BIOS is stored in a Flash EEPROM and can be easily updated. This chapter describes the basic navigation of the AMI BIOS Setup Utility setup screens.

Note: For AMI BIOS Recovery, please refer to the UEFI BIOS Recovery Instructions in Appendix C.

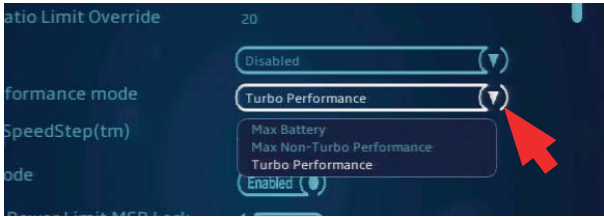
Starting BIOS GUI Setup Utility

To enter the AMI BIOS GUI Setup Utility screens, press the <Delete> key while the system is booting up.

Note: In most cases, the <Delete> key is used to invoke the AMI BIOS setup screen.



Each BIOS menu option is described in this manual. The Main BIOS Setup screen has two main areas. The left area is the Main Navigation, and the main area is for the Setup Section. Icons that do not respond when the mouse pointer is hovering on top are not configurable.



The AMI BIOS GUI Setup Utility uses a mouse pointer navigation system similar to standard graphical user interfaces. Hover and click an icon to select a section, click a down arrow to select from an options list.



Except for the Home screen you may press the <F1> on any screen under the Setup Section to see a list of Hot Keys that are available.

The keyboard's Escape key <ESC> cancels the current screen and will you back to the previous screen.

How To Change the Configuration Data

The configuration data that determines the system parameters may be changed by entering the AMI BIOS GUI Setup utility. This Setup utility can be accessed by pressing at the appropriate time during system boot.

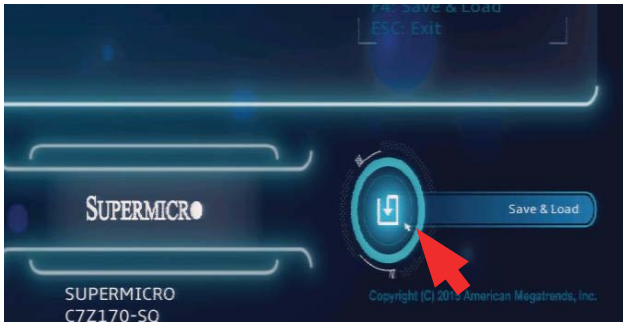
Note: For the purposes of this manual, options that are printed in **Bold** are default settings.

How to Start the Setup Utility

Normally, the only visible Power-On Self-Test (POST) routine is the memory test. As the memory is being tested, press the <Delete> key to enter the main menu of the AMI BIOS GUI Setup Utility. From the Setup Home screen, you can access the other Setup Sections.

7-2 Saving and Loading

Save and Load



The Save and Load icon brings up a pop-up menu that enables the user to choose from different saving options at the end of the session:



Restore Defaults

To set this feature, select Restore Defaults from the Save & Load menu and click <OK>. These are factory settings designed for maximum system stability.

Save All Settings Only

When you have completed the system configuration changes, select this option to save all changes made. This will not reset (reboot) the system and will not exit.

Save Changes and Exit

Select this option to save the current settings and exit Setup.

Save Changes and Reset

Select this option to save the current settings, exit Setup and reboot.

Discard Changes

Select this option discard any changes and return to Setup.

Exit without Save

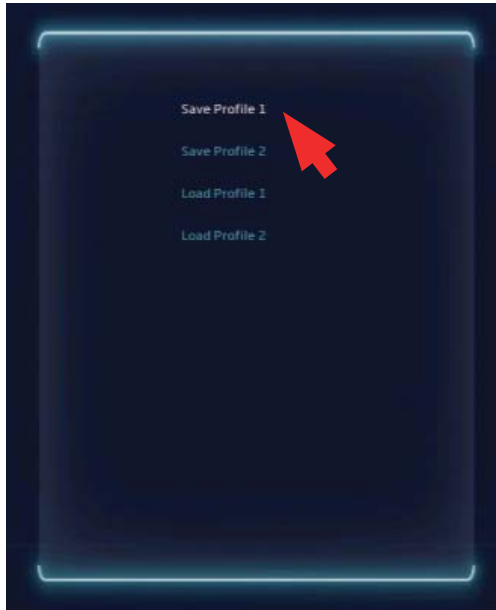
Select this option to exit Setup without making any permanent changes to the system configuration.

Discard Changes and Reset

Select this option to discard all changes to setup and reboot.

Profiles

The Profiles icon brings up a pop-up menu that enables the user to choose from two saving and loading locations. These locations can be used to store new, or retrieve previously saved overclocking profiles:

**Save Profile 1 / Save Profile 2**

Select this option to save the current overclocking profile into either Profile 1 or Profile 2 location. Click "OK" when prompted, click "Cancel" to go back and not save.

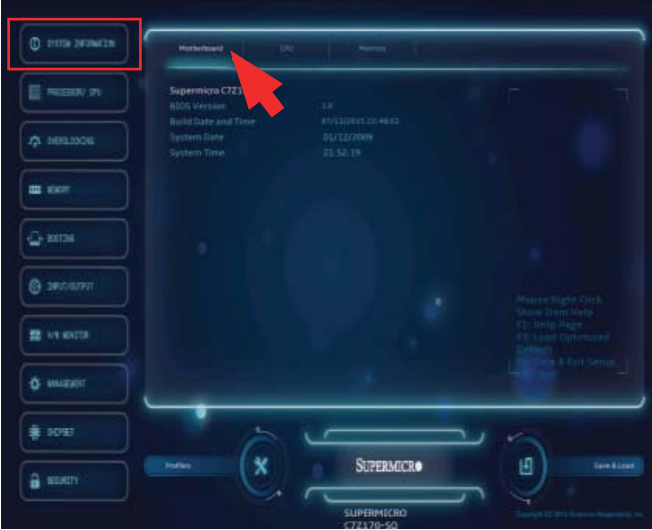
Load Profile 1 / Load Profile 2

Select this option to load a previously saved overclocking profile from either Profile 1 or Profile 2 location. Click "OK" when prompted, click "Cancel" to go back and not load.

7-3 System Information

The System Information Screen displays the motherboard's configuration.

Motherboard



The following information are displayed in this section:

- **Motherboard Model Name** - C7Z170-SQ.
- **BIOS Version** - this item displays the BIOS version number.
- **Build Date and Time** - displays the BIOS build date and Time.

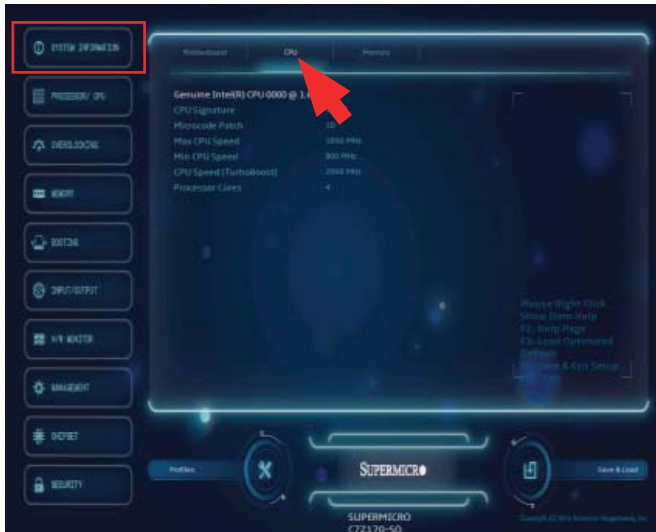
System Date

Click on the date to open the setup fields. This item sets and displays the system date. Click the up and down arrows to adjust the date.

System Time

Click on the time to open the setup fields. This item sets and displays the system time. Click the up and down arrows to adjust the system time.

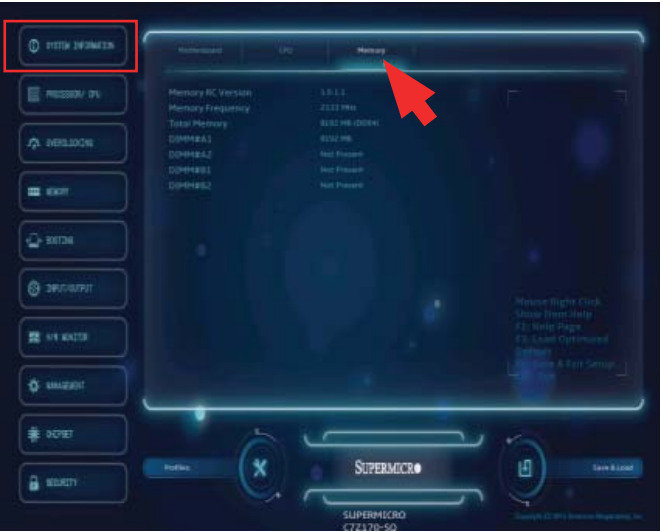
CPU



The following information are be displayed in this section:

- Type and Speed of CPU - indicates the brand, model name, model number of the CPU and it's rated clock speed.
- **CPU Signature** - displays the unique signature embedded in the CPU.
- **Microcode Patch** - displays the CPU's microcode patch version.
- **Max CPU Speed** - this item shows the maximum CPU speed.
- **Min CPU Speed** - this item shows the minimum CPU speed.
- **CPU Speed** - this item shows the current CPU speed.
- **Processor Cores** - this item shows the detected number of processor cores..

Memory



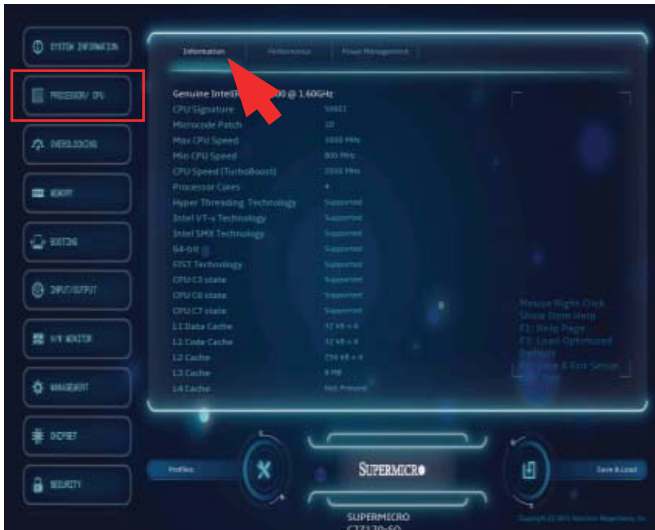
The following information are be displayed in this section:

- **Memory Frequency** - displays the system memory's detected speed.
- **Total Memory** - shows the total detected system memory.
- **DIMM#0-DIMM#3** - displays the memory size detected on each memory slot.

7-4 Processor (CPU)

Set all options for the processor in this section.

Information

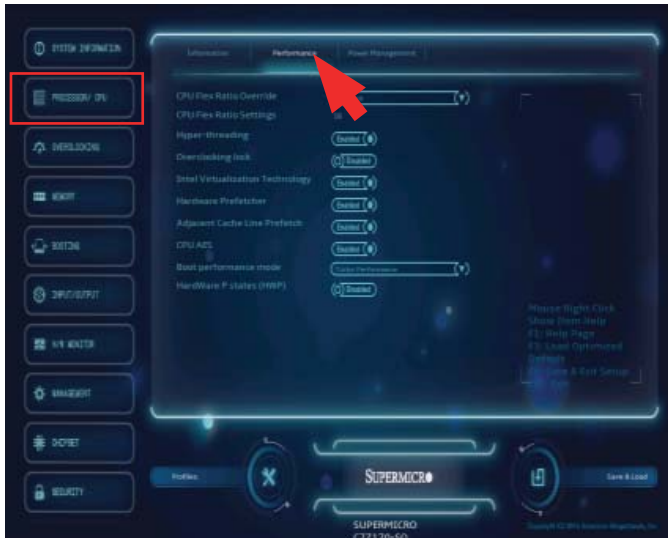


The following CPU information will be displayed:

- **CPU Signature** - displays the unique signature embedded in CPU.
- **Microcode Patch** - displays the CPU's microcode patch version.
- **Max CPU Speed** - this item shows the maximum CPU speed.
- **Min CPU Speed** - this item shows the minimum CPU speed.
- **CPU Speed** - displays the CPU's rated speed.
- **Processor Cores** - displays the number of cores the CPU has.
- **Intel HT(Hyper-Threading) Technology** - indicates if Intel HT is supported.
- **Intel VT-x Technology** - indicates if Intel VT-x is supported.
- **Intel SMX Technology** - indicates if Intel SMX is supported.
- **64-bit** - indicates if 64-bit is supported.
- **EIST Technology** - displays whether EIST is supported or not.
- **CPU C3 State** - indicates if ACPI C3 state is supported.
- **CPU C6 State** - shows whether ACPI C6 state is supported or not.
- **CPU C7 State** - indicates if ACPI C7 is supported.

- **L1 Data Cache** - indicates if Level 1 cache is supported.
- **L1 Code Cache** - displays if Level 1 code cache is supported.
- **L2 Cache** - indicates if Level 2 cache is supported.
- **L3 Cache** - displays whether Level 3 cache is supported or not.
- **L4 Cache** - - indicates if Level 4 cache is supported.

Performance



CPU Flex Ratio Override

Select Enabled to activate CPU Flex Ratio programming. The options are Enabled and **Disabled**.

CPU Flex Ratio Settings

When CPU Flex Ratio is enabled, this sets the value for the CPU Flex Ratio. The default is **16**. Press "+" or "-" on your keyboard to change the value.

Hyper-threading

Select Enabled to support Intel Hyper-threading Technology to enhance CPU performance. The options are **Enabled** and Disabled.

Overclocking Lock

Select Enabled to prevent the CPU overclocking. The options are Enabled and **Disabled**.

Intel® Virtualization Technology

(Available when supported by the CPU)

Select Enabled to use the Intel Virtualization Technology to allow one platform to run multiple operating systems and applications in independent partitions, creating multiple "virtual" systems in one physical computer. The options are **Enabled** and Disabled.

Hardware Prefetcher

(Available when supported by the CPU)

If set to Enabled, the hardware prefetcher will prefetch streams of data and instructions from the main memory to the L2 cache to improve CPU performance. The options are Disabled and **Enabled**.

Adjacent Cache Line Prefetch

(Available when supported by the CPU)

Select Enabled for the CPU to prefetch both cache lines for 128 bytes as comprised. Select Disabled for the CPU to prefetch both cache lines for 64 bytes. The options are Disabled and **Enabled**.

Note: If there is any change to this setting, you will need to power off and reboot the system for the change to take effect. Please refer to Intel's web site for detailed information.

CPU AES

Select Enable for Intel CPU Advanced Encryption Standard (AES) Instructions support to enhance data integrity. The options are **Enabled** and Disabled.

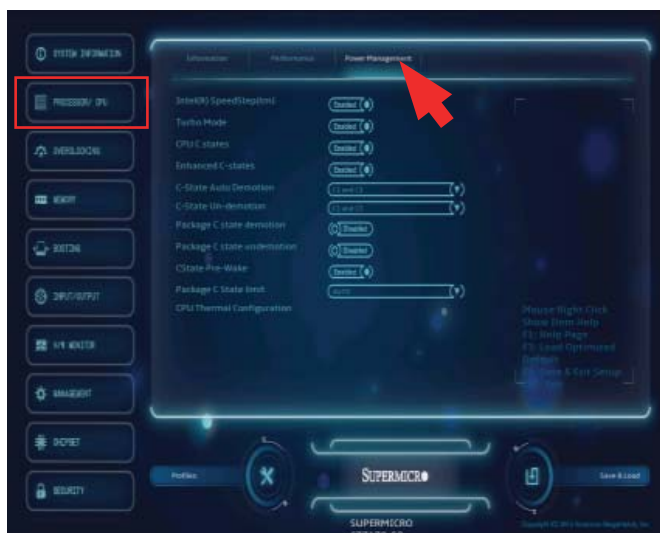
Boot Performance Mode

This option enables the selection of the default CPU performance during system boot. The options are **Max Non-Turbo Performance**, Max Battery and Turbo Performance.

Hardware P State

This option enables the Hardware P State support. The options are **Disabled** and Enabled.

Power Management



Intel(R) SpeedStep(tm)

Intel SpeedStep Technology allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. **Please refer to Intel's web site for detailed information.** The options are Disabled and **Enabled**.

Turbo Mode

This feature allows processor cores to run faster than the frequency recommended by the manufacturer. The options are Disabled and **Enabled**. If this feature is set to Enabled, the following items will display:

CPU C States

C-States architecture, a processor power management platform developed by Intel, can further reduce power consumption from the basic C1 (Halt State) state that blocks clock cycles to the CPU. Select Enabled for CPU C States support. The options are **Enabled** and Disabled. If this feature is set to Enabled, the following items will display:

Enhanced C State

(Available when "CPU C States" is set to Enabled)

Select Enabled to enable Enhanced C1 Power State to boost system performance. The options are **Enabled** and Disabled.

C State Auto Demotion

When this item is enabled, the CPU will conditionally demote C State based on un-cored auto-demote information. The options are Disabled, C1, C3 and **C1 and C3**.

C1

When this item is selected, the CPU will conditionally demote C3, C6 or C7 requests to C1 State based on un-cored auto-demote information.

C3

When this item is selected, the CPU will conditionally demote C6 or C7 requests to C3 State based on un-cored auto-demote information.

C State Un-Demotion

When this item is enabled, the CPU will conditionally undemote from demoted C3 or C1. The options are Disabled, C1, C3 and **C1 and C3**.

Package C-State Demotion

This item enables the Package C-State demotion. The options are **Disabled** and Enabled.

Package C-State Un-Demotion

When set, the CPU will conditionally undemote from demoted Packaged Package C-State Un-Demotion

C-State Pre-Wake

When set, this option enables or disables the C-State pre wake. The options are **Enabled** and Disabled.

Package C-State Limit

Select Auto for the AMI BIOS to automatically set the limit on the C-State package register. The options are C0, C2, C3, C6, C7, C7s and **Auto**.

CPU Thermal Configuration

This section configures the motherboard's onboard Thermal Management.

CPU DTS

When this item is enabled, the motherboard's ACPI Thermal Management uses the DTS SMM mechanism to obtain CPU temperature values. When disabled, the ACPI Thermal Management uses the EC reported temperature values. The options are Enabled and **Disabled**.

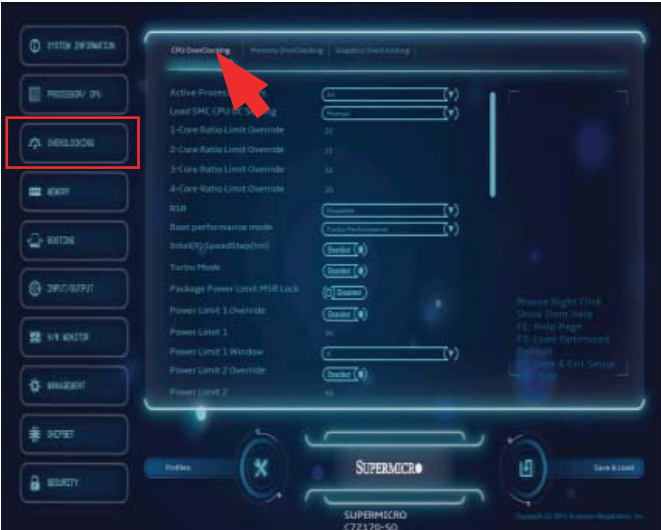
ACPI 3.0 T-States

Use this feature to enable or disable the ACPI 3.0 T-States. The options are Enabled and **Disabled**.

7-5 Overclocking

Set all options for the Overclocking in this section.

CPU Overclocking



Active Processor Cores

Use this feature to select the number of active processor cores. The options are **All**, 1, 2, 3 and 4 (These options depend on how many cores are supported by the CPU.)

Load SMC CPU OC Setting

This item has optimized pre-configured overclock settings. Select one to activate. The options are **Manual**, 3.5GHz~5.0GHz (in 100MHz increments).

1-Core Ratio Limit Override

This increases (multiplies) 1 clock speed in the CPU core in relation to the bus speed when one CPU core is active. Press "+" or "-" on your keyboard to change the value. Enter 0 to use the manufacturer's default setting.

2-Core Ratio Limit Override

This increases (multiplies) 2 clock speeds in the CPU core in relation to the bus speed when two CPU cores are active. Press "+" or "-" on your keyboard to change the value. Enter 0 to use the manufacturer's default setting.

3-Core Ratio Limit Override

This increases (multiplies) 3 clock speeds in the CPU core in relation to the bus speed when three CPU cores are active. Press "+" or "-" on your keyboard to change the value. Enter 0 to use the manufacturer's default setting.

4-Core Ratio Limit Override

This increases (multiplies) 4 clock speeds in the CPU core in relation to the bus speed when four CPU cores are active. Press "+" or "-" on your keyboard to change the value. Enter 0 to use the manufacturer's default setting.

RSR

This item enables or disables the RSR feature. The options are **Disabled** and **Enabled**.

Boot Performance Mode

This option enables the selection of the default CPU performance during system boot. The options are Max Non-Turbo Performance, Max Battery and **Turbo Performance**.

Intel(R) SpeedStep(tm) Technology

Enhanced Intel SpeedStep Technology (EIST) allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. **Please refer to Intel's web site for detailed information.** The options are **Disabled** and **Enabled**.

Turbo Mode

This feature allows processor cores to run faster than the frequency recommended by the manufacturer. The options are **Disabled** and **Enabled**. If this feature is set to Enabled, the following items will display:

Package Power Limit MSR Lock

This feature enables or disables the locking of Package Power Limit settings. When enabled Package Power Limit MSR will be locked and a reset will be required to unlock the register. The options are **Disabled** and **Enabled**.

Power Limit 1 Override

This feature disables or enables the Power Limit 1 Override. If this option is disabled, the BIOS will program the default values for Power Limit and Power Limit 1 Time Window. The options are Disabled and **Enabled**.

Power Limit 1

This feature configures Package Power Limit 1, in milliwatts. When the limit is exceeded, the CPU ratio is lowered after a period of time (see item below). A lower limit can save power and protect the CPU, while a higher limit improves performance. This value must be between Min Power Limit TDP limit. If value is '0' the BIOS will program the TDP value. Use the number keys on your keyboard to enter the value. The default setting is dependent on the CPU.

Power Limit Window

This item determines how long the time window over which the TDP value is maintained. Use the number keys on your keyboard to enter the value. The default setting is **8**. This value may vary between 0~128.

Power Limit 2 Override

This feature disables or enables the Power Limit 2 Override. If this option is disabled, the BIOS will program the default values for Power Limit and Power Limit 2 Time Window. The options are Disabled and **Enabled**.

Power Limit 2

This feature configures Package Power Limit 2, in milliwatts. When the limit is exceeded, the CPU ratio is lowered after a period of time (see item below). A lower limit can save power and protect the CPU, while a higher limit improves performance. This value must be between Min Power Limit TDP limit. If value is '0' the BIOS will program the TDP value. Use the number keys on your keyboard to enter the value. The default setting is dependent on the CPU.

Platform PL1 Enable

This option disables or enables the Platform Power Limit 1 programming. If this option is enabled, it activates the PL1 value to be used by the processor to limit the average power of the given time window. The options are Disabled and **Enabled**. When enabled, the following will appear:

Platform PL1 Power

This feature configures Platform PL1 Power. Press "+" or "-" on your keyboard to change the value. Enter 0 to use the manufacturer's default setting.

Platform PL1 Window

This item determines how long the time window over which the TDP value is maintained. Use the number keys on your keyboard to enter the value. The default setting is **0**. This value may vary between 0~128.

Platform PL2 Enable

This option disables or enables the Platform Power Limit 2 programming. If this option is enabled, it activates the PL1 value to be used by the processor to limit the average power of the given time window. The options are **Disabled** and Enabled. When enabled, the following will appear:

Platform PL2 Power

This feature configures Platform PL2 Power. Press "+" or "-" on your keyboard to change the value. Enter 0 to use the manufacturer's default setting.

Power Limit 3 Override

This feature disables or enables the Power Limit 3 Override. If this option is disabled, the BIOS will program the default values for Power Limit and Power Limit 3 Time Window. The options are **Disabled** and Enabled. If enabled, the following will appear:

Power Limit 3

This feature configures Package Power Limit 3, in milliwatts. When the limit is exceeded, the CPU ratio is lowered after a period of time (see item below). A lower limit can save power and protect the CPU, while a higher limit improves performance. This value must be between Min Power Limit TDP limit. If value is '0' the BIOS will program the TDP value. Use the number keys on your keyboard to enter the value. The default setting is dependent on the CPU.

Power Limit 3 Window

This item determines how long the time window over which the TDP value is maintained. Use the number keys on your keyboard to enter the value. The default setting is **0**. This value may vary between 0~128.

Power Limit 3 Duty Cycle

This item allows the user to determine the percentage of time the CPU should operate at the power set by the user for the item above (i.e., If Power Limit 3 Time is set at 100 secs, a 60% duty cycle means the CPU will run 60 seconds at the power limit set in Power Limit 3 every 100 seconds.). Use the number keys on your keyboard to enter the value between 1~100. Enter 0 to use the manufacturer's default setting.

Power Limit 3 Lock

This feature enables or disables the locking of Power Limit 3 settings. When enabled Power Limit 3 settings will be locked and a reset will be required to unlock the register. The options are **Disabled** and **Enabled**.

CPU Flex Ratio Override

Select **Enabled** to activate CPU Flex Ratio programming. The options are **Enabled** and **Disabled**.

CPU Flex Ratio Settings

When CPU Flex Ratio is enabled, this sets the value for the CPU Flex Ratio. The default is **16**. Press "+" or "-" on your keyboard to change the value.

CPU Max OC Ratio

This option sets the maximum overclocking ratio for the CPU core. The allowable range is from 0~80. Press "+" or "-" on your keyboard to change the value.

CPU Input Voltage

This option sets the VCC IN for the CPU core. Press "+" or "-" on your keyboard to change the value.

System Agent Voltage

This option sets the System Agent Voltage. Press "+" or "-" on your keyboard to change the value.

GT Voltage

This option sets the GT Voltage. Press "+" or "-" on your keyboard to change the value.

Core Voltage Mode

Use this feature to select the Core voltage mode. The options are **Override** and **Adaptive**.

Core Extra Turbo Voltage

This option specifies the extra voltage when IA Core is running in Turbo mode. Range is from 0~2000mV. Press "+" or "-" on your keyboard to change the value.

Core Voltage Offset

Use this feature to set the CPU Voltage Offset value from -500mV to +500mV. Enter **0** to use the manufacture default value. Press "+" or "-" on your keyboard to change the value.

Offset Prefix

Use this feature to set the Core Voltage Offset value as a positive (+) number or a negative (-) number. Press "+" or "-" on your keyboard to make a selection. The default setting is "+".

Ring Max OC Ratio

This option sets the maximum overclocking ratio for the RING domain. Press "+" or "-" on your keyboard to change the value.

Ring Min OC Ratio

This option sets the minimum overclocking ratio for the RING domain. Press "+" or "-" on your keyboard to change the value.

Ring Voltage Mode

Use this feature to select the Ring voltage mode. The options are Override and **Adaptive**.

Ring Voltage Offset

Use this feature to set the CPU Voltage Offset value from -1000mV to +1000mV. Enter **0** to use the manufacture default value. Press "+" or "-" on your keyboard to change the value.

Offset Prefix

Use this feature to set the Ring Offset value as a positive (+) number or a negative (-) number. Press "+" or "-" on your keyboard to make a selection. The default setting is "+".

Uncore Voltage Offset

Use this feature to set the ncore domain Voltage Offset value from -1000mV to +1000mV. Enter **0** to use the manufacture default value. Press "+" or "-" on your keyboard to change the value.

Offset Prefix

Use this feature to set the offset value as a positive (+) number or a negative (-) number. Press "+" or "-" on your keyboard to make a selection. The default setting is "+".

PMON

This option sets the PMON Slope value in 1/100 increments. For a 1.25 slope, enter 125. Press "+" or "-" on your keyboard to change the value.

PMON Offset

Use this feature to set the PMON offset value. Range is -255. Enter '0' for auto. Press "+" or "-" on your keyboard to make a selection. The default setting is "+".

PSYS PMax Current

This option sets the PSYS PMax Current in 1/8A increments. Range is from 0~8192. For a PMAX of 125A, enter 1000. Enter '0' for auto. Press "+" or "-" on your keyboard to change the value.

System Agent VR Settings

This option sets the System Agent VR Settings. Press "+" or "-" on your keyboard to change the value.

Core/IA VR Settings

This option sets the Core IA VR Settings. Press "+" or "-" on your keyboard to change the value.

Ring VR Settings

This option sets the Ring VR Settings. Press "+" or "-" on your keyboard to change the value.

Memory Voltage

This option selects the Memory Voltage. The options are **Auto**, 1.45V, 1.50V, 1.55V, 1.60V, 1.65V, 1.70V, 1.75V, 1.80V, 1.85V, and 1.95V.

Memory Timing Configuration (Expert Mode)

tCK (fs)

This option configures the clock cycle time. The default is **938000**.

tCL

This option configures the Cas Latency Range. Enter a number between 4-18. The default is **15**.

tRCD/tRP

This option selects the Ras Precharge Range and Row to Col Delay Range. Enter a number between 1-38. The default is **15**.

tRAS

This option selects the Ras Active Time. Enter a number between 1-586. The default is **36**.

tCWL

This option selects the Minimum CAS Write Latency Time. Enter a numeric value. The default is **8**.

tFAW

This option selects the Minimum Four Activate Window Delay Time. Enter a numeric value between 1-586. The default is **23**.

tREFI

This option configures the Maximum tREFI Time (Average Periodic Refresh Interval). Enter a numeric value. The default is **6240**.

tRFC

This option selects the Minimum Refresh Recovery Delay Time. Enter a number between 1-9363. The default is **278**.

tRRD

This option selects the Minimum Row Active To Row Active Delay Time. Enter a number between 1-38. The default is **4**.

tRTP

This option configures the Internal Read to Precharge Command Delay Time. Enter a number between 1-38. The default is **8**.

tWR

This option configures the Minimum Write Recovery Time. Enter a number between 1-38. The default is **16**.

tWTR

This option configures the Minimum Internal Write to Read Command Delay Time. Enter a number between 1-38. The default is **0**.

NMode

This option configures NMode. The default is **2**.

VDD (mV)

This option configures NMode. The default is **1200**. In millivolts.

DIMM Profile

This option selects the DIMM timing profile. The options are **Default DIMM Profile** and Custom Profile.

If Custom Profile is selected, the following options appear:

Memory Reference Clock

This option selects the Memory Clock ratio. The options are **133MHz**, 100MHz and Auto.

Memory Ratio

This option selects the Memory Clock Multiplier. The options are 4, 5, 6, 7, **8**, 9, 10, 11 and 12.

QCLK Odd Ratio

This option enables or disables the quadrature clock odd ratio. The options are **Disabled**, and Enabled.

DRAM CH_A/B Voltage

This option selects the DRAM channel A/B voltage. The options are 1.20V, 1.25V, 1.30V, 1.35V, 1.40V, 1.45V, 1.50V, and 1.52V.

tCL

This option configures the Cas Latency Range. Enter a number between 4-18. The default is **15**.

tRCD/tRP

This option selects the Row to Col Delay Range and Ras Precharge Range. Enter a number between 1-38. The default is **15**.

tRAS

This option selects the Ras Active Time. Enter a number between 1-586. The default is **36**.

Minimum CAS Write Latency Time (tCWL)

This option selects the Minimum CAS Write Latency Time. Enter a numeric value. The default is **14**.

tFAW

This option selects the Minimum Four Activate Window Delay Time. Enter a numeric value between 1-586. The default is **23**.

Maximum tREFI Time (tREFI)

This option configures the Maximum tREFI Time (Average Periodic Refresh Interval). Enter a numeric value. The default is **8316**.

tRFC

This option selects the Minimum Refresh Recovery Delay Time. Enter a number between 1-9363. The default is **278**.

tRRD

This option selects the Minimum Row Active To Row Active Delay Time. Enter a number between 1-38. The default is **4**.

tRTP

This option configures the Internal Read to Precharge Command Delay Time. Enter a number between 1-38. The default is **8**.

tWR

This option configures the Minimum Write Recovery Time. Enter a number between 1-38. The default is **16**.

tWTR

This option configures the Minimum Internal Write to Read Command Delay Time. Enter a number between 1-38. The default is 0.

NMode

This option configures NMode. The default is 2.

3rd Timing:**tRPab_ext**

This option configures the tRPab_ext. Enter a numeric value. The default is 0.

tRDPRE

This option configures the tRDPRE. Enter a numeric value. The default is 8.

tWRPRE

This option configures the tWRPRE. Enter a numeric value. The default is 34.

tRRD_sg

This option configures the tRRD_sg. Enter a numeric value. The default is 6.

tRRD_dg

This option configures the tRRD_dg. Enter a numeric value. The default is 4.

Derating ext

This option configures the derating_ext. Enter a numeric value. The default is 2.

ODT Read Duration

This option configures the ODT Read Duration. Enter a numeric value. The default is 0.

ODT Read Delay

This option configures the ODT Read Delay. Enter a numeric value. The default is 1.

ODT Write Duration

This option configures the ODT Write Duration. Enter a numeric value. The default is 0.

ODT Write Delay

This option configures the ODT Write Delay. Enter a numeric value. The default is **0**.

Write Early ODT

This option configures the Write Early ODT. Enter a numeric value. The default is **0**.

tAONPD

This option configures the tAONPD. The default is **10**.

ODT Always Rank0

This option configures the ODT Always Rank0. Enter a numeric value. The default is **0**.

tRDRD_sg

This option configures the between module read to read delay (tRDRD_sg). Enter a numeric value. The default is **6**.

tRDRD_dg

This option configures the between module read to read delay (tRDRD_dg). Enter a numeric value. The default is **4**.

tRDRD_dr

This option configures the between module read to read delay (tRDRD_dr). Enter a numeric value. The default is **6**.

tRDRD_dd

This option configures the between module read to read delay (tRDRD_dd). Enter a numeric value. The default is **7**.

tRDWR_sg

This option configures the between module read to write delay (tRDWR_sg). Enter a numeric value. The default is **6**.

tRDWR_dg

This option configures the between module read to write delay (tRDWR_dg). Enter a numeric value. The default is **4**.

tRDWR_dr

This option configures the between module read to write delay (tRDWR_dr). Enter a numeric value. The default is **7**.

tRDWR_dd

This option configures the between module read to write delay (tRDWR_dd). Enter a numeric value. The default is **7**.

tXP

This option configures tXP. Enter a numeric value. The default is **7**.

tXPDLL

This option configures tXPDLL. Enter a numeric value. The default is **26**.

tPRPDEN

This option configures tPRPDEN. Enter a numeric value. The default is **2**.

tRDPDEN

This option configures tRDPDEN. Enter a numeric value. The default is **20**.

tWRPDEN

This option configures tWRPDEN. Enter a numeric value. The default is **34**.

DIIBwEn[0]

This option configures DIIBwEn[0]. Enter a numeric value. The default is **0**.

DIIBwEn[1]

This option configures DIIBwEn[1]. Enter a numeric value. The default is **1**.

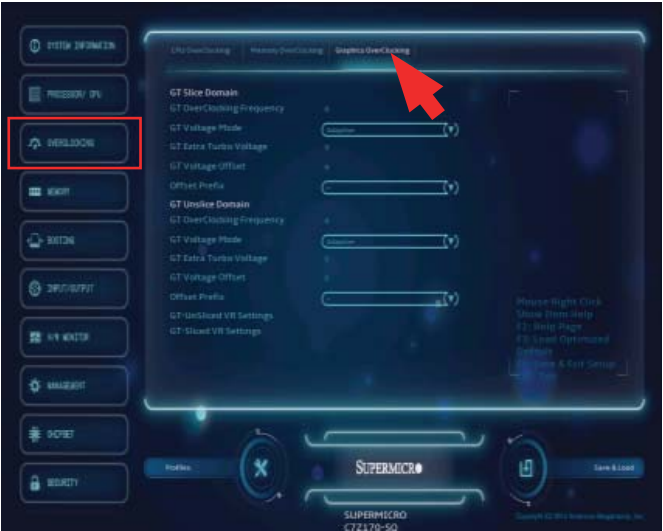
DIIBwEn[2]

This option configures DIIBwEn[2]. Enter a numeric value. The default is **2**.

DIIBwEn[3]

This option configures DIIBwEn[3]. Enter a numeric value. The default is **2**.

Graphics OverClocking



GT Slice Domain

GT OverClocking Frequency

This option selects the Overclocked RPO frequency in multiples of 50MHz. The default is **0**.

GT Voltage Mode

Use this feature to select the Overclocking GT mode. The options are Override, Offset and **Adaptive**.

GT Extra Turbo Voltage Target

(if Adaptive is selected above) Use this feature to set the extra voltage applied while GT is operating in trubo mode. Specify a value from 0mV to 2000mV. Enter **0** to use the manufacture default value.

GT Voltage Offset

(if Offset is selected above) Use this feature to set the GT Adaptive voltage Target(mV) value from 0mV to 2000mV. Enter **0** to use the manufacture default value.

Offset Prefix

Use this feature to set the Offset value as a positive (+) number or a negative (-) number. Press "+" or "-" on your keyboard to make a selection. The default setting is "+".

GT Unslice Domain**GT OverClocking Frequency**

This option selects the Overclocked RPO frequency in multiples of 50MHz. The default is **0**.

GT Voltage Mode

Use this feature to select the Overclocking GT mode. The options are Override, Offset and **Adaptive**.

GT Extra Turbo Voltage Target

(if Adaptive is selected above) Use this feature to set the extra voltage applied while GT is operating in turbo mode. Specify a value from 0mV to 2000mV. Enter **0** to use the manufacture default value.

GT Voltage Offset

(if Offset is selected above) Use this feature to set the GT Adaptive voltage Target(mV) value from 0mV to 2000mV. Enter **0** to use the manufacture default value.

Offset Prefix

Use this feature to set the Offset value as a positive (+) number or a negative (-) number. Press "+" or "-" on your keyboard to make a selection. The default setting is "+".

GT-UnSliced VR Settings

This option configures the GT UnSliced VR setting. The default is **0**.

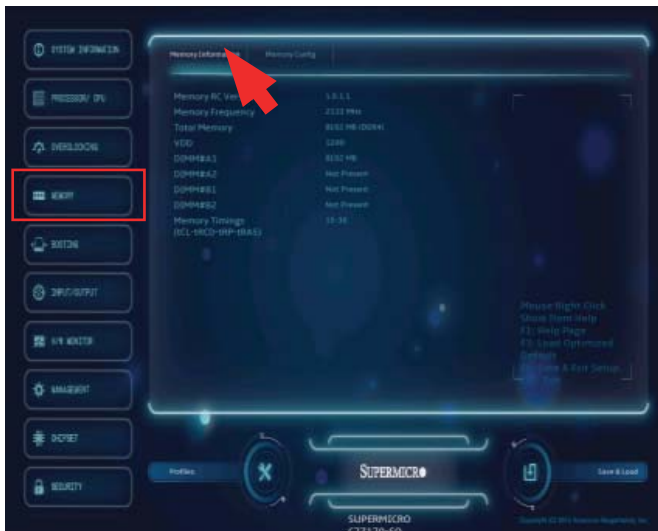
GT-Sliced VR Settings

This option configures the GT Sliced VR setting. The default is **0**.

7-6 Memory

Set all options for the Memory in this section.

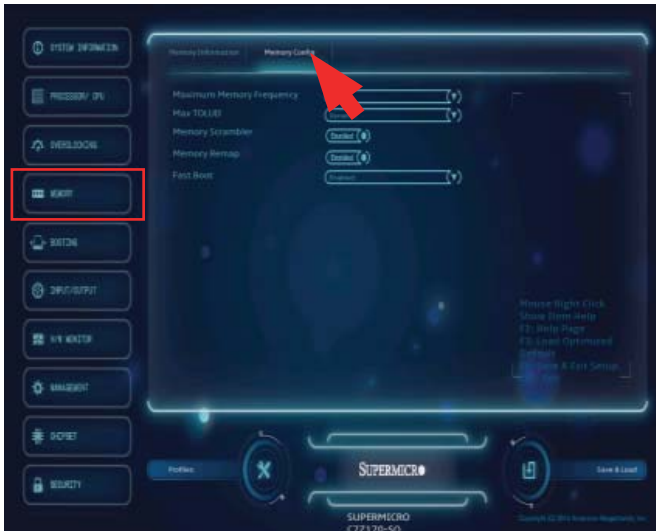
Memory Information



This item displays the following information on the memory modules installed on the motherboard.

- **Memory RC Version** - this item displays the memory controller version.
- **Memory Frequency** - this item displays the frequency of the installed memory.
- **Total Memory** - this item displays the total memory size detected.
- **VDD (Memory Voltage)** - this item displays the current memory voltage.
- **DIMM#0** - displays if a DIMM is installed on this slot, and the DIMM size.
- **DIMM#1** - displays if a DIMM is installed on this slot, and the DIMM size.
- **DIMM#2** - displays if a DIMM is installed on this slot, and the DIMM size.
- **DIMM#3** - displays if a DIMM is installed on this slot, and the DIMM size.
- **Memory Timings (tCL-tRCD-tRP-tRAS)** - displays memory timings.

Memory Configuration



This section is used to configure the memory modules installed on the motherboard.

Max TOLUD (Top of Low Usable DRAM)

This feature sets the maximum TOLUD value, which specifies the "Top of Low Usable DRAM" memory space to be used by internal graphics devices, GTT Stolen Memory, and TSEG, respectively, if these devices are enabled. The options are **Dynamic**, 1 GB, 1.25 GB, 1.5 GB, 1.75 GB, 2 GB, 2.25 GB, 2.5 GB, 2.75 GB, 3 GB, 3.25 GB and 3.5 GB.

Note: TSEG is a block of memory that is only accessible by the processor while operating in System Management Mode (SMM).

EPG DIMM Idd3N

This feature displays the memory standby current.

EPG DIMM Idd3P

This item displays the active power-down current.

Ch Hash Support

This item disables or enables Ch Hash Support. The options are **Disabled** and Enabled.

Ch Hash Mask

This item sets the BIT(s) to be included in the XOR function.

Ch Hash Interleaved Bit

This item selects the BIT to be used for channel interleaved mode. The options are BIT6, BIT7, **BIT8**, BIT9, BIT10, BIT11, BIT12, and BIT13.

Memory Scrambler

This feature enables or disables memory scrambler support for memory error correction. The settings are **Enabled** and Disabled.

Memory Remap Feature

PCI memory resources will overlap with the total physical memory if 4GB of memory or above is installed on the motherboard. When this occurs, **Enable** this function to reallocate the overlapped physical memory to a location above the total physical memory to resolve the memory overlapping situation. The options are **Enabled** and Disabled.

Lpddr Mem WL Set

This feature selects the Memory Write Latency Set, and applies only to LPDDR. The settings are Set B and **Set A**.

EV Loader

This feature enables or disables the EV loader functionality. The settings are Enabled and **Disabled**.

EV Loader Delay

This feature enables or disables the EV loader 2nd delay. The settings are **Enabled** and Disabled.

Fast Boot

This option sets fast system boot, quick POST, etc . The options are **Enabled** and Disabled.

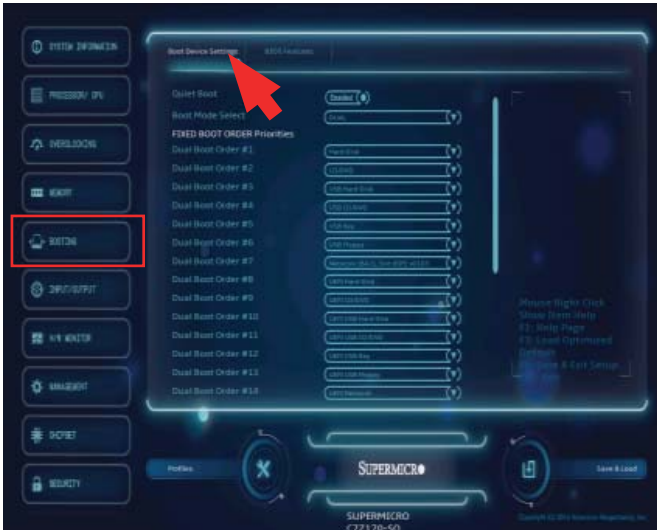
DLL Weak Lock Support

This option sets the DLL Weak Lock Support. The options are **Enabled** and Disabled.

7-7 Booting

Set all options for the Boot devices in this section.

Boot Device Settings



Quiet Boot

This option sets the state to which the system buzzer is configured when booting. The options are **Enabled** and Disabled.

New Boot Option Policy

This feature controls the placement of a newly-detected UEFI boot options. The options are **Default**, Place First and Place Last.

Boot Mode Select

This option sets the boot mode between Legacy BIOS, UEFI BIOS or Dual. The options are Dual, **Legacy** and UEFI.

Boot Order #1~#8

This option sets the order of which the system boots from the installed boot devices. The options and defaults are dependent on the boot devices detected.

Network Device BBS Priorities

Boot Option #1

This option sets the order of which the system boots from the installed firmware. The options are Disabled and any detected boot device(s).

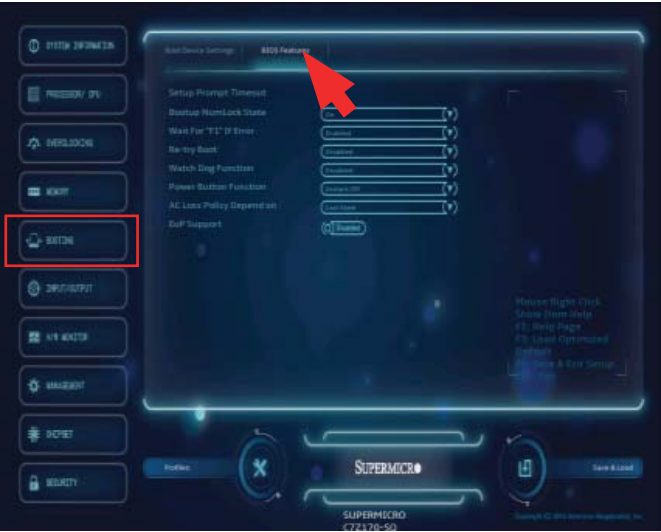
Delete Driver Option

Use this option to delete and EFI driver from the boot order.

NETWORK Drive BBS Priorities

Use this option to specify the boot device priority sequence from available network drives.

BIOS Features



Boot Configuration

Setup Prompt Timeout

This feature sets the length of time the BIOS waits for the key to be pressed by the user when entering setup. Enter a value in seconds.

Bootup Numlock State

This option sets the state to which the NumLock key is configured when booting. The options are **Enabled** and Disabled.

Wait for "F1" for Error

This option sets whether the system will wait for the user to press "F1" when an error is detected during POST. The options are **Enabled** and Disabled.

Retry Boot

Select Enabled to force the system to reboot when system fails to boot. The options are **Disabled** and Enabled.

Power Button Function

This feature controls how the system shuts down when the power button is pressed. Select 4 Seconds Override for the user to power off the system after pressing and holding the power button for 4 seconds or longer. Select Instant Off to instantly power off the system as soon as the user presses the power button. The options are **Instant Off**, and 4 Seconds Override.

AC Loss Policy

Use this feature to set the power state after a power outage. Select Power-Off for the system power to remain off after a power loss. Select Power-On for the system power to be turned on after a power loss. Select Last State to allow the system to resume its last power state before a power loss. The options are **Last State**, Power On, Stay Off.

EUP Support

EuP, or Energy Using Product is a European energy-saving specification that sets a standard on the maximum total power consumption on electrical products. Check the box to activate EUP support, the default is Unchecked (**Disabled**).

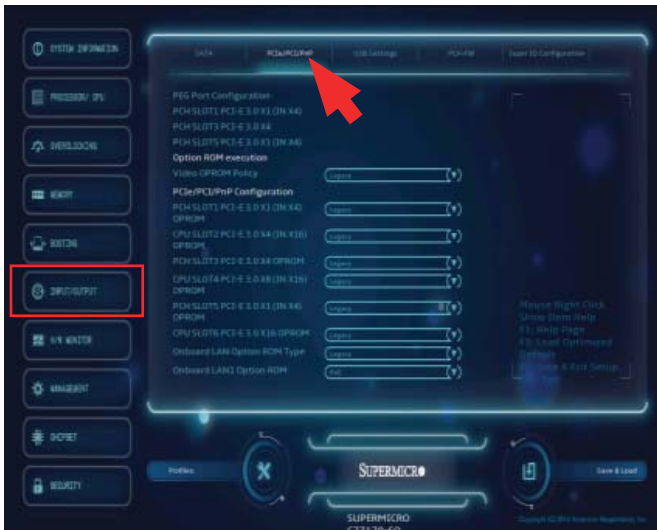
SATA Device Type

This feature configures the selected SATA port to support either a solid state drive or hard disk drive. The options are **Hard Disk Drive** and Solid State Drive.

Spin Up Device

On an edge detect from 0 to 1, set this item to allow the PCH to start a COMRESET initialization

PCIe/PCI/PnP



PEG Port Configuration

**PCH SLOT1 PCI-E 3.0 X1 (IN X4), PCH SLOT3 PCI-E 3.0 X4,
PCH SLOT5 PCI-E 3.0 X1 (IN X4)**

PCI Express Root Port 20

This option controls the PCI Express root port. The options are **Enabled** and Disabled.

ASPM Support

Set this option to configure the Active State Power Management (ASPM) of the PEG device on this PCIE slot. The options are **Auto**, Disabled, L0s, L1, and L0sL1.

L1 Substates

Set this option to configure the PCI Express L1 substate setting. The options are Disabled, L1.1, L1.2 and **L1.1 & L1.2**.

PCIE Speed

Set this option to configure the speed setting of this PCIE slot . The options are **Auto**, Gen1, Gen2 and Gen3.

Detect Non-Compliant Device

Set this option to configure the motherboard to detect any non-compliant PCIE device installed on any of the PCIE slots. The options are Enabled and **Disabled**.

PCIE LTR Lock

Set this option to configure PCIE LTR Configuration Lock. The options are Enabled and **Disabled**.

Option ROM Execution

Video

This feature controls which option ROM to execute for the Video device. The options are Do Not Launch, UEFI and **Legacy**.

PCIe/PCI/PnP Configuration

**PCH SLOT1 PCI-E 3.0 X1 (IN X4),
CPU SLOT2 PCI-E 3.0 X4 (IN X16),
PCH SLOT3 PCI-E 3.0 X4,
CPU SLOT4 PCI-E 3.0 X8 (IN X16),
PCH SLOT5 PCI-E 3.0 X1 (IN X4),
CPU SLOT6 PCI-E 3.0 X16**

Select Disabled to deactivate the selected slot, Legacy to activate the slot in legacy mode and EFI to activate the slot in EFI mode. The options are Disabled, **Legacy**, and EFI.

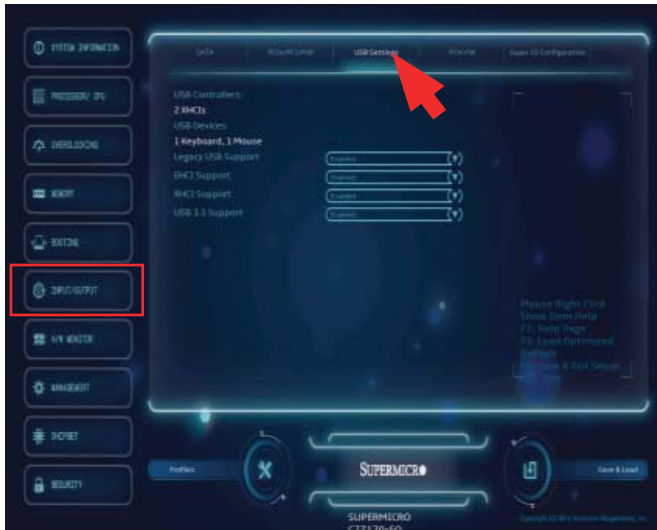
Onboard LAN Option ROM Type

Select the onboard LAN option ROM type. The options are **Legacy** and EFI.

Onboard LAN1 Option ROM

Select PXE (Preboot Execution Environment) to boot the computer using a PXE device installed in a LAN port specified. Select Disabled to prevent system boot using a device installed in a LAN port. The options are **Disabled** and PXE.

USB Settings



- **USB Controllers** - displays the detected USB controllers.
- **USB Devices** - displays the detected USB devices.

Legacy USB Support

This item activates Legacy USB Support. The options are **Enabled** and Disabled.

EHCI Support

This item activates EHCI Support. The options are **Enabled** and Disabled.

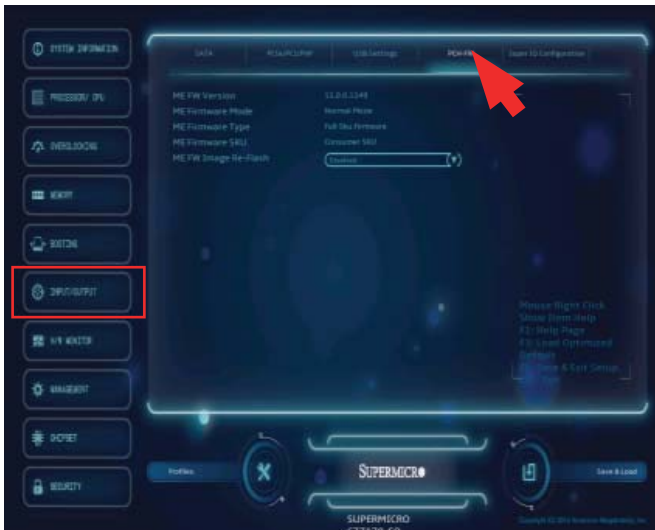
XHCI Support

This item activates XHCI Support. The options are **Enabled** and Disabled.

USB 3.1 Support

This item activates USB 3.1 Support. The options are **Enabled** and Disabled.

PCH-FW (Firmware)



The following information for the PCH Firmware.

- **ME FW Version** - displays the Management Engine version number.
- **ME Firmware Mode** - displays the Management Engine mode.
- **ME Firmware Type** - displays the Management Engine firmware type.
- **ME Firmware SKU** - displays the Management Engine SKU size.

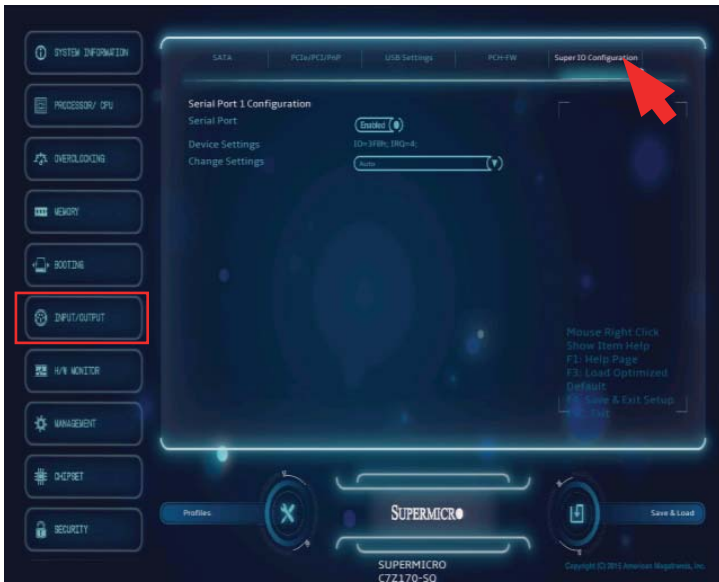
ME State

When enabled, this item will cause ME to be disabled temporarily. The options are Enabled and **Disabled**.

ME FW Image Re-Flash

This item will update the PCH Firmware from an image in a USB Flashdrive attached to a USB port. The options are **Enabled** and Disabled.

Super IO Configuration



Serial Port 1 Configuration

Serial Port

This item will Enable or Disable Serial Port 1 (COM1). Place a tick mark on the box to enable Serial Port 1. The default is **Enabled**.

Device Settings

This item displays the current IRQ setting for Serial Port 1 (COM1).

IRQ Settings

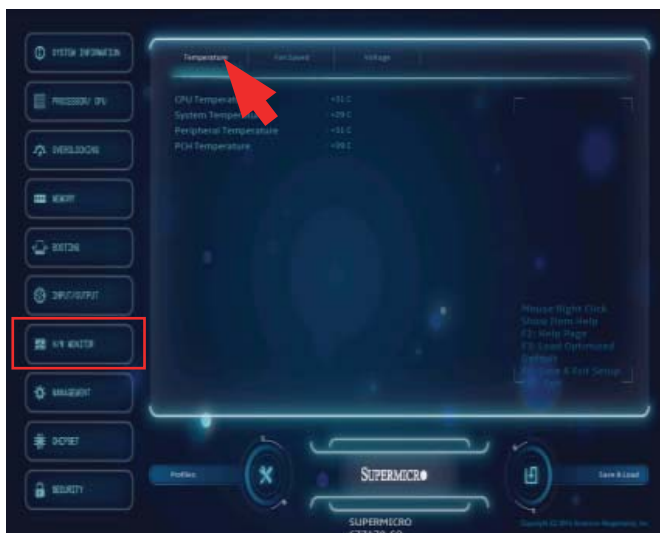
This item configures the IRQ setting for Serial Port 1 (COM1).

The options for Serial Port 1 are **Auto**, IO=3F8h; IRQ=4, IO=3F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12, IO=2F8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12), IO=3E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12 and IO=2E8h; IRQ=3, 4, 5, 6, 7, 9, 10, 11, 12.

7-9 Hardware Monitor

Hardware Monitors for various sensors on the motherboard are in this section.

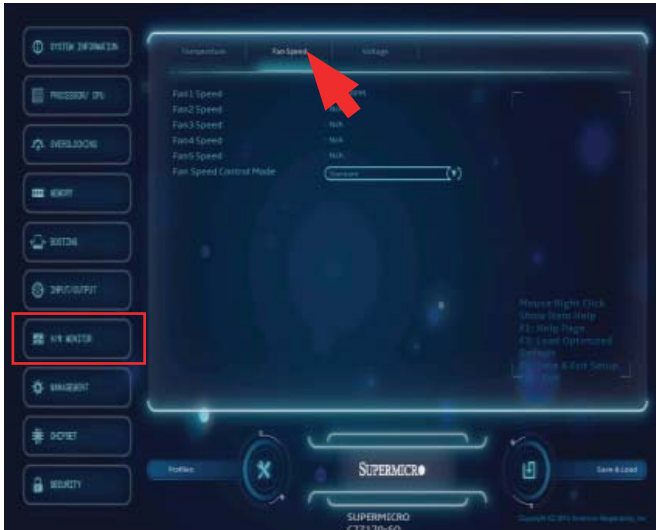
Temperature



The following items will be displayed:

- **CPU Temperature** - displays the CPU temperature detected by PECI.
- **System Temperature** - indicates the system internal temperature.
- **Peripheral Temperature** - displays the detected peripheral device temperature.
- **PCH Temperature** - indicates the detected PCH chip temperature.

Fan Speed



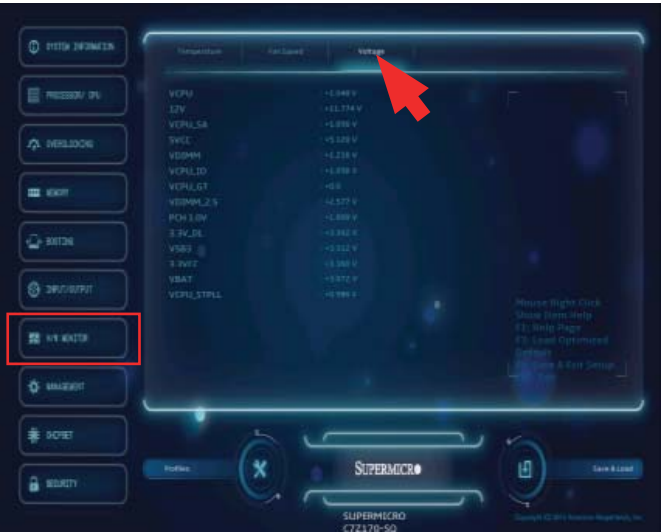
Fan Speed Control Mode

This feature allows the user to decide how the system controls the speeds of the onboard fans. The CPU temperature and the fan speed are correlative. When the CPU on-die temperature increases, the fan speed will also increase for effective system cooling. Select "Full Speed" to allow the onboard fans to run at full speed (of 100% Pulse Width Modulation Duty Cycle) for maximum cooling. This setting is recommended for special system configuration or debugging. Select "Standard" for the onboard fans to run at 50% of the Initial PWM Cycle in order to balance the needs between system cooling and power saving. This setting is recommended for regular systems with normal hardware configurations. The options are Full Speed (@100% of PWM Cycle), and **Standard** (@50% of PWM Cycle).

The following items will be displayed:

- Fan 1 Speed ~ Fan 5 Speed

Voltage



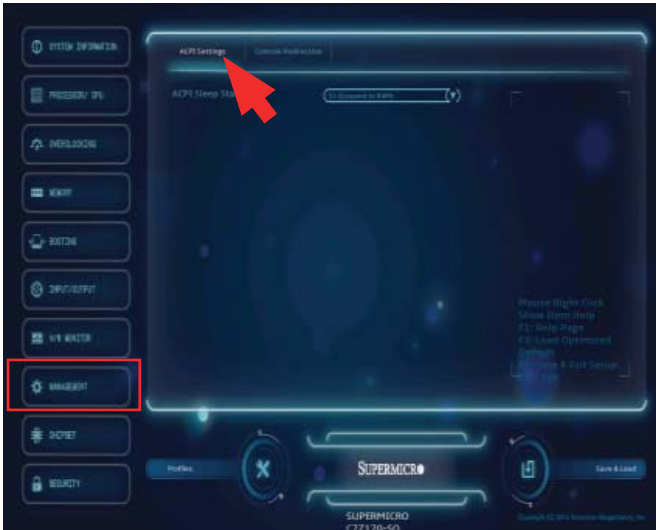
The following items will be displayed:

- VCPU
- 12V
- VCPU_SA
- 5VCC
- VDIMM
- VCPU_IO
- VCPU_GT
- VDIMM_2.5
- PCH 1.0V
- 3.3V_DL
- VSBS
- 3.3VCC
- VBAT
- VCPU_STPLL

7-10 Management

Set all options for the Overclocking in this section.

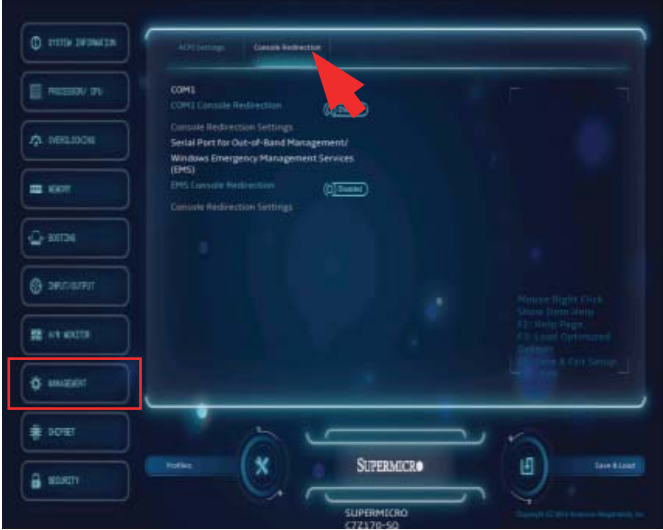
ACPI Settings



ACPI Sleep State

This feature selects the ACPI Sleep State that the system will enter into when the suspend button is activated. The options are Suspend Disabled, and **S3 (Suspend to RAM)**.

Console Redirection



COM 1

Console Redirection

Select Enabled to enable COM Port 1 Console Redirection, which will allow a client machine to be connected to a host machine at a remote site for networking. The options are **Disabled (unchecked)** and Enabled (checked).

**If the item above set to Enabled, the following items will become available for configuration:*

Console Redirection Settings

Terminal Type

This feature allows the user to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII Character set. Select VT100+ to add color and function key support. Select ANSI to use the Extended ASCII Character Set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, **VT100+**, and VT-UTF8.

Bits Per second

Use this item to set the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 38400, 57600 and **115200** (bits per second).

Data Bits

Use this feature to set the data transmission size for Console Redirection. The options are **7 (Bits)** and **8 (Bits)**.

Parity

A parity bit can be sent along with regular data bits to detect data transmission errors. Select **Even** if the parity bit is set to 0, and the number of 1's in data bits is even. Select **Odd** if the parity bit is set to 0, and the number of 1's in data bits is odd. Select **None** if you do not want to send a parity bit with your data bits in transmission. Select **Mark** to add a mark as a parity bit to be sent along with the data bits. Select **Space** to add a Space as a parity bit to be sent with your data bits. The options are **None**, **Even**, **Odd**, **Mark** and **Space**.

Stop Bits

A stop bit indicates the end of a serial data packet. Select **1 Stop Bit** for standard serial data communication. Select **2 Stop Bits** if slower devices are used. The options are **1** and **2**.

Flow Control

Use this item to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop sending data when the receiving buffer is full. Send a "Start" signal to start sending data when the receiving buffer is empty. The options are **None** and **Hardware RTS/CTS**.

VT-UTF8 Combo Key Support

Select **Enabled** to enable VT-UTF8 Combination Key support for ANSI/VT100 terminals. The options are **Enabled (checked)** and **Disabled (unchecked)**.

Recorder Mode

Select **Enabled** to capture the data displayed on a terminal and send it as text messages to a remote system. The options are **Enabled (checked)** and **Disabled (unchecked)**.

Resolution 100x31

Select **Enabled** for extended-terminal resolution support. The options are **Enabled (checked)** and **Disabled (unchecked)**.

Legacy OS Redirection Resolution

Use this item to select the number of rows and columns used in Console Redirection for legacy OS support. The options are **80x24** and **80x25**.

Putty KeyPad

This feature selects Function Keys and KeyPad settings for Putty, which is a terminal emulator designed for the Windows OS. The options are **VT100**, LINUX, XTERMR6, SCO, ESCN, and VT400.

Redirection After BIOS Post

Use this feature to enable or disable legacy Console Redirection after BIOS POST. When the option-Bootloader is selected, legacy Console Redirection is disabled before booting the OS. When the option- Always Enable is selected, legacy Console Redirection remains enabled upon OS bootup. The options are **Always Enable** and Bootloader.

Serial Port for Out-of-Band Management/Windows Emergency Management Services (EMS)

The submenu allows the user to configure Console Redirection settings to support Out-of-Band Serial Port management.

Enable Console Redirection

Select Enabled to use a COM port selected by the user for EMS Console Redirection. The options are Enabled (checked) and **Disabled (unchecked)**.

**If the item above set to Enabled, the following items will become available for user's configuration:*

Console Redirection Settings

Out-of-Band Management Port

The feature selects a serial port in a client system to be used by the Windows Emergency Management Services (EMS) to communicate with a remote host system. The options are **COM1 (Console Redirection)** and SOL (Console Redirection).

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII character set. Select VT100+ to add color and function key support. Select ANSI to use the extended ASCII character set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are ANSI, VT100, VT100+, and **VT-UTF8**.

Bits Per Second

This item sets the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in both host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 57600, and **115200** (bits per second).

Flow Control

Use this item to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop data-sending when the receiving buffer is full. Send a "Start" signal to start data-sending when the receiving buffer is empty. The options are **None**, Hardware RTS/CTS, and Software Xon/Xoff.

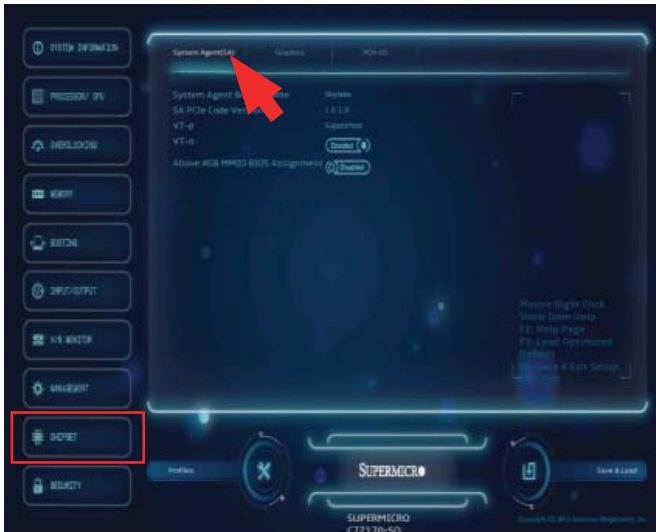
The setting for each these features is displayed:

Data Bits, Parity, Stop Bits

7-11 Chipset

Set all options for the Chipset in this section.

System Agent



The following will be displayed:

- **System Agent Bridge Name** - this displays the System Agent bridge name.
- **System Agent RC Version** - indicates the System Agent RC version.
- **VT-d Capability** - this item indicates whether VT-d is supported.

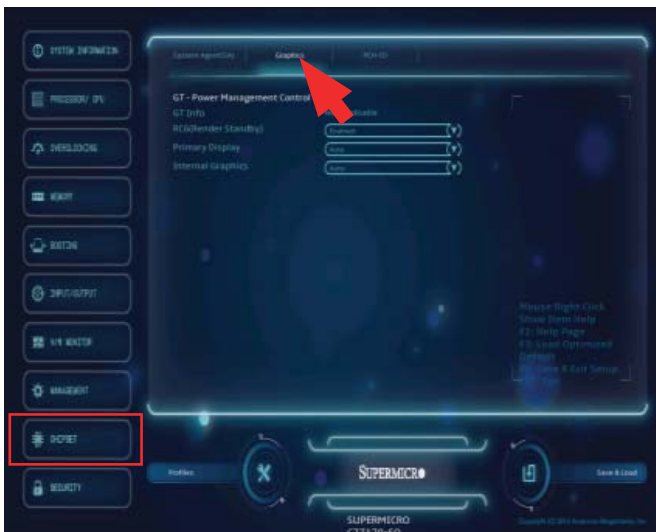
VT-d

Select Enabled to enable Intel Virtualization Technology support for Direct I/O VT-d by reporting the I/O device assignments to the Virtual Machine Manager (VMM) through the DMAR ACPI Tables. This feature offers fully-protected I/O resource-sharing across the Intel platforms, providing the user with greater reliability, security and availability in networking and data-sharing. The settings are **Enabled** and Disabled.

Above 4GB MMIO BIOS Assignment

Select Enable for remapping of BIOS above 4GB. The options are Enabled and **Disabled**.

Graphics



The following will be displayed:

- **GT Info** - displays the Graphics chip information.

RC6 (Render Standby)

Use this feature enable Render Standby support. The options are **Enabled**, and Disabled.

Primary Display

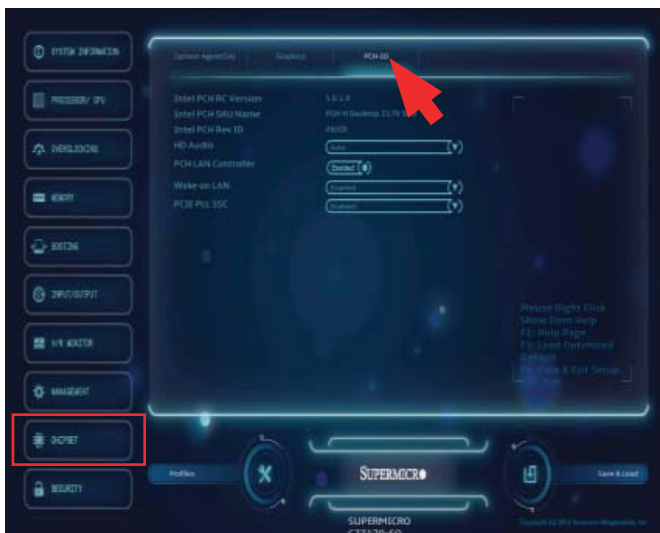
Use this feature to select the graphics device to be used as the primary display. Select from IGFX/PEG/PCI or select SG for switchable GFX. The options are **Auto**, IGFX, and PCIE slots:

PCH SLOT1 PCI-E 3.0 X1 (IN X4),
 CPU SLOT2 PCI-E 3.0 X4 (IN X16),
 PCH SLOT3 PCI-E 3.0 X4,
 CPU SLOT4 PCI-E 3.0 X8 (IN X16),
 PCH SLOT5 PCI-E 3.0 X1 (IN X4),
 CPU SLOT6 PCI-E 3.0 X16

Internal Graphics

This item keeps the IGD (Internal Graphics Device) enabled, based on setup options. The options are **Auto**, Enabled and Disabled.

PCH-IO



The following will be displayed:

- **Intel PCH RC Version** - displays the PCH chip release version.
- **Intel PCH SKU Name** - indicates the PCH chip part number.
- **Intel PCH Rev ID** - displays the PCH chip revision ID.

HD Audio

This item controls the HD Audio device. The settings are **Auto**, Enabled and Disabled.

PCH LAN Controller

This item controls the PCH LAN Controller. The settings are **Enabled** and Disabled.

Wake on LAN

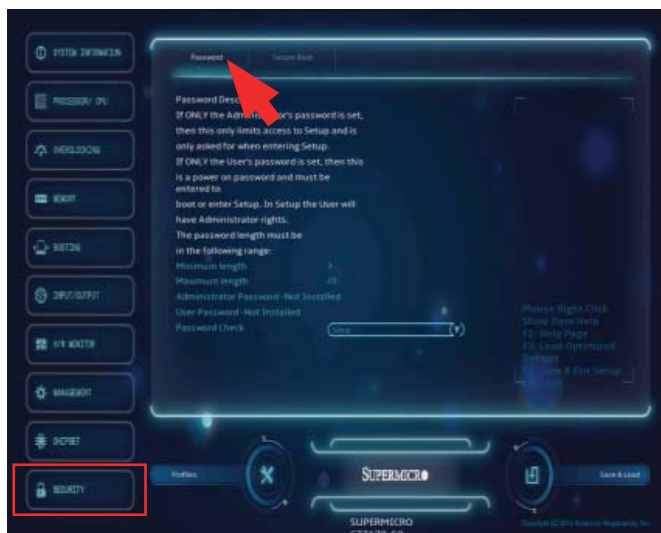
Select Enabled to enable the capability to 'wake-up' the system through the Ethernet port. The settings are **Enabled** and Disabled.

PCIE PLL SSC

This item enables the PCIE PLL SSC function. The settings are Enabled and Disabled.

7-12 Security

Password



This menu allows the user to configure the following security settings for the system.

- If ONLY the Administrator password is defined - this controls access to the BIOS setup ONLY.
- If the User's password is defined ONLY - this password will need to be entered upon each system boot, and will also have Administrator rights in the setup.
- Passwords must be at least 3 and up to 20 characters long.

Administrator Password

Use this feature to set the Administrator Password which is required to enter the BIOS setup utility. The length of the password should be from 3 characters to 20 characters long.

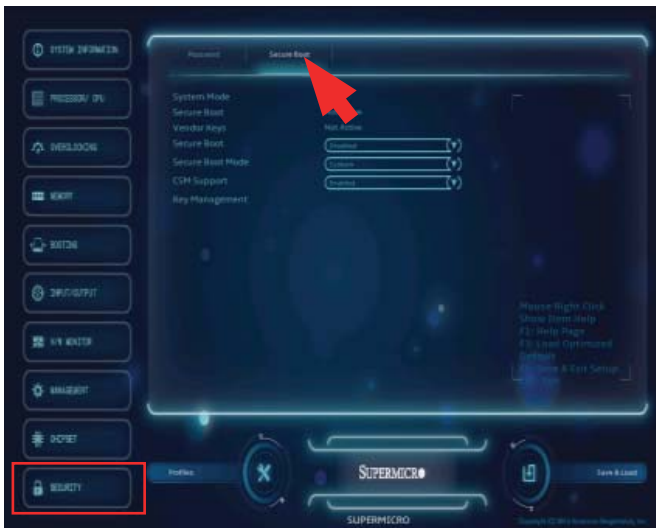
User Password

Use this feature to set the User Password, which is required everytime the system boots. The length of the password should be from 3 characters to 20 characters long.

Password Check

Use this feature to select whether the motherboard prompts for a password always, or only when entering setup. The options are **Setup** and Always.

Secure Boot Menu



The following items will be displayed:

- **System Mode** - indicates the current system mode.
- **Secure Boot** - this item indicates if Secure Boot is activated or not.

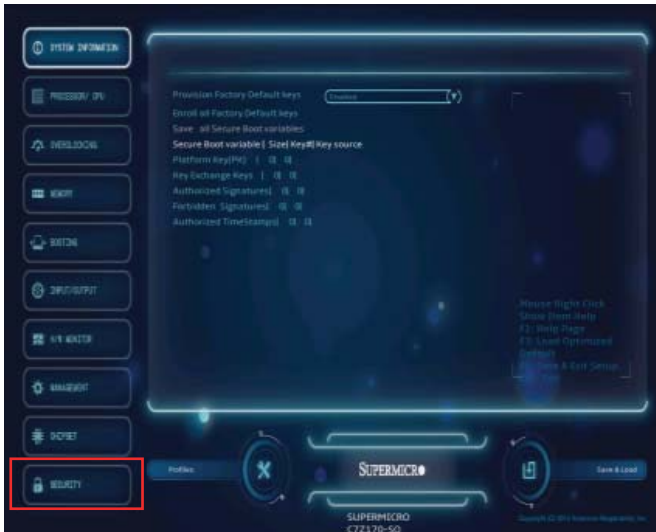
Secure Boot

Select Enabled for Secure Boot flow control. This feature is available when the platform key (PK) is pre-registered, the platform operates in the user mode, and CSM is disabled in the Setup utility. The options are **Disabled** and Enabled.

Secure Boot Mode

This feature allows selection of the Secure Boot Mode between Standard and Custom. Selecting Custom enables users to change the Image Execution Policy and manage Secure Boot Keys. The options are **Custom** and Standard.

Key Management



(if Secure Boot Mode is set to 'Custom')

Key Management allows experienced users to modify Secure Boot Variables.

Provision Factory Default Keys

Select Enabled to install factory default Secure boot keys. The options are **Disabled** and Enabled.

Enroll Factory Default Keys

This option forces system into user mode, installing all factory default keys (PK, KEK, db, dbt, dbx). Changes will take effect after reboot. Select "Yes" when prompted, otherwise click "No".

Platform Key

This item displays the current Platform Key status. Clicking this option will bring up the Key Management window.



Set New Key

This item uploads and installs a secure Platform Key. You may insert a factory default key or load from a file. The file formats accepted are:

1. Public Key Certificate
 - a. EFI Signature List
 - b. EFI CERT X509 (DER Encoded)
 - c. EFI CERT RSA2048 (bin)
 - d. EFI SERT SHA256 (bin)
2. EFI Time Based Authenticated Variable

When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Delete Key

This item deletes a previously installed Platform Key.

Key Exchange Key

This item displays the current Key Exchange Key status. Clicking this option will bring up the Key Management window.



Set New Key

This item uploads and installs a Key Exchange Key. You may insert a factory default key or load from a file. When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Append Key

This item uploads and adds a Key Exchange Key into the Key Management. You may insert a factory default key or load from a file. When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Delete Key

This item deletes a previously installed Key Exchange Key.

Authorized Signatures

This item displays the current Authorized Signatures status. Clicking this option will bring up the Key Management window.

Set New Key

This item uploads and installs an Authorized Signature . You may insert a factory default key or load from a file. The file formats accepted are:

1. Public Key Certificate
 - a. EFI Signature List
 - b. EFI CERT X509 (DER Encoded)
 - c. EFI CERT RSA2048 (bin)
 - d. EFI SERT SHA256 (bin)
2. EFI Time Based Authenticated Variable

When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Append Key

This item uploads and adds an Authorized Signature into the Key Management. You may insert a factory default key or load from a file. When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Delete Key

This item deletes a previously installed Authorized Signature.

Forbidden Signatures

This item displays the current Forbidden Signatures status. Clicking this option will bring up the Key Management window.

Delete Key

This item deletes a previously installed Forbidden Signature.

Set New Key

This item uploads and installs a Forbidden Signature. You may insert a factory default key or load from a file. The file formats accepted are:

1. Public Key Certificate
 - a. EFI Signature List
 - b. EFI CERT X509 (DER Encoded)
 - c. EFI CERT RSA2048 (bin)
 - d. EFI SERT SHA256 (bin)
2. EFI Time Based Authenticated Variable

When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Append Key

This item uploads and adds an Forbidden Signature into the Key Management. You may insert a factory default key or load from a file. When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Authorized TimeStamps

This item displays the current Authorized TimeStamps status. Clicking this option will bring up the Key Management window.

Set New Key

This item uploads and installs a Forbidden Signature . You may insert a factory default key or load from a file. The file formats accepted are:

1. Public Key Certificate
 - a. EFI Signature List
 - b. EFI CERT X509 (DER Encoded)
 - c. EFI CERT RSA2048 (bin)
 - d. EFI SERT SHA256 (bin)
2. EFI Time Based Authenticated Variable

When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Append Key

This item uploads and adds an Forbidden Signature into the Key Management. You may insert a factory default key or load from a file. When prompted, select "Yes" to load Factory Defaults or "No" to load from a file.

Delete Key

This item deletes a previously installed Forbidden Signature.

7-13 Recovery

This motherboard supports the Dual Boot Block feature, which is the last-ditch mechanism to recover the BIOS boot block. This section provides an introduction to the feature.

BIOS Boot Block

```
-----
                AMI Firmware Update Utility vX.XX.XX
        Copyright (C)XXXX American Megatrends Inc. All Rights Reserved.
        -----
```

```
Reading flash . . . . . done
-- ME Data Size checking . ok
-- FFS checksums . . . . . ok
Erasing Boot Block . . . . . done
__ Updating Boot Block . . . . . 0x00A91000 (13%)
```

A BIOS boot block is the minimum BIOS loader required to enable necessary hardware components for the BIOS crisis recovery flash that will update the main BIOS block. An on-call BIOS boot-block corruption may occur due to a software tool issue (see image below) or an unexpected power outage during BIOS updates.

BIOS Boot Block Corruption Occurrence

When a BIOS boot block is corrupted due to an unexpected power outage or a software tool malfunctioning during BIOS updates, you can still reboot the system by activating switch JBR1 on the motherboard. When JBR1 is activated, the system will boot from a backup boot block pre-loaded in the BIOS by the manufacturer.

Steps to Reboot the System by Switch JBR1

Rebooting the System by Switch JBR1

1. Power down the system.
2. On switch JBR1 slide switch to ON, and power on the system.
3. Follow the BIOS recovery SOP listed in the next section.
4. After completing the steps above, power down the system.
5. Turn OFF switch JBR1, and power on the system.

7-14 UEFI BIOS Recovery Instructions

Attention! Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall Supermicro be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you need to update the BIOS, do not shut down or reset the system while the BIOS is updating to avoid possible boot failure.

An Overview to the UEFI BIOS

The Unified Extensible Firmware Interface (UEFI) specification provides a software-based interface between the operating system and the platform firmware in the pre-boot environment. The UEFI specification supports an architecture-independent mechanism for add-on card initialization to allow the UEFI OS loader, which is stored in the add-on card, to boot up the system. UEFI offers a clean, hands-off control to a computer system at bootup.

How to Recover the UEFI BIOS Image (-the Main BIOS Block)

A UEFI BIOS flash chip consists of a recovery BIOS block, comprised of two boot blocks and a main BIOS block (a main BIOS image). The boot block contains critical BIOS codes, including memory detection and recovery codes for the user to flash a new BIOS image if the original main BIOS image is corrupted. When the system power is on, the boot block codes execute first. Once that is completed, the main BIOS code will continue with system initialization and bootup.

Note: Follow the BIOS Recovery instructions below for BIOS recovery when the main BIOS boot crashes. However, when the BIOS boot block crashes, you will need to follow the procedures in Appendix D.

To Recover the Main BIOS Block Using a USB-Attached Device

This feature allows the user to recover a BIOS image using a USB-attached device without additional utilities used. A USB flash device such as a USB Flash Drive, or a USB CD/DVD ROM/RW device can be used for this purpose. However, a USB Hard Disk drive cannot be used for BIOS recovery at this time.

To perform UEFI BIOS recovery using a USB-attached device, follow the instructions below.

Perform UEFI BIOS Recovery Using a USB-attached Device

1. Using a different machine, copy the "Super.ROM" binary image file into the disc Root "\" Directory of a USB device or a writeable CD/DVD.

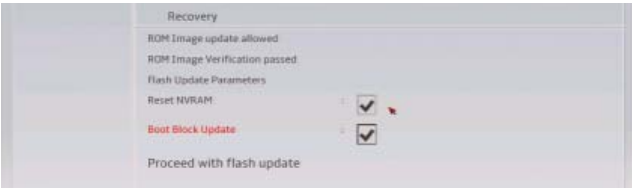
Note: If you cannot locate the "SUPER.ROM" file in your driver disk, visit our website at www.supermicro.com to download the BIOS image into a USB flash device (save in the root folder) and rename it "SUPER.ROM" for BIOS recovery use.

2. Insert the USB device that contains the new BIOS image ("SUPER.ROM") into any available USB port. Be sure the file is saved in the very top (root) folder.
3. Set the JBR1 switch on the motherboard to recovery mode and power on the system. If the screen appears as below, press to continue.



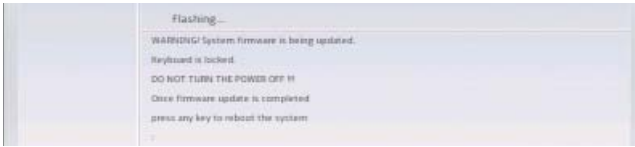
Version: 2.16.1243, Copyright (C) 2013 American Megatrends, Inc.
Supermicro C7297-DCE BIOS Date:04/25/2014 Rev:1.0
CPU : Intel(R) Core(TM) i7-4765T CPU @ 2.00GHz
Speed : 2.00 GHz
The IMC is operating with DDR3L 1333 MHz
Setup default has been loaded.
Press to run Setup
Press <F12> to Continue Booting

4. After locating the new BIOS binary image, the system will enter the BIOS Recovery menu as shown below.



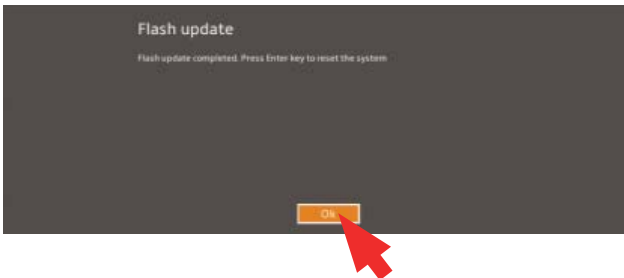
Note: At this point, you may decide if you want to start with BIOS Recovery. If you decide to proceed with BIOS Recovery, follow the procedures below.

5. To continue with BIOS Recovery, select the item- "Proceed with flash update". You will see the progress of BIOS Recovery as shown on the screens below.



Note: Do not interrupt the BIOS programming until it is completed.

6. After the BIOS Recovery process is complete, click OK to reboot the system.



Notes

Appendix A

BIOS Error Beep Codes

During the POST (Power-On Self-Test) routines, which are performed each time the system is powered on, errors may occur.

Non-fatal errors are those which, in most cases, allow the system to continue with bootup. The error messages normally appear on the screen.

Fatal errors will not allow the system to continue to bootup. If a fatal error occurs, you should consult with your system manufacturer for possible repairs.

These fatal errors are usually communicated through a series of audible beeps. The numbers on the fatal error list correspond to the number of beeps for the corresponding error.

BIOS Error Beep Codes		
Beep Code/LED	Error Message	Description
1 beep	Refresh	Circuits have been reset. (Ready to power up)
5 short beeps + 1 long beep	Memory error	No memory detected in the system
5 short beeps	Display error	System display error
OH LED On	System OH	System Overheat

Notes

Appendix B

System Specifications

Processors

Single Intel Core i3/i5/i7 6th generation processor in an LGA1151 socket

Note: Please refer to our web site for a complete listing of supported processors.

Chipset

Intel Z170 Express

BIOS

128 Mb AMI BIOS® SPI Flash BIOS

Memory Capacity

Four (4) DIMM slots that can support 64GB of unbuffered, non-ECC UDIMM up to 4 GB, 8 GB or 16 GB size and DDR4 3000+MHz(OC) MHz speed SDRAM.

Note: See the memory section in Chapter 5 for details.

SATA Controller

Intel on-chip controller for six-port SATA 3.0 and an additional six-port SATA 2.0 system (RAID supported)

Drive Bays

Eight hot-swap and fixed drive bays are available to house up to twelve SATA drives

Peripheral Drive Bays

Two 5.25" drive bays can be used for peripheral devices

Expansion Slots

Supports the use of eight standard size PCI add-on cards: two (2) PCH PCI-E 3.0 X1 (in X4) slots, one (1) CPU PCI-E 3.0 X4 (in X16) slot, one (1) PCH PCI-E 3.0 X4 slot, one (1) CPU PCI-E 3.0 X16 slot, one (1) CPU PCI-E 3.0 X8 (in X16) slot and one (1) M.2 slot

Motherboard

C7Z170-SQ (ATX form factor),

Dimensions: ATX form factor: (12.0" x 9.6") (304.8 mm x 243.84 mm)

Chassis

GS5A-753R Form Factor: mid tower,

Dimensions (as tower): HxWxD: 18.1" x 7.9" x 19.4" (460mm x 200mm x 493mm)

Weight

Gross (Bare Bone): 24.2 lbs. (10.98 kg)

System Cooling

Three (3) 12-cm low-noise PWM fans

System Input Requirements

AC Input Voltage: 100-240 VAC

Rated Input Current: 7A (115V) to 3.5A (240V)

Rated Input Frequency: 50/60 Hz

Power Supply

Rated Output Power: 750W (Part# PWS-753-PQ)

Rated Output Voltages: +3.3V (15A), +5V (20A), +12V (17A), -12V (0.5A), +5Vsb (3A))

Operating Environment

Operating Temperature: 10° to 35° C (50° to 95° F)

Non-operating Temperature: -40° to 70° C (-40° to 158° F)

Operating Relative Humidity: 8% to 90% (non-condensing)

Non-operating Relative Humidity: 5 to 95% (non-condensing)

Regulatory Compliance

Electromagnetic Emissions: FCC Class B, EN 55022 Class B, EN 61000-3-2/-3-3, CISPR 22 Class B

Electromagnetic Immunity: EN 55024/CISPR 24, (EN 61000-4-2, EN 61000-4-3, EN 61000-4-4, EN 61000-4-5, EN 61000-4-6, EN 61000-4-8, EN 61000-4-11)

Safety: CSA/EN/IEC/UL 60950-1 Compliant, UL or CSA Listed (USA and Canada), CE Marking (Europe)

California Best Management Practices Regulations for Perchlorate Materials:
This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. "Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate"

(continued from front)

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